

## DUAL CHANNEL, 12-BIT, 125/105/80/65 MSPS ADC WITH SERIAL LVDS INTERFACE

### FEATURES

- Maximum Sample Rate: 125 MSPS
- 12-Bit Resolution with No Missing Codes
- Simultaneous Sample and Hold
- 3.5 dB Coarse Gain and up to 6 dB Programmable Fine Gain for SFDR/SNR Trade-Off
- Serialized LVDS Outputs with Programmable Internal Termination Option
- Supports Sine, LVCMOS, LVPECL, LVDS Clock Inputs and Amplitude Down to 400 mV<sub>pp</sub>
- Internal Reference with External Reference Support
- No External Decoupling Required for References
- 3.3-V Analog and Digital Supply
- 48 QFN Package (7 mm × 7 mm)

- Pin Compatible 14-Bit Family (ADS624X - [SLAS542](#))
- Feature Compatible Quad Channel Family (ADS644X - [SLAS531](#) and ADS642X - [SLAS532](#))

### APPLICATIONS

- Base-Station IF Receivers
- Diversity Receivers
- Medical Imaging
- Test Equipment

Table 1. ADS62XX Dual Channel Family

|                   | 125 MSPS | 105 MSPS | 80 MSPS | 65 MSPS |
|-------------------|----------|----------|---------|---------|
| ADS624X<br>14 Bit | ADS6245  | ADS6244  | ADS6243 | ADS6242 |
| ADS622X<br>12 Bit | ADS6225  | ADS6224  | ADS6223 | ADS6222 |

Table 2. Performance Summary

|                       |                            | ADS6225 | ADS6224 | ADS6223 | ADS6222 |
|-----------------------|----------------------------|---------|---------|---------|---------|
| SFDR, dBc             | Fin = 10MHz (0 dB gain)    | 90      | 91      | 91      | 93      |
|                       | Fin = 170MHz (3.5 dB gain) | 79      | 81      | 82      | 83      |
| SINAD, dBFS           | Fin = 10MHz (0 dB gain)    | 70.7    | 70.8    | 71.3    | 71.3    |
|                       | Fin = 170MHz (3.5 dB gain) | 67.4    | 68.1    | 68.2    | 68.7    |
| Power per channel, mW |                            | 500     | 405     | 350     | 315     |

### DESCRIPTION

ADS6225/ADS6224/ADS6223/ADS6222 (ADS622X) is a family of high performance 12-bit 125/105/80/65 MSPS dual channel A-D converters. Serial LVDS data outputs reduce the number of interface lines, resulting in a compact 48-pin QFN package (7 mm × 7 mm) that allows for high system integration density. The device includes 3.5 dB coarse gain option that can be used to improve SFDR performance with little degradation in SNR. In addition to the coarse gain, fine gain options also exist, programmable in 1 dB steps up to 6 dB.

The output interface is 2-wire, where each ADC data is serialized and output over two LVDS pairs. This makes it possible to halve the serial data rate (compared to a 1-wire interface) and restrict it to less than 1 Gbps easing receiver design. The ADS622X also includes the traditional 1-wire interface that can be used at lower sampling frequencies.

An internal phase lock loop (PLL) multiplies the incoming ADC sampling clock to derive the bit clock. The bit clock is used to serialize the ADC data from each channel. In addition to the serial data streams, the frame and bit clocks are also transmitted as LVDS outputs. The LVDS output buffers have features such as programmable LVDS currents, current doubling modes and internal termination options. These can be used to widen eye-openings and improve signal integrity, easing capture by the receiver.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

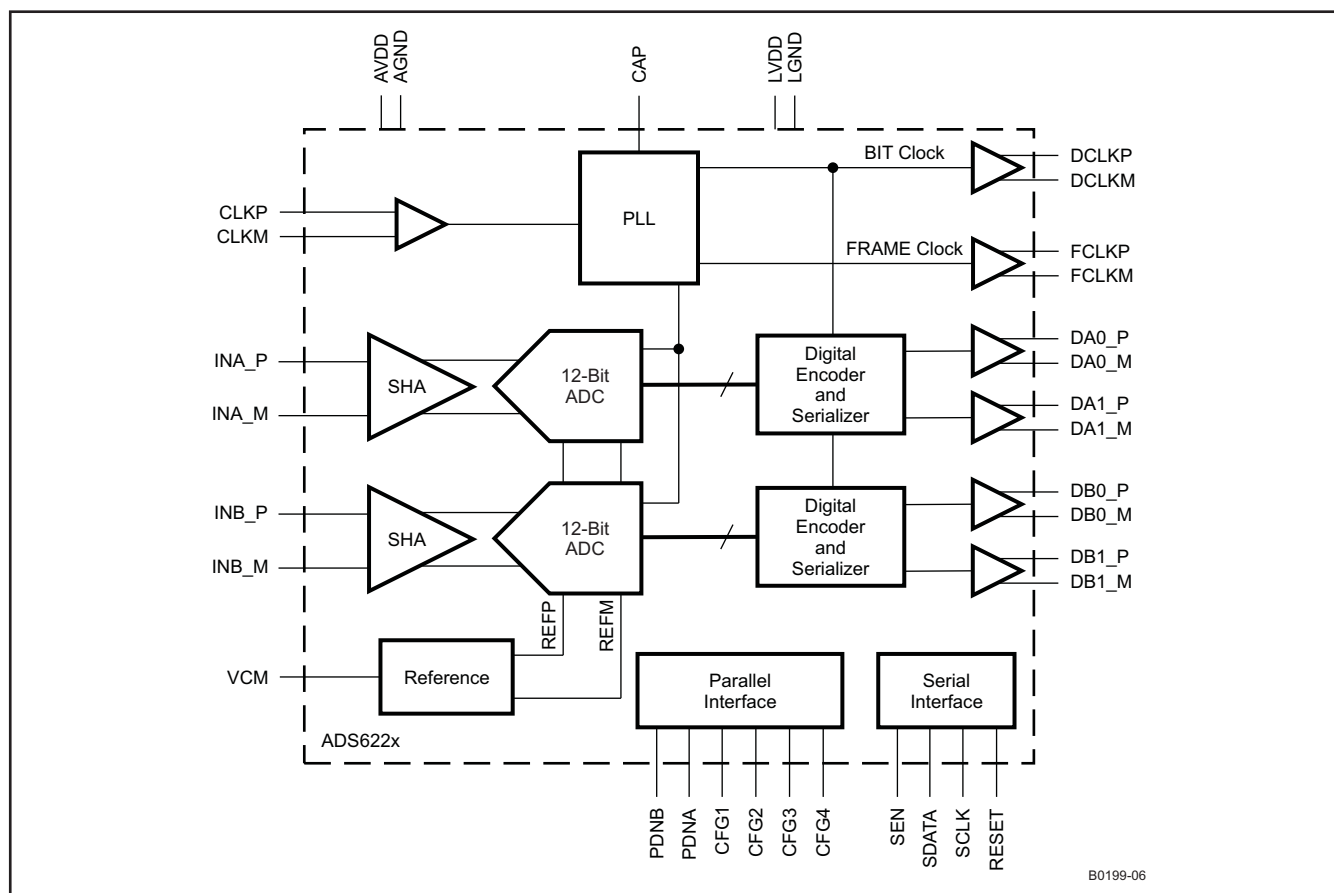


These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## DESCRIPTION (CONTINUED)

The ADC channel outputs can be transmitted either as MSB or LSB first and 2s complement or straight binary.

ADS622X has internal references, but can also support an external reference mode. The device is specified over the industrial temperature range (–40°C to 85°C).



B0199-06

**PACKAGE/ORDERING INFORMATION<sup>(1)</sup>**

| PRODUCT | PACKAGE-LEAD          | PACKAGE DESIGNATOR | SPECIFIED TEMPERATURE RANGE | PACKAGE MARKING | ORDERING NUMBER | TRANSPORT MEDIA, QUANTITY |
|---------|-----------------------|--------------------|-----------------------------|-----------------|-----------------|---------------------------|
| ADS6225 | QFN-48 <sup>(2)</sup> | RGZ                | –40°C to 85°C               | AZ6225          | ADS6225IRGZT    | 250, Tape/reel            |
|         |                       |                    |                             |                 | ADS6225IRGZR    | 2000, Tape/reel           |
| ADS6224 | QFN-48 <sup>(2)</sup> | RGZ                | –40°C to 85°C               | AZ6224          | ADS6224IRGZT    | 250, Tape/reel            |
|         |                       |                    |                             |                 | ADS6224IRGZR    | 2000, Tape/reel           |
| ADS6223 | QFN-48 <sup>(2)</sup> | RGZ                | –40°C to 85°C               | AZ6223          | ADS6223IRGZT    | 250, Tape/reel            |
|         |                       |                    |                             |                 | ADS6223IRGZR    | 2000, Tape/reel           |
| ADS6222 | QFN-48 <sup>(2)</sup> | RGZ                | –40°C to 85°C               | AZ6222          | ADS6222IRGZT    | 250, Tape/reel            |
|         |                       |                    |                             |                 | ADS6222IRGZR    | 2000, Tape/reel           |

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).
- (2) For thermal pad size on the package, see the mechanical drawings at the end of this data sheet.  $\theta_{JA} = 23.17^{\circ}\text{C/W}$  (0 LFM air flow),  $\theta_{JC} = 22.1^{\circ}\text{C/W}$  when used with 2 oz. copper trace and pad soldered directly to a JEDEC standard four layer 3 in. x 3 in. PCB.

**ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>**

|  | VALUE                                | UNIT |
|--|--------------------------------------|------|
| AVDD Supply voltage range                                    | –0.3 to 3.9                          | V    |
| LVDD Supply voltage range                                    | –0.3 to 3.9                          | V    |
| Voltage between AGND and DGND                                | –0.3 to 0.3                          | V    |
| Voltage between AVDD to LVDD                                 | –0.3 to 3.3                          | V    |
| Voltage applied to external pin, VCM                         | –0.3 to 2.0                          | V    |
| Voltage applied to analog input pins                         | –0.3V to minimum ( 3.6, AVDD + 0.3V) | V    |
| T <sub>A</sub> Operating free-air temperature range          | –40 to 85                            | °C   |
| T <sub>J</sub> Operating junction temperature range          | 125                                  | °C   |
| T <sub>stg</sub> Storage temperature range                   | –65 to 150                           | °C   |
| Lead temperature 1,6 mm (1/16") from the case for 10 seconds | 220                                  | °C   |

- (1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## RECOMMENDED OPERATING CONDITIONS

over operating free-air temperature range (unless otherwise noted)

|   |   | MIN                          | NOM  | MAX  | UNIT            |
|---|---|------------------------------|------|------|-----------------|
| SUPPLIES  |   |                              |      |      |                 |
| AVDD  | Analog supply voltage   | 3.0                          | 3.3  | 3.6  | V               |
| LVDD  | LVDS Buffer supply voltage  | 3.0                          | 3.3  | 3.6  | V               |
| ANALOG INPUTS   |   |                              |      |      |                 |
| Differential input voltage range  |   | 2                            |      |      | V <sub>pp</sub> |
| Input common-mode voltage   |   | 1.5<br>±0.1                  |      |      | V               |
| Voltage applied on VCM in external reference mode                           |   | 1.45                         | 1.50 | 1.55 | V               |
| CLOCK INPUT   |   |                              |      |      |                 |
| Input clock sample rate   | ADS6225   | 5                            | 125  |      | MSPS            |
|   | ADS6224   | 5                            | 105  |      |                 |
|   | ADS6223   | 5                            | 80   |      |                 |
|   | ADS6222   | 5                            | 65   |      |                 |
| Input clock amplitude differential (V <sub>CLKP</sub> – V <sub>CLKM</sub> ) | Sine wave, ac-coupled   | 0.4                          | 1.5  |      | V <sub>pp</sub> |
|   | LVPECL, ac-coupled  | ±0.8                         |      |      |                 |
|   | LVDS, ac-coupled  | ±0.35                        |      |      |                 |
|   | LVC MOS, ac-coupled   | 3.3                          |      |      |                 |
| Input clock duty cycle  |   | 35%                          | 50%  | 65%  |                 |
| DIGITAL OUTPUTS   |   |                              |      |      |                 |
| C <sub>LOAD</sub>   | Maximum external load capacitance from each output pin to DGND        | Without internal termination | 5    |      | pF              |
|   |   | With internal termination    | 10   |      |                 |
| R <sub>LOAD</sub>   | Differential load resistance (external) between the LVDS output pairs | 100                          |      |      | Ω               |
| T <sub>A</sub>  | Operating free-air temperature  | –40                          |      |      | 85 °C           |

## ELECTRICAL CHARACTERISTICS

Typical values are at 25°C, min and max values are across the full temperature range T<sub>MIN</sub> = –40°C to T<sub>MAX</sub> = 85°C, AVDD = LVDD = 3.3 V, maximum rated sampling frequency, 50% clock duty cycle, –1dBFS differential analog input, internal reference mode (unless otherwise noted).

| PARAMETER  |   | ADS6225<br>F <sub>s</sub> = 125 MSPS |     |     | ADS6224<br>F <sub>s</sub> = 105 MSPS |     |     | ADS6223<br>F <sub>s</sub> = 80 MSPS |     |     | ADS6222<br>F <sub>s</sub> = 65 MSPS |     |     | UNIT            |
|--|---|--------------------------------------|-----|-----|--------------------------------------|-----|-----|-------------------------------------|-----|-----|-------------------------------------|-----|-----|-----------------|
|  |   | MIN                                  | TYP | MAX | MIN                                  | TYP | MAX | MIN                                 | TYP | MAX | MIN                                 | TYP | MAX |                 |
| RESOLUTION   |   | 12                                   |     |     | 12                                   |     |     | 12                                  |     |     | 12                                  |     |     | Bits            |
| ANALOG INPUT   |   |                                      |     |     |                                      |     |     |                                     |     |     |                                     |     |     |                 |
| Differential input voltage range                             |   | 2.0                                  |     |     | 2.0                                  |     |     | 2.0                                 |     |     | 2.0                                 |     |     | V <sub>PP</sub> |
| Differential input capacitance                               |   | 7                                    |     |     | 7                                    |     |     | 7                                   |     |     | 7                                   |     |     | pF              |
| Analog input bandwidth                                       |   | 500                                  |     |     | 500                                  |     |     | 500                                 |     |     | 500                                 |     |     | MHz             |
| Analog input common mode current (per input pin of each ADC) |   | 155                                  |     |     | 130                                  |     |     | 100                                 |     |     | 81                                  |     |     | μA              |
| REFERENCE VOLTAGES   |   |                                      |     |     |                                      |     |     |                                     |     |     |                                     |     |     |                 |
| VREFB  | Internal reference bottom voltage       | 1.0                                  |     |     | 1.0                                  |     |     | 1.0                                 |     |     | 1.0                                 |     |     | V               |
| VREFT  | Internal reference top voltage          | 2.0                                  |     |     | 2.0                                  |     |     | 2.0                                 |     |     | 2.0                                 |     |     | V               |
| ΔV <sub>REF</sub>  | Internal reference error, (VREFT–VREFB) | –15                                  | ±2  | 15  | –15                                  | ±2  | 15  | –15                                 | ±2  | 15  | –15                                 | ±2  | 15  | mV              |
| VCM  | Common mode output voltage              | 1.5                                  |     |     | 1.5                                  |     |     | 1.5                                 |     |     | 1.5                                 |     |     | V               |

## ELECTRICAL CHARACTERISTICS (continued)

Typical values are at 25°C, min and max values are across the full temperature range  $T_{MIN} = -40^{\circ}\text{C}$  to  $T_{MAX} = 85^{\circ}\text{C}$ ,  $AVDD = LVDD = 3.3\text{ V}$ , maximum rated sampling frequency, 50% clock duty cycle, –1dBFS differential analog input, internal reference mode (unless otherwise noted).

| PARAMETER  | ADS6225<br>F <sub>s</sub> = 125 MSPS   |         |       | ADS6224<br>F <sub>s</sub> = 105 MSPS |         |       | ADS6223<br>F <sub>s</sub> = 80 MSPS |         |       | ADS6222<br>F <sub>s</sub> = 65 MSPS |         |      | UNIT |       |
|--|--|---------|-------|--------------------------------------|---------|-------|-------------------------------------|---------|-------|-------------------------------------|---------|------|------|-------|
|  | MIN  | TYP     | MAX   | MIN                                  | TYP     | MAX   | MIN                                 | TYP     | MAX   | MIN                                 | TYP     | MAX  |      |       |
| VCM output current capability  | 4  |         |       | 4                                    |         |       | 4                                   |         |       | 4                                   |         |      | mA   |       |
| DC ACCURACY  |  |         |       |                                      |         |       |                                     |         |       |                                     |         |      |      |       |
| No missing codes   |  | Assured |       |                                      | Assured |       |                                     | Assured |       |                                     | Assured |      |      |       |
| E <sub>O</sub>   | Offset error, across devices and across channels within a device                               | −15     | ±2    | 15                                   | −15     | ±2    | 15                                  | −15     | ±2    | 15                                  | −15     | ±2   | 15   | mV    |
|  | Offset error temperature coefficient, across devices and across channels within a device       | 0.05    |       |                                      | 0.05    |       |                                     | 0.05    |       |                                     | 0.05    |      |      | mV/°C |
| There are two sources of gain error - internal reference inaccuracy and channel gain error |  |         |       |                                      |         |       |                                     |         |       |                                     |         |      |      |       |
| E <sub>GREF</sub>  | Gain error due to internal reference inaccuracy alone, (ΔV <sub>REF</sub> /2.0)%               | −0.75   | ±0.1  | 0.75                                 | −0.75   | ±0.1  | 0.75                                | −0.75   | ±0.1  | 0.75                                | −0.75   | ±0.1 | 0.75 | % FS  |
|  | Reference gain error temperature coefficient   | 0.0125  |       |                                      | 0.0125  |       |                                     | 0.0125  |       |                                     | 0.0125  |      |      | Δ%/°C |
| E <sub>GCHAN</sub>   | Gain error of channel alone, across devices and across channels within a device <sup>(1)</sup> | −1      | ±0.3  | 1                                    | −1      | ±0.3  | 1                                   | −1      | ±0.3  | 1                                   | −1      | ±0.3 | 1    | % FS  |
|  | Channel gain error temperature coefficient, across devices and across channels within a device | 0.005   |       |                                      | 0.005   |       |                                     | 0.005   |       |                                     | 0.005   |      |      | Δ%/°C |
| DNL  | Differential nonlinearity  | −0.95   | ±0.5  | 2.0                                  | −0.95   | ±0.5  | 2.0                                 | −0.9    | ±0.4  | 1.8                                 | −0.9    | ±0.4 | 1.8  | LSB   |
| INL  | Integral nonlinearity  | −2.5    | ±1.25 | 2.5                                  | −2.2    | ±1.25 | 2.2                                 | −2.0    | ±1.25 | 2.0                                 | −2.0    | ±1.0 | 2.0  | LSB   |
| PSRR   | DC power supply rejection ratio  | 0.5     |       |                                      | 0.5     |       |                                     | 0.5     |       |                                     | 0.5     |      |      | mV/V  |
| POWER SUPPLY   |  |         |       |                                      |         |       |                                     |         |       |                                     |         |      |      |       |
| I <sub>CC</sub>  | Total supply current   | 300     |       |                                      | 245     |       |                                     | 210     |       |                                     | 190     |      |      | mA    |
| I <sub>AVDD</sub>  | Analog supply current  | 237     |       |                                      | 185     |       |                                     | 155     |       |                                     | 140     |      |      | mA    |
| I <sub>LVDD</sub>  | LVDS supply current  | 63      |       |                                      | 60      |       |                                     | 55      |       |                                     | 50      |      |      | mA    |
|  | Total power  | 1.0     | 1.2   |                                      | 0.81    | 0.97  |                                     | 0.7     | 0.85  |                                     | 0.63    | 0.8  | W    |       |
|  | Power down (with input clock stopped)  | 77      | 150   |                                      | 77      | 150   |                                     | 77      | 150   |                                     | 77      | 150  | mW   |       |

(1) This is specified by design and characterization; it is not tested in production.

## ELECTRICAL CHARACTERISTICS

Typical values are at 25°C, min and max values are across the full temperature range  $T_{MIN} = -40^{\circ}\text{C}$  to  $T_{MAX} = 85^{\circ}\text{C}$ ,  $AVDD = LVDD = 3.3\text{ V}$ , maximum rated sampling frequency, 50% clock duty cycle, –1dBFS differential analog input, internal reference mode (unless otherwise noted).

| PARAMETER                                     | TEST CONDITIONS |                    | ADS6225<br>F <sub>s</sub> = 125 MSPS |      |     | ADS6224<br>F <sub>s</sub> = 105 MSPS |      |     | ADS6223<br>F <sub>s</sub> = 80 MSPS |      |     | ADS6222<br>F <sub>s</sub> = 65 MSPS |      |     | UNIT |
|---|-----------------|--------------------|--------------------------------------|------|-----|--------------------------------------|------|-----|-------------------------------------|------|-----|-------------------------------------|------|-----|------|
|   |                 |                    | MIN                                  | TYP  | MAX | MIN                                  | TYP  | MAX | MIN                                 | TYP  | MAX | MIN                                 | TYP  | MAX |      |
| DYNAMIC AC CHARACTERISTICS                    |                 |                    |                                      |      |     |                                      |      |     |                                     |      |     |                                     |      |     |      |
| SNR<br>Signal to noise ratio                  | Fin = 10 MHz    |                    | 70.9                                 |      |     | 71                                   |      |     | 71.4                                |      |     | 71.4                                |      |     | dBFS |
|   | Fin = 50 MHz    |                    | 67.5                                 | 70.5 |     | 70.8                                 |      |     | 68                                  | 71.1 |     | 71.2                                |      |     |      |
|   | Fin = 70 MHz    |                    | 70.3                                 |      |     | 67.5                                 | 70.6 |     | 70.9                                |      |     | 68                                  | 71   |     |      |
|   | Fin = 100 MHz   |                    | 69.9                                 |      |     | 70.1                                 |      |     | 70.5                                |      |     | 70.5                                |      |     |      |
|   | Fin = 170 MHz   | 0 dB Gain          | 68.5                                 |      |     | 68.8                                 |      |     | 69                                  |      |     | 69.1                                |      |     |      |
|   |                 | 3.5 dB Coarse gain | 68.1                                 |      |     | 68.4                                 |      |     | 68.4                                |      |     | 68.8                                |      |     |      |
|   | Fin = 230 MHz   | 0 dB Gain          | 67.4                                 |      |     | 67.8                                 |      |     | 66.9                                |      |     | 68.1                                |      |     |      |
|   |                 | 3.5 dB Coarse gain | 67.1                                 |      |     | 67.3                                 |      |     | 67.3                                |      |     | 67.8                                |      |     |      |
| SINAD<br>Signal to noise and distortion ratio | Fin = 10 MHz    |                    | 70.7                                 |      |     | 70.8                                 |      |     | 71.3                                |      |     | 71.3                                |      |     | dBFS |
|   | Fin = 50 MHz    |                    | 67                                   | 70   |     | 69.8                                 |      |     | 67.5                                | 70.9 |     | 71                                  |      |     |      |
|   | Fin = 70 MHz    |                    | 69.2                                 |      |     | 67                                   | 70   |     | 70.6                                |      |     | 67.5                                | 70.7 |     |      |
|   | Fin = 100 MHz   |                    | 69.7                                 |      |     | 70                                   |      |     | 70.1                                |      |     | 70                                  |      |     |      |
|   | Fin = 170 MHz   | 0 dB Gain          | 66.9                                 |      |     | 68.5                                 |      |     | 68.6                                |      |     | 68.9                                |      |     |      |
|   |                 | 3.5 dB Coarse gain | 67.4                                 |      |     | 68.1                                 |      |     | 68.2                                |      |     | 68.7                                |      |     |      |
|   | Fin = 230 MHz   | 0 dB Gain          | 66                                   |      |     | 66.8                                 |      |     | 66.5                                |      |     | 67.3                                |      |     |      |
|   |                 | 3.5 dB Coarse gain | 66.5                                 |      |     | 66.8                                 |      |     | 67.2                                |      |     | 67.4                                |      |     |      |
| SFDR<br>Spurious free dynamic range           | Fin = 10 MHz    |                    | 90                                   |      |     | 91                                   |      |     | 91                                  |      |     | 93                                  |      |     | dBc  |
|   | Fin = 50 MHz    |                    | 73                                   | 83   |     | 80                                   |      |     | 76                                  | 87   |     | 88                                  |      |     |      |
|   | Fin = 70 MHz    |                    | 78                                   |      |     | 73                                   | 81   |     | 86                                  |      |     | 76                                  | 87   |     |      |
|   | Fin = 100 MHz   |                    | 87                                   |      |     | 85                                   |      |     | 85                                  |      |     | 83                                  |      |     |      |
|   | Fin = 170 MHz   | 0 dB Gain          | 75                                   |      |     | 78                                   |      |     | 79                                  |      |     | 80                                  |      |     |      |
|   |                 | 3.5 dB Coarse gain | 79                                   |      |     | 81                                   |      |     | 82                                  |      |     | 83                                  |      |     |      |
|   | Fin = 230 MHz   | 0 dB Gain          | 74                                   |      |     | 76                                   |      |     | 77                                  |      |     | 78                                  |      |     |      |
|   |                 | 3.5 dB Coarse gain | 78                                   |      |     | 79                                   |      |     | 80                                  |      |     | 81                                  |      |     |      |
| HD2<br>Second harmonic                        | Fin = 10 MHz    |                    | 93                                   |      |     | 94                                   |      |     | 96                                  |      |     | 97                                  |      |     | dBc  |
|   | Fin = 50 MHz    |                    | 73                                   | 91   |     | 88                                   |      |     | 76                                  | 90   |     | 92                                  |      |     |      |
|   | Fin = 70 MHz    |                    | 90                                   |      |     | 73                                   | 88   |     | 90                                  |      |     | 76                                  | 92   |     |      |
|   | Fin = 100 MHz   |                    | 90                                   |      |     | 90                                   |      |     | 87                                  |      |     | 87                                  |      |     |      |
|   | Fin = 170 MHz   | 0 dB Gain          | 85                                   |      |     | 84                                   |      |     | 86                                  |      |     | 86                                  |      |     |      |
|   |                 | 3.5 dB Coarse gain | 88                                   |      |     | 86                                   |      |     | 88                                  |      |     | 88                                  |      |     |      |
|   | Fin = 230 MHz   | 0 dB Gain          | 82                                   |      |     | 81                                   |      |     | 82                                  |      |     | 83                                  |      |     |      |
|   |                 | 3.5 dB Coarse gain | 85                                   |      |     | 83                                   |      |     | 84                                  |      |     | 85                                  |      |     |      |

## ELECTRICAL CHARACTERISTICS (continued)

Typical values are at 25°C, min and max values are across the full temperature range  $T_{MIN} = -40^{\circ}\text{C}$  to  $T_{MAX} = 85^{\circ}\text{C}$ ,  $AVDD = LVDD = 3.3\text{ V}$ , maximum rated sampling frequency, 50% clock duty cycle, –1dBFS differential analog input, internal reference mode (unless otherwise noted).

| PARAMETER                                      | TEST CONDITIONS   | ADS6225<br>$F_s = 125\text{ MSPS}$ |      |     | ADS6224<br>$F_s = 105\text{ MSPS}$ |      |     | ADS6223<br>$F_s = 80\text{ MSPS}$ |      |     | ADS6222<br>$F_s = 65\text{ MSPS}$ |      |     | UNIT            |
|--|---|------------------------------------|------|-----|------------------------------------|------|-----|-----------------------------------|------|-----|-----------------------------------|------|-----|-----------------|
|  |   | MIN                                | TYP  | MAX | MIN                                | TYP  | MAX | MIN                               | TYP  | MAX | MIN                               | TYP  | MAX |                 |
| HD3<br>Third<br>harmonic                       | Fin = 10 MHz  |                                    | 90   |     |                                    | 91   |     |                                   | 91   |     |                                   | 93   |     | dBc             |
|  | Fin = 50 MHz  | 73                                 | 83   |     |                                    | 80   |     | 76                                | 87   |     |                                   | 88   |     |                 |
|  | Fin = 70 MHz  |                                    | 78   |     | 73                                 | 81   |     |                                   | 86   |     | 76                                | 86   |     |                 |
|  | Fin = 100 MHz   |                                    | 87   |     |                                    | 85   |     |                                   | 85   |     |                                   | 83   |     |                 |
|  | Fin = 170 MHz   | 0 dB Gain                          |      | 75  | 78                                 |      |     | 79                                |      |     | 80                                |      |     |                 |
|  |   | 3.5 dB Coarse gain                 |      | 79  | 82                                 |      |     | 82                                |      |     | 83                                |      |     |                 |
|  | Fin = 230 MHz   | 0 dB Gain                          |      | 74  | 76                                 |      |     | 77                                |      |     | 78                                |      |     |                 |
|  |   | 3.5 dB Coarse gain                 |      | 78  | 79                                 |      |     | 80                                |      |     | 81                                |      |     |                 |
| Worst<br>harmonic<br>(other than<br>HD2, HD3)  | Fin = 10 MHz  |                                    | 95   |     |                                    | 95   |     |                                   | 96   |     |                                   | 98   |     | dBc             |
|  | Fin = 50 MHz  |                                    | 94   |     |                                    | 94   |     |                                   | 95   |     |                                   | 95   |     |                 |
|  | Fin = 70 MHz  |                                    | 92   |     |                                    | 94   |     |                                   | 95   |     |                                   | 95   |     |                 |
|  | Fin = 100 MHz   |                                    | 91   |     |                                    | 92   |     |                                   | 93   |     |                                   | 93   |     |                 |
|  | Fin = 170 MHz   |                                    | 88   |     |                                    | 89   |     |                                   | 90   |     |                                   | 90   |     |                 |
|  | Fin = 230 MHz   |                                    | 86   |     |                                    | 86   |     |                                   | 87   |     |                                   | 87   |     |                 |
| THD<br>Total<br>harmonic<br>distortion         | Fin = 10 MHz  |                                    | 88   |     |                                    | 89.5 |     |                                   | 89.5 |     |                                   | 91   |     | dBc             |
|  | Fin = 50 MHz  | 70                                 | 81   |     |                                    | 78.5 |     | 74                                | 85.5 |     |                                   | 86   |     |                 |
|  | Fin = 70 MHz  |                                    |      |     | 70                                 | 77   |     |                                   |      |     | 74                                |      |     |                 |
|  | Fin = 100 MHz   |                                    | 84   |     |                                    | 84   |     |                                   | 83   |     |                                   | 80.5 |     |                 |
|  | Fin = 170 MHz   |                                    | 73   |     |                                    | 76   |     |                                   | 77.5 |     |                                   | 78.5 |     |                 |
|  | Fin = 230 MHz   |                                    | 72   |     |                                    | 74   |     |                                   | 75.5 |     |                                   | 76.5 |     |                 |
| ENOB<br>Effective<br>number of bits            | Fin = 50 MHz  | 10.8                               | 11.4 |     |                                    |      |     | 10.9                              | 11.5 |     |                                   | 11.5 |     | Bits            |
|  | Fin = 70 MHz  |                                    |      |     | 10.8                               | 11.4 |     |                                   |      |     | 10.9                              |      |     |                 |
| IMD<br>2-Tone<br>intermodulation<br>distortion | F1= 46.09 MHz,<br>F2 = 50.09 MHz  |                                    | 90   |     |                                    | 90   |     |                                   | 94   |     |                                   | 97   |     | dBFS            |
|  | F1= 185.09 MHz,<br>F2 = 190.09 MHz  |                                    | 82   |     |                                    | 88   |     |                                   | 92   |     |                                   | 96   |     |                 |
| Cross-talk                                     | Cross-talk signal<br>frequency = 10 MHz   |                                    | 105  |     |                                    | 105  |     |                                   | 106  |     |                                   | 108  |     | dBc             |
| Input overload<br>recovery                     | Recovery to within 1% (of final<br>value) for 6-dB overload with<br>sine wave input |                                    | 1    |     |                                    | 1    |     |                                   | 1    |     |                                   | 1    |     | Clock<br>cycles |
| AC PSRR<br>Power Supply<br>Rejection<br>Ratio  | Up to 100 MHz, 100 mV <sub>PP</sub> on<br>AVDD                                      |                                    | 35   |     |                                    | 35   |     |                                   | 35   |     |                                   | 35   |     | dBc             |

## DIGITAL CHARACTERISTICS

The DC specifications refer to the condition where the digital outputs are not switching, but are permanently at a valid logic level 0 or 1  $AVDD = LVDD = 3.3V$ ,  $I_O = 3.5mA$ ,  $R_{LOAD} = 100\Omega^{(1)}$ .

All LVDS specifications are characterized, but not tested at production.

| PARAMETER                 | TEST CONDITIONS             | ADS6225/ADS6224/AD<br>S6223/ADS6222                                |     |     | UNIT |    |
|---------------------------|-----------------------------|--|-----|-----|------|----|
|                           |                             | MIN  | TYP | MAX |      |    |
| DIGITAL INPUTS            |                             |  |     |     |      |    |
| High-level input voltage  |                             | 2.4  |     |     | V    |    |
| Low-level input voltage   |                             | 0.8  |     |     | V    |    |
| High-level input current  |                             | 10   |     |     | μA   |    |
| Low-level input current   |                             | 10   |     |     | μA   |    |
| Input capacitance         |                             | 4  |     |     | pF   |    |
| DIGITAL OUTPUTS           |                             |  |     |     |      |    |
| High-level output voltage |                             | 1375   |     |     | mV   |    |
| Low-level output voltage  |                             | 1025   |     |     | mV   |    |
| V <sub>OD</sub>           | Output differential voltage | 250  | 350 | 450 | mV   |    |
| V <sub>OS</sub>           | Output offset voltage       | Common-mode voltage of OUTP and OUTM                               |     |     | 1200 | mV |
|                           | Output capacitance          | Output capacitance inside the device, from either output to ground |     |     | 2    | pF |

(1)  $I_O$  refers to the LVDS buffer current setting,  $R_{LOAD}$  is the external differential load resistance between the LVDS output pair.



## TIMING SPECIFICATIONS<sup>(1)</sup>

Typical values are at 25°C, min and max values are across the full temperature range  $T_{MIN} = -40^{\circ}\text{C}$  to  $T_{MAX} = 85^{\circ}\text{C}$ ,  $AVDD = LVDD = 3.3\text{ V}$ , maximum rated sampling frequency, sine wave input clock, 1.5  $V_{PP}$  clock amplitude,  $C_L = 5\text{ pF}$  <sup>(2)</sup>,  $I_O = 3.5\text{ mA}$ ,  $R_L = 100\ \Omega$  <sup>(3)</sup>, no internal termination, unless otherwise noted.

| PARAMETER  |   | TEST CONDITIONS   | ADS6225 |      |     | ADS6224 |      |     | ADS6223 |      |     | ADS6222 |     |     | UNIT         |
|--|---|---|---------|------|-----|---------|------|-----|---------|------|-----|---------|-----|-----|--------------|
|  |   |   | MIN     | TYP  | MAX | MIN     | TYP  | MAX | MIN     | TYP  | MAX | MIN     | TYP | MAX |              |
| t <sub>J</sub>   | Aperture jitter                               | Uncertainty in the sampling instant   | 250     |      |     | 250     |      |     | 250     |      |     | 250     |     |     | fs rms       |
| Interface: 2-wire, DDR bit clock, 14x serialization  |   |   |         |      |     |         |      |     |         |      |     |         |     |     |              |
| t <sub>su</sub>  | Data setup time <sup>(4) (5) (6)</sup>        | From data cross-over to bit clock cross-over                                | 0.35    | 0.55 |     | 0.45    | 0.65 |     | 0.65    | 0.85 |     | 0.8     | 1.1 |     | ns           |
| t <sub>h</sub>   | Data hold time <sup>(4) (5) (6)</sup>         | From bit clock cross-over to data cross-over                                | 0.35    | 0.58 |     | 0.5     | 0.7  |     | 0.7     | 0.9  |     | 0.8     | 1.1 |     | ns           |
| t <sub>pd_clk</sub>  | Clock propagation delay <sup>(6)</sup>        | Input clock rising edge cross-over to frame clock rising edge cross-over    | 3.4     | 4.4  | 5.4 | 3.4     | 4.4  | 5.4 | 3.4     | 4.4  | 5.4 | 3.4     | 4.4 | 5.4 | ns           |
|  | Bit clock cycle-cycle jitter <sup>(5)</sup>   |   | 350     |      |     | 350     |      |     | 350     |      |     | 350     |     |     | ps pp        |
|  | Frame clock cycle-cycle jitter <sup>(5)</sup> |   | 75      |      |     | 75      |      |     | 75      |      |     | 75      |     |     | ps pp        |
| Below specifications apply for 5 MSPS ≤ Sampling freq ≤ 125 MSPS and all interface options |   |   |         |      |     |         |      |     |         |      |     |         |     |     |              |
| t <sub>A</sub>   | Aperture delay                                | Delay from input clock rising edge to the actual sampling instant           | 1       | 2    | 3   | 1       | 2    | 3   | 1       | 2    | 3   | 1       | 2   | 3   | ns           |
|  | Aperture delay variation                      | Channel-channel within same device  | −250    | ±80  | 250 | −250    | ±80  | 250 | −250    | ±80  | 250 | −250    | ±80 | 250 | ps           |
|  | ADC Latency <sup>(7)</sup>                    | Time for a sample to propagate to ADC outputs, see <a href="#">Figure 1</a> | 12      |      |     | 12      |      |     | 12      |      |     | 12      |     |     | Clock cycles |
|  | Wake up time                                  | Time to valid data after coming out of global power down                    | 100     |      |     | 100     |      |     | 100     |      |     | 100     |     |     | μs           |
|  |   | Time to valid data after input clock is re-started                          | 100     |      |     | 100     |      |     | 100     |      |     | 100     |     |     | μs           |
|  |   | Time to valid data after coming out of channel standby                      | 200     |      |     | 200     |      |     | 200     |      |     | 200     |     |     | clock cycles |
| t <sub>RISE</sub>  | Data rise time                                | From −100 mV to +100 mV   | 50      | 100  | 200 | 50      | 100  | 200 | 50      | 100  | 200 | 50      | 100 | 200 | ps           |
| t <sub>FALL</sub>  | Data fall time                                | From +100 mV to −100 mV   | 50      | 100  | 200 | 50      | 100  | 200 | 50      | 100  | 200 | 50      | 100 | 200 | ps           |
| t <sub>RISE</sub>  | Bit clock and Frame clock rise time           | From −100 mV to +100 mV   | 50      | 100  | 200 | 50      | 100  | 200 | 50      | 100  | 200 | 50      | 100 | 200 | ps           |

(1) Timing parameters are ensured by design and characterization and not tested in production.

(2)  $C_L$  is the External single-ended load capacitance between each output pin and ground.

(3)  $I_O$  Refers to the LVDS buffer current setting;  $R_L$  is the external differential load resistance between the LVDS output pair.

(4) Timing parameters are measured at the end of a 2 inch pcb trace (100-Ω characteristic impedance) terminated by  $R_L$  and  $C_L$ .

(5) Setup and hold time specifications take into account the effect of jitter on the output data and clock.

(6) Refer to [Output Timings](#) in application section for timings at lower sampling frequencies and other interface options.

(7) Note that the total latency = ADC latency + internal serializer latency. The serializer latency depends on the interface option selected as listed in [Table 28](#).

## TIMING SPECIFICATIONS (continued)

Typical values are at 25°C, min and max values are across the full temperature range  $T_{MIN} = -40^{\circ}\text{C}$  to  $T_{MAX} = 85^{\circ}\text{C}$ ,  $AVDD = LVDD = 3.3\text{ V}$ , maximum rated sampling frequency, sine wave input clock, 1.5  $V_{PP}$  clock amplitude,  $C_L = 5\text{ pF}$ ,  $I_O = 3.5\text{ mA}$ ,  $R_L = 100\ \Omega$ , no internal termination, unless otherwise noted.

| PARAMETER                                      | TEST CONDITIONS         | ADS6225 |     |     | ADS6224 |     |     | ADS6223 |     |     | ADS6222 |     |     | UNIT |
|--|-------------------------|---------|-----|-----|---------|-----|-----|---------|-----|-----|---------|-----|-----|------|
|  |                         | MIN     | TYP | MAX | MIN     | TYP | MAX | MIN     | TYP | MAX | MIN     | TYP | MAX |      |
| $t_{FALL}$ Bit clock and Frame clock fall time | From +100 mV to -100 mV | 50      | 100 | 200 | 50      | 100 | 200 | 50      | 100 | 200 | 50      | 100 | 200 | ps   |
| LVDS Bit clock duty cycle                      |                         | 45%     | 50% | 55% | 45%     | 50% | 55% | 45%     | 50% | 55% | 45%     | 50% | 55% |      |
| LVDS Frame clock duty cycle                    |                         | 47%     | 50% | 53% | 47%     | 50% | 53% | 47%     | 50% | 53% | 47%     | 50% | 53% |      |

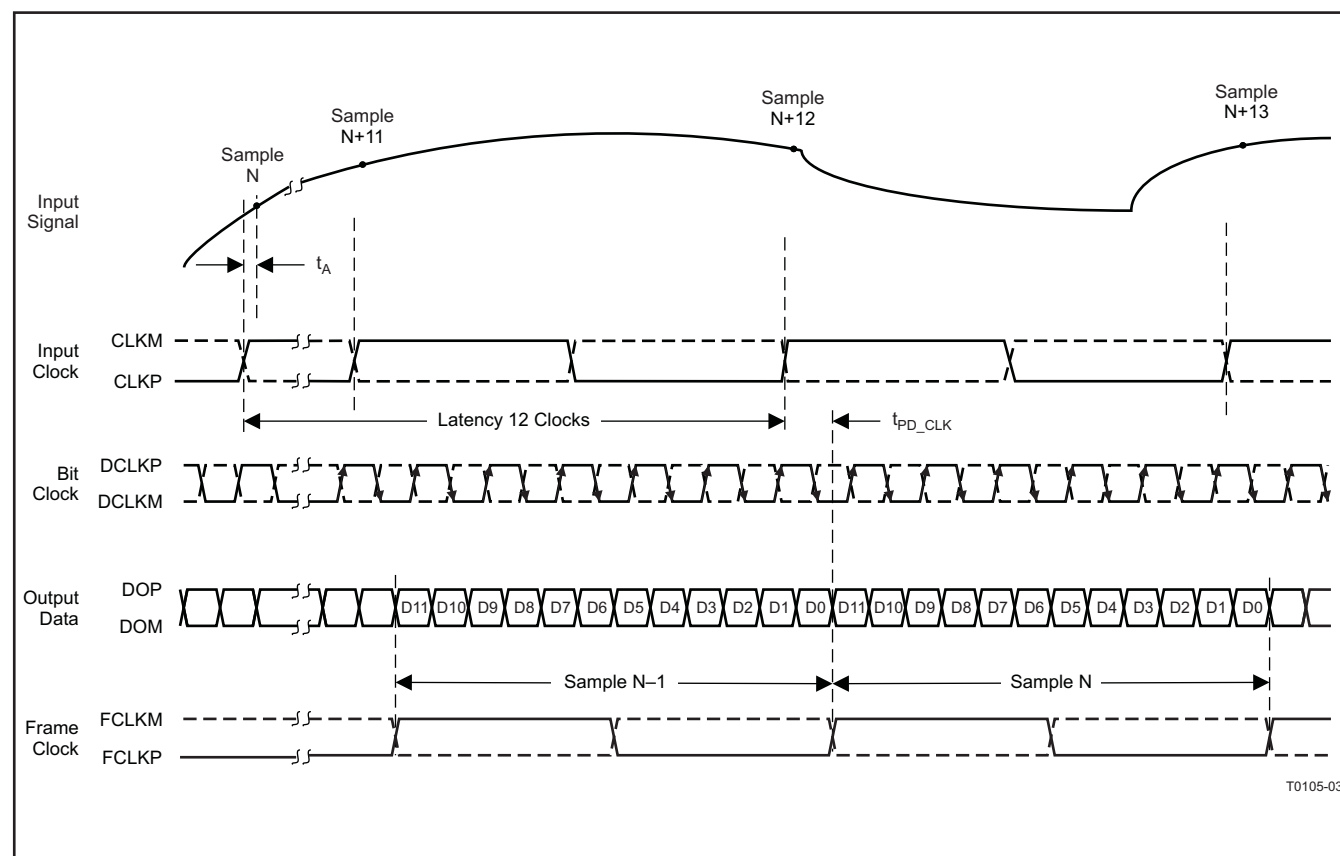
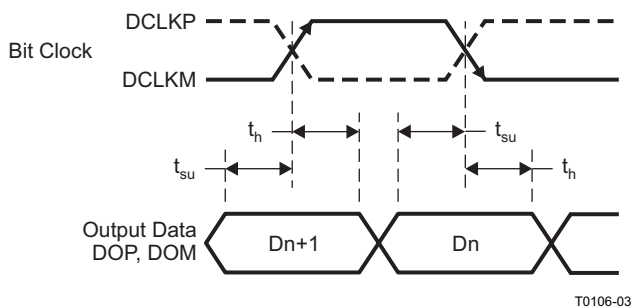


Figure 1. Latency



**Figure 2. LVDS Timings**

## DEVICE PROGRAMMING MODES

ADS622X offers flexibility with several programmable features that are easily configured.

The device can be configured independently using either parallel interface control or serial interface programming.

In addition, the device supports a third configuration mode, where both the parallel interface and the serial control registers are used. In this mode, the priority between the parallel and serial interfaces is determined by a priority table (Table 4). If this additional level of flexibility is not required, the user can select either the serial interface programming or the parallel interface control.

## USING PARALLEL INTERFACE CONTROL ONLY

To control the device using parallel interface, keep RESET tied to **high** (LVDD). Pins CFG1, CFG2, CFG3, CFG4, PDNA, PDNB, SEN, SCLK, and SDATA are used to directly control certain functions of the ADC. After power-up, the device will automatically get configured as per the parallel pin voltage settings (Table 5 to Table 9) and no reset is required. In this mode, SEN, SCLK, and SDATA function as parallel interface control pins.

Frequently used functions are controlled in this mode—output data interface and format, power down modes, coarse gain and internal/external reference. The parallel pins can be configured using a simple resistor string as illustrated in Figure 3.

Table 3 has a description of the modes controlled by the parallel pins.

**Table 3. Parallel Pin Definition**

| PIN         | CONTROL FUNCTIONS                                    |
|-------------|--|
| SEN         | Coarse gain and internal/external reference.         |
| SCLK, SDATA | Sync, deskew patterns and global power down.         |
| PDNA, PDNB  | Dedicated pins for individual channel ADC power down |
| CFG1        | 1-Wire/2-wire and DDR/SDR bit clock                  |
| CFG2        | 12x/14x Serialization and SDR bit clock capture edge |
| CFG3        | Reserved function. <b>Tie CFG3 to Ground.</b>        |
| CFG4        | MSB/LSB First and data format.                       |

## USING SERIAL INTERFACE PROGRAMMING ONLY

In this mode, SEN, SDATA, and SCLK function as serial interface pins and are used to access the internal registers of ADC. The registers must first be reset to their default values either by applying a pulse on RESET pin or by a **high** setting on the <RST> bit (in register ). After reset, the RESET pin must be kept **low**.

The *serial interface section* describes the register programming and register reset in more detail.

Since the parallel pins (CFG1-4, PDNA and PDNB) are not used in this mode, they must be tied to ground. The register override bit <OVRD> - D10 in register 0x0D has to be set **high** to disable the control of parallel interface pins in this serial interface control ONLY mode.

## USING BOTH THE SERIAL INTERFACE AND PARALLEL CONTROLS

For increased flexibility, a combination of serial interface registers and parallel pin controls (CFG1-4, PDNA and PDNB) can also be used to configure the device.

The parallel interface control pins CFG1-4, PDNA and PDNB are available. After power-up, the device will automatically get configured as per the parallel pin voltage settings (Table 5 to Table 12) and no reset is required. A simple resistor string can be used as illustrated in Figure 3.

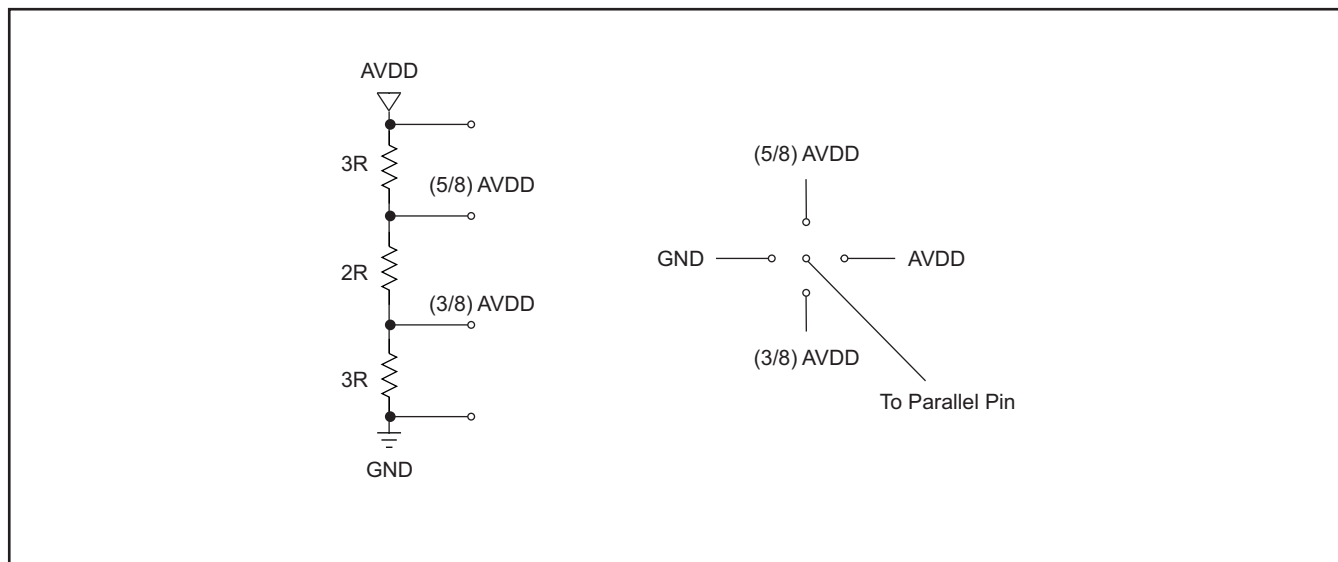
SEN, SDATA, and SCLK function as serial interface pins and are used to access the internal registers of ADC. The registers must first be reset to their default values either by applying a pulse on RESET pin or by a **high** setting on the <RST> bit (in register ). After reset, the RESET pin must be kept **low**.

The *serial interface section* describes the register programming and register reset in more detail.

Since some functions are controlled using both the parallel pins and serial registers, the priority between the two is determined by a priority table (Table 4).

**Table 4. Priority Between Parallel Pins and Serial Registers**

| PIN          | FUNCTIONS SUPPORTED   | PRIORITY   |
|--------------|---|--|
| CFG1 to CFG4 | As described in <a href="#">Table 9</a> to <a href="#">Table 12</a> | Register bits can control the modes ONLY if the <OVRD> bit is <b>high</b> . If the <OVRD> bit is LOW, then the control voltage on these parallel pins determines the function as per Tables  |
| PDN          | Global power down   | D0 Bit of register 0x00 controls Power down global ONLY if PDN pin is LOW. If PDN is <b>high</b> , device is in global power down mode.  |
| SEN          | Serial Interface Enable   | Coarse Gain setting is controlled by bit D5 of register 0x0D ONLY if the <OVRD> bit is <b>high</b> . Else, it is in default register setting of 0 dB COARSE GAIN.<br>Internal/external reference setting is determined by bit D6 of register 0x00. |
| SCLK, SDATA  | Serial Interface Clock and Serial Interface Data pins               | D7, D6, D5 Bits of register 0x0A control the sync and deskew output patterns.<br>Power down is determined by bit D0 of 0x00 register.  |



**Figure 3. Simple Scheme to Configure Parallel Pins**

## DESCRIPTION OF PARALLEL PINS

**Table 5. SCLK, SDATA Control Pins**

| SCLK | SDATA | DESCRIPTION  |
|------|-------|--|
| LOW  | LOW   | NORMAL conversion.   |
| LOW  | HIGH  | SYNC – ADC Outputs sync pattern on all channels. This pattern can be used by the receiver to align the deserialized data to the frame boundary. See <a href="#">Capture Test Patterns</a> for details. |
| HIGH | LOW   | POWER DOWN – Global power down, all channels of the ADC are powered down, including internal references, PLL and output buffers.   |
| HIGH | HIGH  | DESKEW – ADC outputs deskew pattern on all channels. This pattern can be used by the receiver to ensure deserializer uses the right clock edge. See <a href="#">Capture Test Patterns</a> for details. |

**Table 6. SEN Control Pin**

| SEN       | DESCRIPTION   |
|-----------|---|
| 0         | External reference and 0 dB coarse gain (full-scale = 2 Vpp)      |
| (3/8)LVDD | External reference and 3.5 dB coarse gain (full-scale = 1.34 Vpp) |
| (5/8)LVDD | Internal reference and 3.5 dB coarse gain (full-scale = 1.34 Vpp) |
| LVDD      | Internal reference and 0 dB coarse gain (full-scale = 2 Vpp)      |

Independent of the programming mode used, after power-up the parallel pins PDNA,PDNB,CFG1 to CFG4 will automatically configure the device as per the voltage applied (Table 7 to Table 12).

**Table 7. PDNA Control Pin**

| PDNA | DESCRIPTION                     |
|------|---------------------------------|
| 0    | Normal operation                |
| AVDD | Channel A ADC power down global |

**Table 8. PDNB Control Pin**

| PDNB | DESCRIPTION                     |
|------|---------------------------------|
| 0    | Normal operation                |
| AVDD | Channel B ADC power down global |

**Table 9. CFG1 Control Pin**

| CFG1      | DESCRIPTION                        |
|-----------|------------------------------------|
| 0         | DDR Bit clock and 1-wire interface |
| (3/8)LVDD | Not used                           |
| (5/8)LVDD | SDR Bit clock and 2-wire interface |
| LVDD      | DDR Bit clock and 2-wire interface |

**Table 10. CFG2 Control Pin**

| CFG2      | DESCRIPTION  |
|-----------|--|
| 0         | 12x Serialization and capture at falling edge of bit clock (only in 2-wire SDR bit clock mode) |
| (3/8)LVDD | 14x Serialization and capture at falling edge of bit clock (only in 2-wire SDR bit clock mode) |
| (5/8)LVDD | 14x Serialization and capture at rising edge of bit clock (only in 2-wire SDR bit clock mode)  |
| LVDD      | 12x Serialization and capture at rising edge of bit clock (only in 2-wire SDR bit clock mode)  |

**Table 11. CFG3 Control Pin**

| CFG3 | RESERVED – TIE TO GROUND |
|------|--------------------------|
|------|--------------------------|

**Table 12. CFG4 Control Pin**

| CFG4      | DESCRIPTION                 |
|-----------|-----------------------------|
| 0         | MSB First and 2s complement |
| (3/8)LVDD | MSB First and offset binary |
| (5/8)LVDD | LSB First and offset binary |
| LVDD      | LSB First and 2s complement |

## SERIAL INTERFACE

The ADC has a serial interface formed by pins SEN (serial interface enable), SCLK (serial interface clock), SDATA (serial interface data) and RESET. Serial shift of bits into the device is enabled when SEN is low. Serial data SDATA is latched at every falling edge of SCLK when SEN is active (low). The serial data is loaded into the register at every 16th SCLK falling edge when SEN is low. In case the word length exceeds a multiple of 16 bits, the excess bits are ignored. Data can be loaded in multiple of 16-bit words within a single active SEN pulse. The interface can work with SCLK frequency from 20 MHz down to very low speeds (few hertz) and even with non-50% duty cycle SCLK.

The first 5 bits of the 16-bit word are the address of the register while the next 11 bits are the register data.

### Register Reset

After power-up, the internal registers **must** be reset to their default values. This can be done in one of two ways:

1. Either by applying a high-going pulse on RESET (of width greater than 10ns) **OR**
2. By applying software reset. Using the serial interface, set the **<RST>** bit in register 0x00 to **high** – this resets the registers to their default values and then self-resets the **<RST>** bit to LOW.

When RESET pin is not used, it must be tied to LOW.

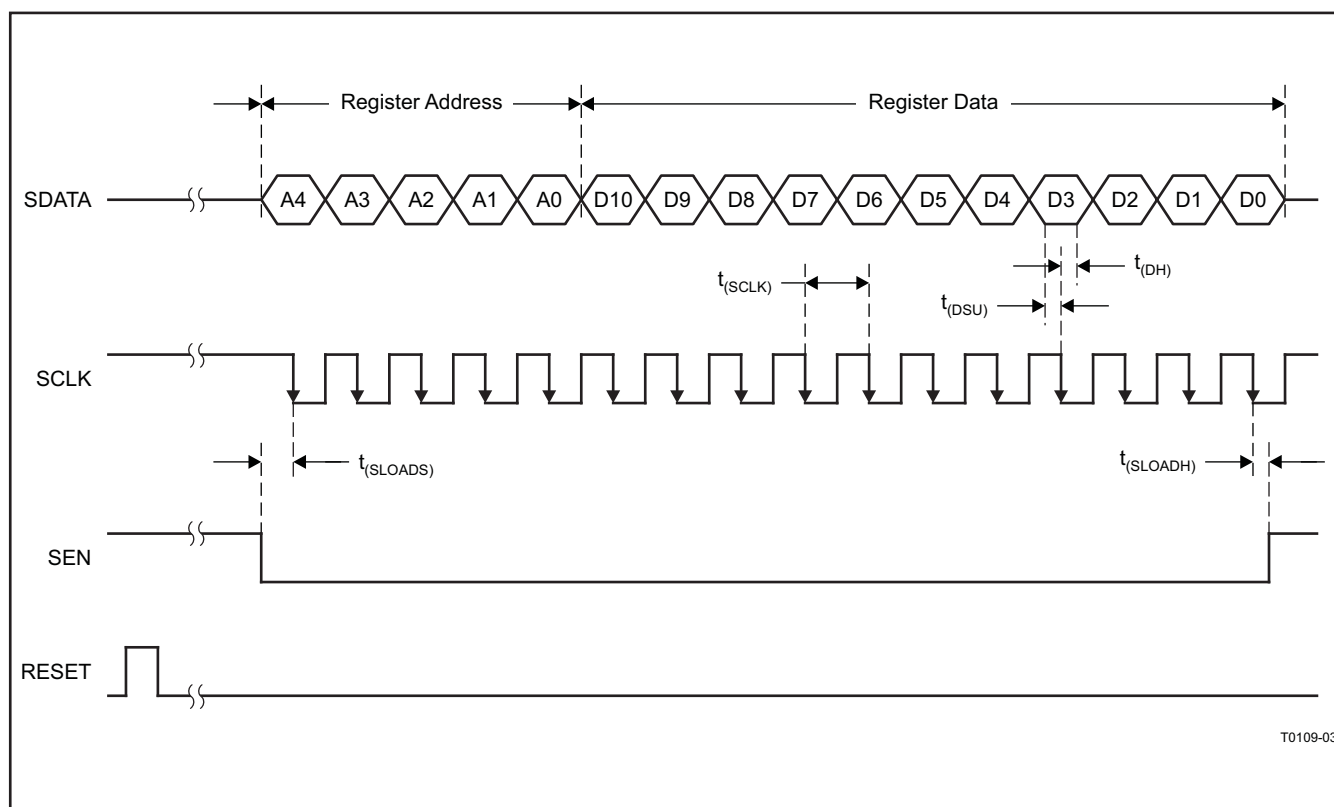


Figure 4. Serial Interface Timing

## SERIAL INTERFACE TIMING CHARACTERISTICS

Typical values at 25°C, min and max values across the full temperature range  $T_{MIN} = -40^{\circ}\text{C}$  to  $T_{MAX} = 85^{\circ}\text{C}$ ,  $AVDD = LVDD = 3.3\text{ V}$ , unless otherwise noted.

| PARAMETER   |   | MIN  | TYP | MAX | UNIT |
|---|---|------|-----|-----|------|
| $f_{SCLK}$  | SCLK Frequency, $f_{SCLK} = 1/t_{SCLK}$ | > DC |     | 20  | MHz  |
| $t_{SLOADS}$  | SEN to SCLK Setup time                  | 25   |     |     | ns   |
| $t_{SLOADH}$  | SCLK to SEN Hold time                   | 25   |     |     | ns   |
| $t_{DSU}$   | SDATA Setup time                        | 25   |     |     | ns   |
| $t_{DH}$  | SDATA Hold time                         | 25   |     |     | ns   |
| Time taken for register write to take effect after 16th SCLK falling edge |   | 100  |     |     | ns   |

## RESET TIMING

Typical values at 25°C, min and max values across the full temperature range  $T_{MIN} = -40^{\circ}\text{C}$  to  $T_{MAX} = 85^{\circ}\text{C}$ ,  $AVDD = LVDD = 3.3\text{ V}$ , unless otherwise noted.

| PARAMETER | CONDITIONS                | MIN | TYP | MAX | UNIT |
|-----------|---------------------------|-----|-----|-----|------|
| $t_1$     | Power-on delay time       | 5   |     |     | ms   |
| $t_2$     | Reset pulse width         | 10  |     |     | ns   |
| $t_3$     | Register write delay time | 25  |     |     | ns   |
| $t_{PO}$  | Power-up delay time       |     | 6.5 |     | ms   |

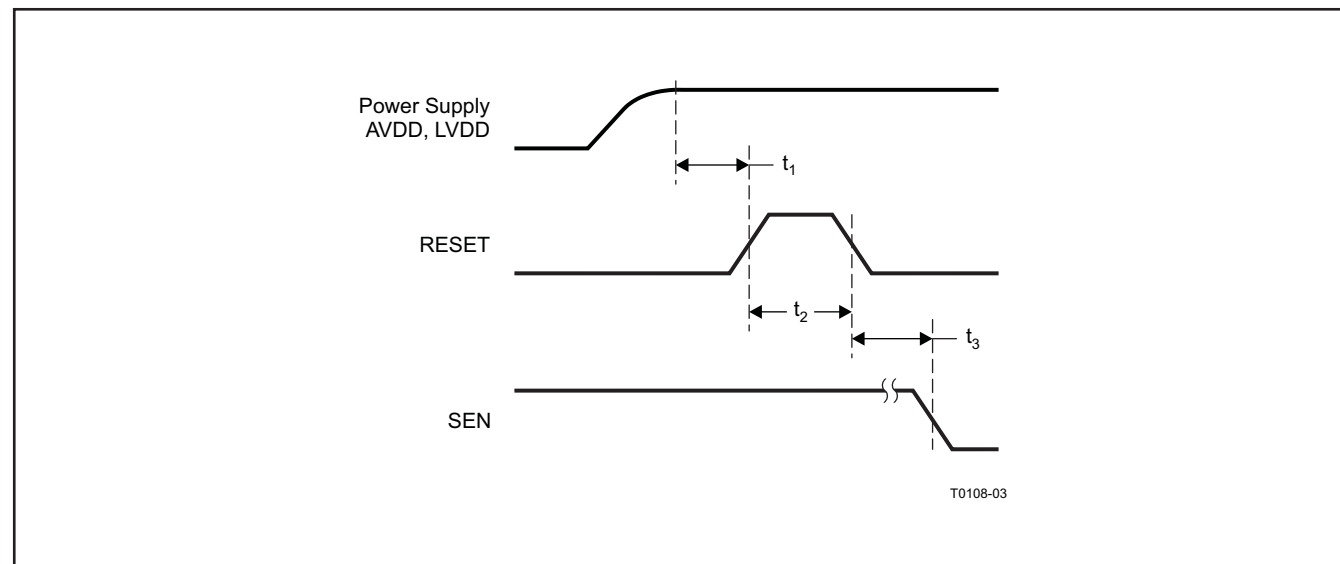


Figure 5. Reset Timing



## SERIAL REGISTER MAP

**Table 13. Summary of Functions Supported By Serial Interface**

| REGISTER ADDRESS | REGISTER FUNCTIONS <sup>(1)(2)</sup>                        |  |    |                             |   |  |   |                                |                                  |                                      |   |
|------------------|---|--|----|-----------------------------|---|--|---|--------------------------------|----------------------------------|--------------------------------------|---|
| A4–A0            | D10   | D9   | D8 | D7                          | D6  | D5   | D4  | D3                             | D2                               | D1                                   | D0  |
| 00               | <RST><br>S/W RESET  | 0  | 0  | 0                           | 0   | <REF><br>INTERNAL<br>OR<br>EXTERNAL          | 0   | <PDN CHB><br>POWER<br>DOWN CHB | <PDN CHA><br>POWER<br>DOWN CH A  | 0                                    | <PDN<br>GLOBAL><br>GLOBAL<br>POWER<br>DOWN      |
| 04               | 0   | 0  | 0  | 0                           | <CLKIN GAIN><br>INPUT CLOCK BUFFER GAIN CONTROL |  |   |                                |                                  | 0                                    | 0   |
| 0A               | 0   | <DF><br>DATA<br>FORMAT 2S<br>COMP OR<br>STRAIGHT<br>BINARY | 0  | <PATTERNS><br>TEST PATTERNS |   |  | 0   | 0                              | 0                                | 0                                    | 0   |
| 0B               | <CUSTOM A><br>CUSTOM PATTERN (LOWER 11 BITS)                |  |    |                             |   |  |   |                                |                                  |                                      |   |
| 0C               | <FINE GAIN><br>FINE GAIN CONTROL (1dB to 6 dB)              |  |    | 0                           | 0   | 0  | 0   | 0                              | 0                                | 0                                    | <CUSTOM<br>B><br>CUSTOM<br>PATTERN<br>(MSB BIT) |
| 0D               | <OVRD><br>OVERRIDE<br>BIT                                   | 0  | 0  | BYTE-WISE<br>OR<br>BIT-WISE | MSB OR<br>LSB FIRST                             | <COARSE<br>GAIN><br>COURSE<br>GAIN<br>ENABLE | FALLING OR<br>RISING BIT<br>CLOCK<br>CAPTURE<br>EDGE    | 0                              | 12-BIT OR<br>14-BIT<br>SERIALIZE | DDR OR<br>SDR BIT<br>CLOCK           | 1-WIRE OR<br>2-WIRE<br>INTERFACE                |
| 10               | <TERM CLK><br>LVDS INTERNAL TERMINATION BIT AND WORD CLOCKS |  |    |                             |   | <LVDS CURR><br>LVDS CURRENT SETTINGS         |   |                                |                                  | <CURR DOUBLE><br>LVDS CURRENT DOUBLE |   |
| 11               | WORD-WISE CONTROL   |  | 0  | 0                           | 0   | 0  | <TERM DATA><br>LVDS INTERNAL TERMINATION - DATA OUTPUTS |                                |                                  |                                      |   |

- (1) The unused bits in each register (shown by blank cells in above table) must be programmed as 0.  
(2) Multiple functions in a register can be programmed in a single write operation.

## DESCRIPTION OF SERIAL REGISTERS

Table 14.

| REGISTER ADDRESS | BITS               |    |    |    |    |                                     |    |                                |                                 |    |                                  |
|------------------|--------------------|----|----|----|----|-------------------------------------|----|--------------------------------|---------------------------------|----|----------------------------------|
| A4–A0            | D10                | D9 | D8 | D7 | D6 | D5                                  | D4 | D3                             | D2                              | D1 | D0                               |
| 00               | <RST><br>S/W RESET | 0  | 0  | 0  | 0  | <REF><br>INTERNAL<br>OR<br>EXTERNAL | 0  | <PDN CHB><br>POWER<br>DOWN CHB | <PDN CHA><br>POWER<br>DOWN CH A | 0  | <PDN><br>GLOBAL<br>POWER<br>DOWN |

### D0 - D4

### Power down modes

#### D0

#### <PDN GLOBAL>

0

Normal operation

1

Global power down, including all channels ADCs, internal references, internal PLL and output buffers

#### D2

#### <PDN CHA>

0

CH A Powered up

1

CH A ADC Powered down

#### D3

#### <PDN CHB>

0

CH B Powered up

1

CH B ADC Powered down

#### D5

#### <REF> [Reference](#)

0

Internal reference enabled

1

External reference enabled

#### D10

#### <RST>

1

Software reset applied – resets all internal registers and self-clears to 0

**Table 15.**

| REGISTER ADDRESS | BITS |    |    |    |   |    |    |    |    |    |    |
|------------------|------|----|----|----|---|----|----|----|----|----|----|
| A4 - A0          | D10  | D9 | D8 | D7 | D6  | D5 | D4 | D3 | D2 | D1 | D0 |
| 04               | 0    | 0  | 0  | 0  | <CLKIN GAIN><br>INPUT CLOCK BUFFER GAIN CONTROL |    |    |    |    | 0  | 0  |

**D6–D2**
**<CLKIN GAIN>** [Input clock buffer gain control](#)

|       |                     |
|-------|---------------------|
| 11000 | Gain 0 minimum gain |
| 00000 | Gain 1              |
| 01100 | Gain 2              |
| 01010 | Gain 3              |
| 01001 | Gain 4              |
| 01000 | Gain 5 maximum gain |

**Table 16.**

| REGISTER ADDRESS | BITS |   |    |                             |    |    |    |    |    |    |    |
|------------------|------|---|----|-----------------------------|----|----|----|----|----|----|----|
| A4–A0            | D10  | D9  | D8 | D7                          | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 00               | 0    | <DF><br>DATA<br>FORMAT -<br>2S COMP<br>OR<br>STRAIGHT<br>BINARY | 0  | <PATTERNS><br>TEST PATTERNS |    |    | 0  | 0  | 0  | 0  | 0  |

**D7–D5**
**<PATTERNS>** [Capture test patterns](#)

|     |  |
|-----|--|
| 000 | Normal ADC operation   |
| 001 | Output all zeros   |
| 010 | Output all ones  |
| 011 | Output toggle pattern  |
| 100 | Unused   |
| 101 | Output custom pattern (contents of CUSTOM pattern registers 0x0B and 0x0C) |
| 110 | Output DESKEW pattern (serial stream of 1010..)                            |
| 111 | Output SYNC pattern  |

**D9**
**<DF>** Data format selection

|   |                        |
|---|------------------------|
| 0 | 2s Complement format   |
| 1 | Straight binary format |

**Table 17.**

| REGISTER ADDRESS | BITS   |    |    |    |    |    |    |    |    |    |    |
|------------------|--|----|----|----|----|----|----|----|----|----|----|
| A4–A0            | D10  | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 0B               | <CUSTOM A><br>CUSTOM PATTERN (LOWER 11 BITS) |    |    |    |    |    |    |    |    |    |    |

**D10 - D0**      <CUSTOM A> Lower 11 bits of custom pattern <DATAOUT10>...<DATAOUT0>

**Table 18.**

| REGISTER ADDRESS | BITS  |    |    |    |    |    |    |    |    |    |                                    |
|------------------|---|----|----|----|----|----|----|----|----|----|------------------------------------|
| A4–A0            | D10   | D9 | D8 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0                                 |
| 0C               | <FINE GAIN><br>FINE GAIN CONTROL (1 dB to 6 dB) |    |    | 0  | 0  | 0  | 0  | 0  | 0  | 0  | <CUSTOM B><br>CUSTOM PATTERN (MSB) |

**D0**      <CUSTOM B> MSB of 12-bit custom pattern <DATAOUT11>

**D10–D8**      <FINE GAIN> [Fine gain control](#)

|     |   |
|-----|---|
| 000 | 0 dB Gain (full-scale range = 2.00 Vpp) |
| 001 | 1 dB Gain (full-scale range = 1.78 Vpp) |
| 010 | 2 dB Gain (full-scale range = 1.59 Vpp) |
| 011 | 3 dB Gain (full-scale range = 1.42 Vpp) |
| 100 | 4 dB Gain (full-scale range = 1.26 Vpp) |
| 101 | 5 dB Gain (full-scale range = 1.12 Vpp) |
| 110 | 6 dB Gain (full-scale range = 1.00 Vpp) |

**Table 19.**

| REGISTER ADDRESS | BITS                     |    |    |                             |                     |  |  |    |                                  |                            |                                  |
|------------------|--------------------------|----|----|-----------------------------|---------------------|--|--|----|----------------------------------|----------------------------|----------------------------------|
| A4–A0            | D10                      | D9 | D8 | D7                          | D6                  | D5   | D4   | D3 | D2                               | D1                         | D0                               |
| 0D               | <OVRD><br>OVER-RIDE BITE | 0  | 0  | BYTE-WISE<br>OR<br>BIT-WISE | MSB OR<br>LSB FIRST | <COARSE<br>GAIN><br>COARSE<br>GAIN<br>ENABLE | FALLING OR<br>RISING BIT<br>CLOCK<br>CAPTURE<br>EDGE | 0  | 14-BIT OR<br>16-BIT<br>SERIALIZE | DDR OR<br>SDR BIT<br>CLOCK | 1-WIRE OR<br>2-WIRE<br>INTERFACE |

**D0**      **Interface selection**

|   |                  |
|---|------------------|
| 0 | 1 Wire interface |
| 1 | 2 Wire interface |

**D1**      **Bit clock selection** (only in 2-wire interface)

|   |               |
|---|---------------|
| 0 | DDR Bit clock |
| 1 | SDR Bit clock |

**D2**      **Serialization selection**

|   |                   |
|---|-------------------|
| 0 | 12x Serialization |
| 1 | 14x Serialization |

|            |  |
|------------|--|
| <b>D4</b>  | <b>Bit clock capture edge</b> (only when SDR bit clock is selected, D1 = 1)  |
| 0          | Capture data with falling edge of bit clock  |
| 1          | Capture data with rising edge of bit clock   |
| <b>D5</b>  | <b>&lt;COARSE GAIN&gt; Coarse gain control</b>   |
| 0          | 0 dB Coarse gain   |
| 1          | 3.5dB Coarse gain (Full-scale range = 1.34 Vpp)  |
| <b>D6</b>  | <b>MSB or LSB first selection</b>  |
| 0          | MSB First  |
| 1          | LSB First  |
| <b>D7</b>  | <b>Byte/bit wise outputs</b> (only when 2-wire is selected)  |
| 0          | Byte wise  |
| 1          | Bit wise   |
| <b>D10</b> | <b>&lt;OVRD&gt;</b> Over-ride bit. All the functions in register 0x0D can also be controlled using the parallel control pins. By setting bit <OVRD> = 1, the contents of register 0x0D will over-ride the settings of the parallel pins. |
| 0          | Disable over-ride  |
| 1          | Enable over-ride   |

**Table 20.**

| REGISTER ADDRESS | BITS  |   |    |    |    |    |                                      |    |    |    |                                      |
|------------------|-------|---|----|----|----|----|--------------------------------------|----|----|----|--------------------------------------|
|                  | A4–A0 | D10   | D9 | D8 | D7 | D6 | D5                                   | D4 | D3 | D2 | D1 D0                                |
| 10               |       | <TERM CLK><br>LVDS INTERNAL TERMINATION BIT AND WORD CLOCKS |    |    |    |    | <LVDS CURR><br>LVDS CURRENT SETTINGS |    |    |    | <LVDS DOUBLE><br>LVDS CURRENT DOUBLE |

|              |   |
|--------------|---|
| <b>D0</b>    | <b>&lt;CURR DOUBLE&gt;</b> LVDS current double for data outputs               |
| 0            | Nominal LVDS current, as set by <D5...D2>                                     |
| 1            | Double the nominal value  |
| <b>D1</b>    | <b>&lt;CURR DOUBLE&gt;</b> LVDS current double for bit and word clock outputs |
| 0            | Nominal LVDS current, as set by <D5...D2>                                     |
| 1            | Double the nominal value  |
| <b>D3–D2</b> | <b>&lt;LVDS CURR&gt;</b> LVDS current setting for data outputs                |
| 00           | 3.5 mA  |
| 01           | 4 mA  |
| 10           | 2.5 mA  |
| 11           | 3 mA  |
| <b>D5–D4</b> | <b>&lt;LVDS CURR&gt;</b> LVDS current setting for bit and word clock outputs  |
| 00           | 3.5 mA  |
| 01           | 4 mA  |
| 10           | 2.5 mA  |
| 11           | 3 mA  |

**D10–D6** [\*\*<TERM CLK> LVDS internal termination for bit and word clock outputs\*\*](#)

|       |                         |
|-------|-------------------------|
| 00000 | No internal termination |
| 00001 | 166 $\Omega$            |
| 00010 | 200 $\Omega$            |
| 00100 | 250 $\Omega$            |
| 01000 | 333 $\Omega$            |
| 10000 | 500 $\Omega$            |

Any combination of above bits can also be programmed, resulting in a parallel combination of the selected values. For example, 00101 is the parallel combination of 166||250 = 100  $\Omega$

|       |              |
|-------|--------------|
| 00101 | 100 $\Omega$ |
|-------|--------------|

**Table 21.**

| REGISTER ADDRESS | BITS              |    |    |    |    |    |  |    |    |    |    |
|------------------|-------------------|----|----|----|----|----|--|----|----|----|----|
| A4–A0            | D10               | D9 | D8 | D7 | D6 | D5 | D4   | D3 | D2 | D1 | D0 |
| 11               | WORD-WISE CONTROL |    | 0  | 0  | 0  | 0  | <b>&lt;TERM DATA&gt;</b><br>LVDS INTERNAL TERMINATION - DATA OUTPUTS |    |    |    |    |

**D4–D0** [\*\*<TERM DATA> LVDS internal termination for data outputs\*\*](#)

|       |                         |
|-------|-------------------------|
| 00000 | No internal termination |
| 00001 | 166 $\Omega$            |
| 00010 | 200 $\Omega$            |
| 00100 | 250 $\Omega$            |
| 01000 | 333 $\Omega$            |
| 10000 | 500 $\Omega$            |

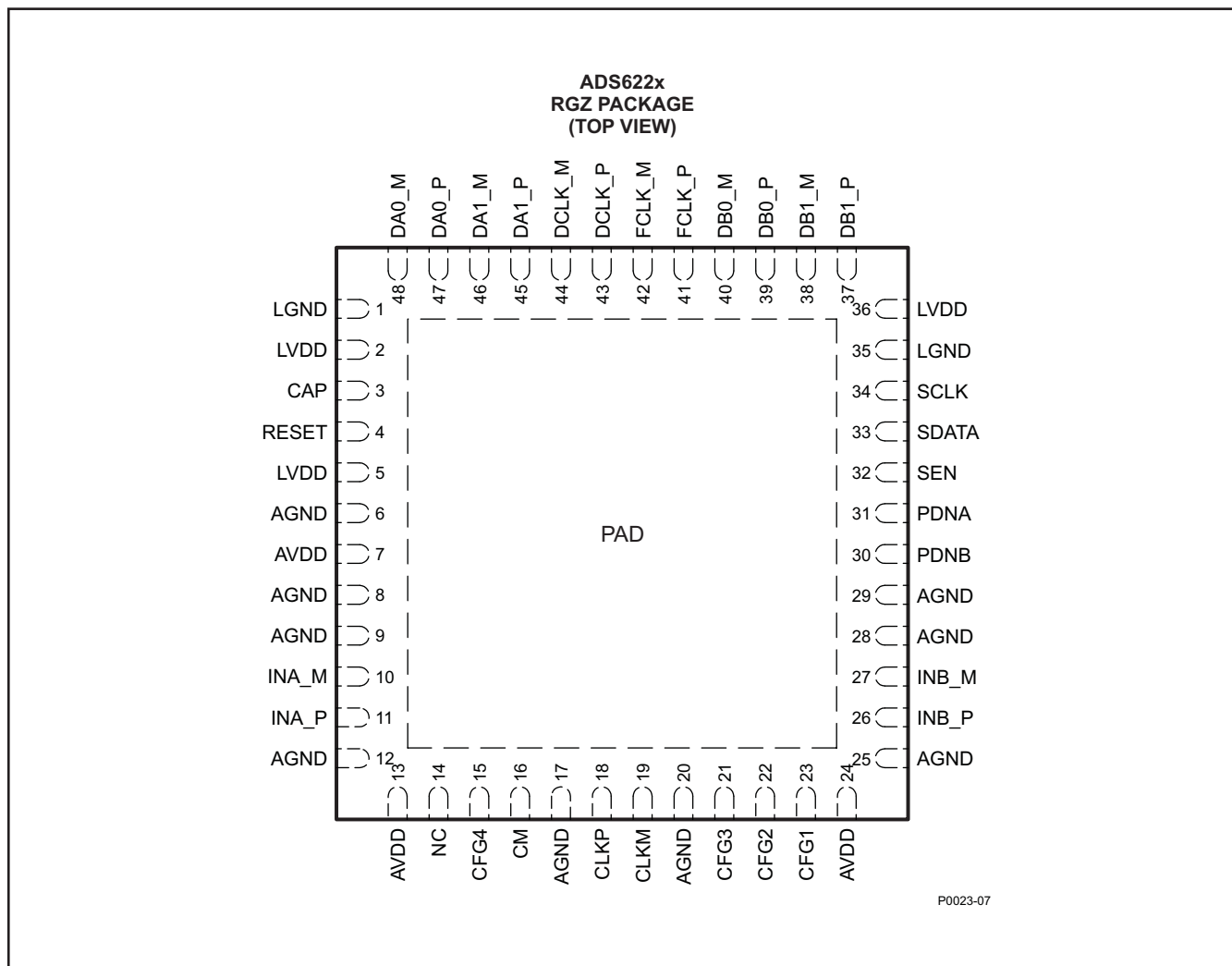
Any combination of above bits can also be programmed, resulting in a parallel combination of the selected values. For example, 00101 is the parallel combination of 166||250 = 100  $\Omega$

|       |              |
|-------|--------------|
| 00101 | 100 $\Omega$ |
|-------|--------------|

**D10–D9** [\*\*Only when 2-wire interface is selected\*\*](#)

|       |  |
|-------|--|
| 00    | Byte-wise or bit-wise output, 1x frame clock |
| 11    | Word-wise output enabled, 0.5x frame clock   |
| 01,10 | Do not use                                   |

## PIN CONFIGURATION (2-WIRE INTERFACE)



## PIN ASSIGNMENTS (2-WIRE INTERFACE)

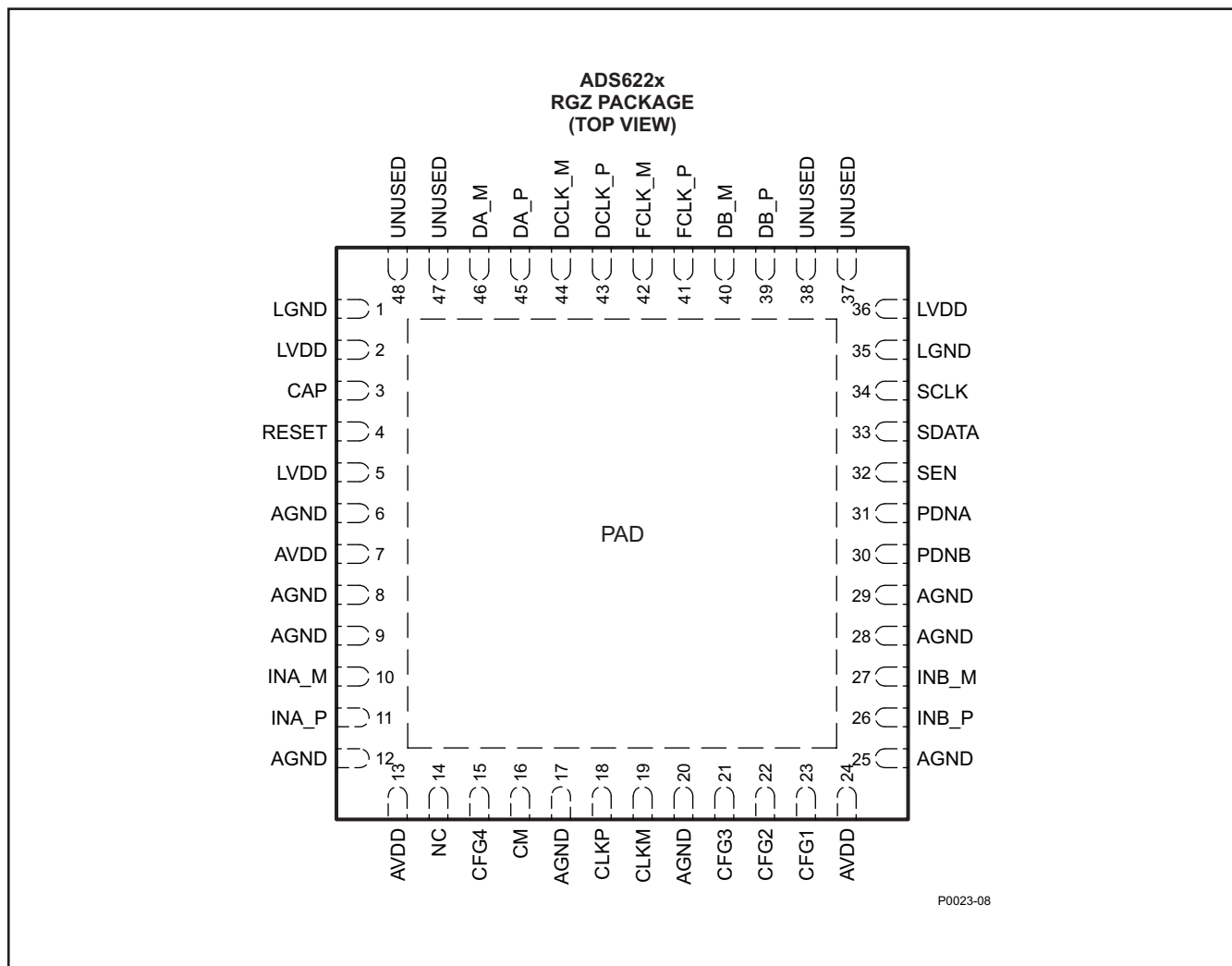
| PINS                   |                         | I/O | NO. OF PINS | DESCRIPTION   |
|------------------------|-------------------------|-----|-------------|---|
| NAME                   | NO.                     |     |             |   |
| SUPPLY AND GROUND PINS |                         |     |             |   |
| AVDD                   | 7,13,24                 |     | 3           | Analog power supply   |
| AGND                   | 6,8,9,12,17,20,25,28,29 |     | 9           | Analog ground   |
| LVDD                   | 2,5,36                  |     | 3           | Digital power supply  |
| LGND                   | 1,35                    |     | 2           | Digital ground  |
| INPUT PINS             |                         |     |             |   |
| CLKP, CLKM             | 18,19                   | I   | 2           | Differential input clock pair   |
| INA_P, INA_M           | 11,10                   | I   | 2           | Differential input signal pair, channel A. If unused, the pins should be tied to VCM. Do not float. |
| INB_P, INB_M           | 26,27                   | I   | 12          | Differential input signal pair, channel B. If unused, the pins should be tied to VCM. Do not float. |
| CAP                    | 3                       | I   | 1           | Connect 2-nF capacitor from pin to ground   |

## PIN ASSIGNMENTS (2-WIRE INTERFACE) (continued)

| PINS               |       | I/O | NO. OF PINS | DESCRIPTION   |
|--------------------|-------|-----|-------------|---|
| NAME               | NO.   |     |             |   |
| SCLK               | 34    | I   | 1           | This pin functions as serial interface clock input when RESET is low. When RESET is <b>high</b> , it controls DESKEW, SYNC and global POWER DOWN modes (along with SDATA). See <a href="#">Table 5</a> for description. This pin has an internal pull-down resistor.  |
| SDATA              | 33    | I   | 1           | This pin functions as serial interface data input when RESET is low. When RESET is <b>high</b> , it controls DESKEW, SYNC and global POWER DOWN modes (along with SCLK). See <a href="#">Table 5</a> for description. This pin has an internal pull-down resistor.  |
| SEN                | 32    | I   | 1           | This pin functions as serial interface enable input when RESET is low. When RESET is <b>high</b> , it controls coarse gain and internal/external reference modes. See <a href="#">Table 6</a> for description. This pin has an internal pull-up resistor.   |
| RESET              | 4     | I   | 1           | Serial interface reset input.<br>When using the serial interface mode, the user MUST initialize internal registers through hardware RESET by applying a high-going pulse on this pin or by using software reset option. Refer to the <a href="#">Serial Interface</a> section. In parallel interface mode, tie RESET permanently <b>high</b> . (SCLK, SDATA and SEN function as parallel control pins in this mode).<br>The pin has an internal pull-down resistor to ground. |
| PDNA               | 31    | I   | 1           | Channel A ADC power down control pin.   |
| PDNB               | 30    | I   | 1           | Channel B ADC power down control pin.   |
| CFG1               | 23    | I   | 1           | Parallel input pin. It controls 1-wire or 2-wire interface and DDR or SDR bit clock selection. See <a href="#">Table 9</a> for description. Tie to AVDD for 2-wire interface with DDR bit clock.  |
| CFG2               | 22    | I   | 1           | Parallel input pin. It controls 12x or 14x serialization and SDR bit clock capture edge. See <a href="#">Table 10</a> for description. For 12x serialization with DDR bit clock, tie to ground or AVDD.   |
| CFG3               | 21    | I   | 1           | RESERVED pin - <b>TIE to ground.</b>  |
| CFG4               | 15    | I   | 1           | Parallel input pin. It controls data format and MSB or LSB first modes. See <a href="#">Table 12</a> for description.   |
| VCM                | 16    | IO  | 1           | Internal reference mode – common-mode voltage output<br>External reference mode – reference input. The voltage forced on this pin sets the internal reference.  |
| <b>OUTPUT PINS</b> |       |     |             |   |
| DA0_P,DA0_M        | 47,48 | O   | 2           | Channel A differential LVDS data output pair, wire 0  |
| DA1_P,DA1_M        | 45,46 | O   | 2           | Channel A differential LVDS data output pair, wire 1  |
| DB0_P,DB0_M        | 39,40 | O   | 2           | Channel B differential LVDS data output pair, wire 0  |
| DB1_P,DB1_M        | 37,38 | O   | 2           | Channel B differential LVDS data output pair, wire 1  |
| DCLKP,DCLKM        | 43,44 | O   | 2           | Differential bit clock output pair  |
| FCLKP,FCLKM        | 41,42 | O   | 2           | Differential frame clock output pair  |
| NC                 | 14    |     | 1           | Do Not Connect  |
| PAD                | 0     |     | 1           | Connect to ground plane using multiple vias. Refer to <a href="#">Board Design Considerations</a> in application section  |



## PIN CONFIGURATION (1-WIRE INTERFACE)



## PIN ASSIGNMENTS (1-WIRE INTERFACE)

| PINS                   |                         | I/O | NO. OF PINS | DESCRIPTION   |
|------------------------|-------------------------|-----|-------------|---|
| NAME                   | NO.                     |     |             |   |
| SUPPLY AND GROUND PINS |                         |     |             |   |
| AVDD                   | 7,13,24                 |     | 3           | Analog power supply   |
| AGND                   | 6,8,9,12,17,20,25,28,29 |     | 9           | Analog ground   |
| LVDD                   | 2,5,36                  |     | 3           | Digital power supply  |
| LGND                   | 1,35                    |     | 2           | Digital ground  |
| INPUT PINS             |                         |     |             |   |
| CLKP, CLKM             | 18,19                   | I   | 2           | Differential input clock pair   |
| INA_P, INA_M           | 11,10                   | I   | 2           | Differential input signal pair, channel A. If unused, the pins should be tied to VCM. Do not float. |
| IND_P, IND_M           | 26,27                   | I   | 12          | Differential input signal pair, channel D. If unused, the pins should be tied to VCM. Do not float. |
| CAP                    | 3                       | I   | 1           | Connect 2-nF capacitance from pin to ground   |

### PIN ASSIGNMENTS (1-WIRE INTERFACE) (continued)

| PINS               |             | I/O | NO.<br>OF<br>PINS | DESCRIPTION   |
|--------------------|-------------|-----|-------------------|---|
| NAME               | NO.         |     |                   |   |
| SCLK               | 34          | I   | 1                 | This pin functions as serial interface clock input when RESET is <b>low</b> . When RESET is <b>high</b> , it controls DESKEW, SYNC and global POWER DOWN modes (along with SDATA). See <a href="#">Table 5</a> for description. This pin has an internal pull-down resistor.  |
| SDATA              | 33          | I   | 1                 | This pin functions as serial interface data input when RESET is <b>low</b> . When RESET is <b>high</b> , it controls DESKEW, SYNC and global POWER DOWN modes (along with SCLK). See <a href="#">Table 5</a> for description. This pin has an internal pull-down resistor.  |
| SEN                | 32          | I   | 1                 | This pin functions as serial interface enable input when RESET is <b>low</b> . When RESET is <b>high</b> , it controls coarse gain and internal/external reference modes. See <a href="#">Table 6</a> for description. This pin has an internal pull-up resistor.   |
| RESET              | 4           | I   | 1                 | Serial interface reset input.<br>When using the serial interface mode, the user MUST initialize internal registers through hardware RESET by applying a high-going pulse on this pin or by using software reset option. Refer to the <a href="#">Serial Interface</a> section. In parallel interface mode, tie RESET permanently <b>high</b> . (SCLK, SDATA and SEN function as parallel control pins in this mode).<br>The pin has an internal pull-down resistor to ground. |
| PDNA               | 31          | I   | 1                 | Channel A ADC power down control pin.   |
| PDNB               | 30          | I   | 1                 | Channel B ADC power down control pin.   |
| CFG1               | 23          | I   | 1                 | Parallel input pin. It controls 1-wire or 2-wire interface and DDR or SDR bit clock selection. See <a href="#">Table 9</a> for description.<br>Tie to ground for 1-wire interface with DDR bit clock.   |
| CFG2               | 22          | I   | 1                 | Parallel input pin. It controls 12x or 14x serialization and SDR bit clock capture edge. See <a href="#">Table 10</a> for description.<br>For 12x serialization with DDR bit clock, tie to ground or AVDD.  |
| CFG3               | 21          | I   | 1                 | RESERVED pin - <b>TIE to ground</b> .   |
| CFG4               | 15          | I   | 1                 | Parallel input pin. It controls data format and MSB or LSB first modes. See <a href="#">Table 12</a> for description.   |
| VCM                | 16          | IO  | 1                 | Internal reference mode – common-mode voltage output<br>External reference mode – reference input. The voltage forced on this pin sets the internal reference.  |
| <b>OUTPUT PINS</b> |             |     |                   |   |
| DA_P,DA_M          | 45,46       | O   | 2                 | Channel A differential LVDS data output pair  |
| DB_P,DB_M          | 39,40       | O   | 2                 | Channel B differential LVDS data output pair  |
| DCLKP,DCLKM        | 43,44       | O   | 2                 | Differential bit clock output pair  |
| FCLKP,FCLKM        | 41,42       | O   | 2                 | Differential frame clock output pair  |
| UNUSED             | 37,38,47,48 |     | 4                 | These pins are unused in the 1-wire interface. Do not connect   |
| NC                 | 14          |     | 1                 | Do not connect  |
| PAD                | 0           |     | 1                 | Connect to ground plane using multiple vias. Refer to <a href="#">Board Design Considerations</a> in application section  |

## TYPICAL CHARACTERISTICS

All plots are at 25°C, AVDD = LVDD = 3.3 V, maximum rated sampling frequency, sine wave input clock, 1.5 V<sub>PP</sub> differential clock amplitude, 50% clock duty cycle, –1 dBFS differential analog input, internal reference mode, 0 dB gain (unless otherwise noted)

### ADS6225 (F<sub>S</sub> = 125 MSPS)

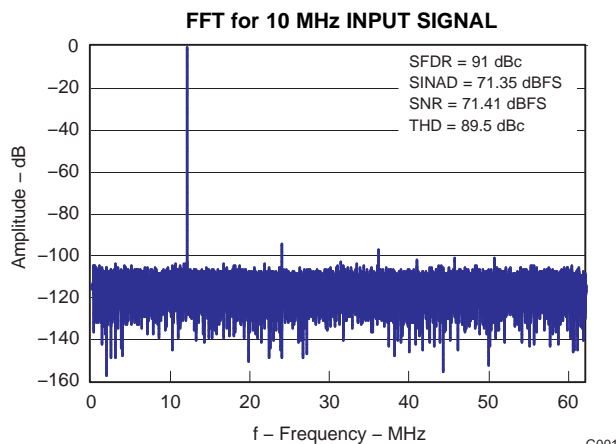


Figure 6.

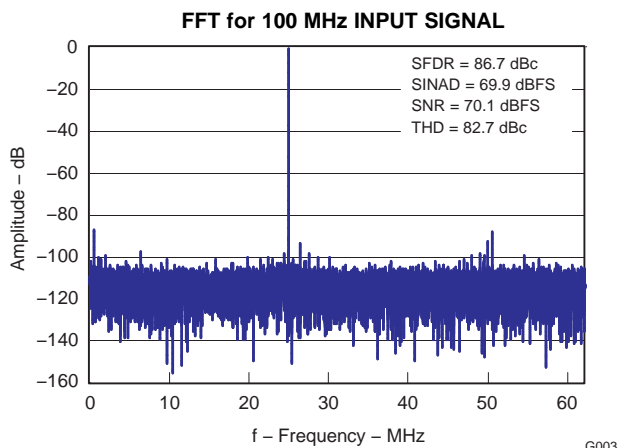


Figure 7.

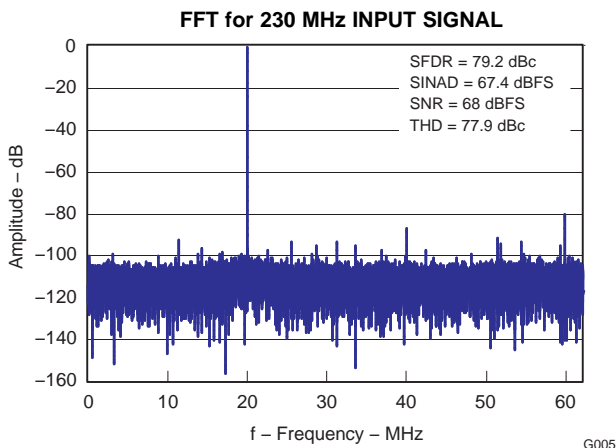


Figure 8.

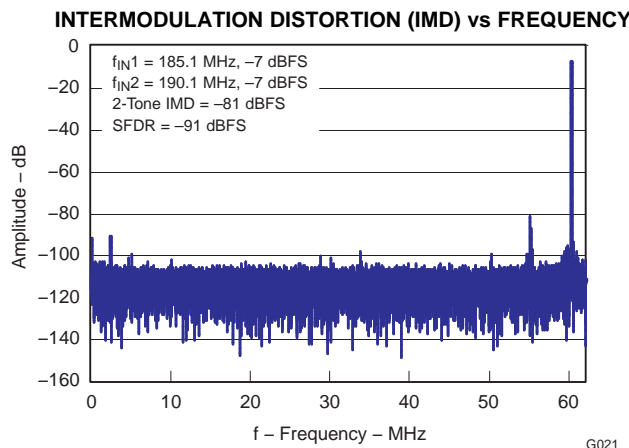


Figure 9.

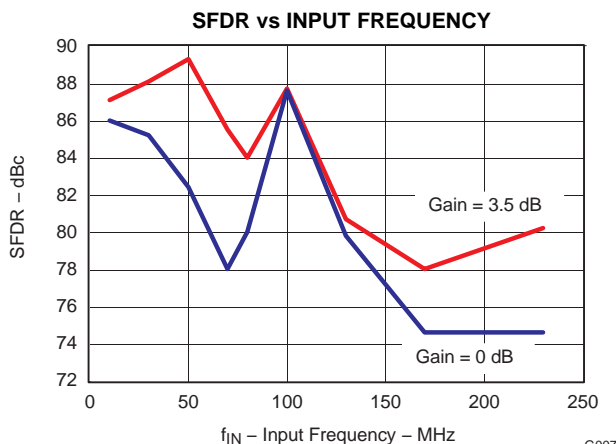


Figure 10.

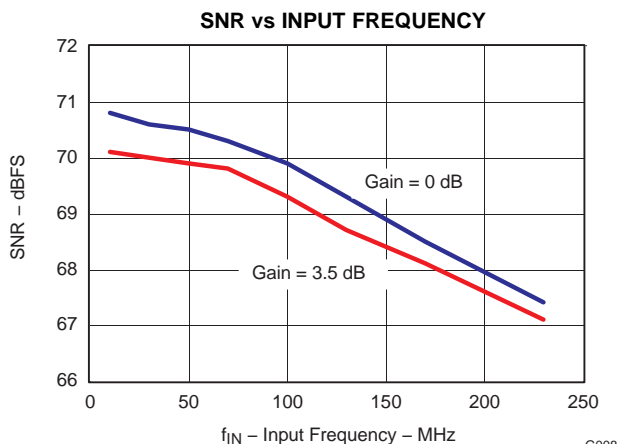


Figure 11.

# ADS6225 ( $F_s = 125$ MSPS) (continued)

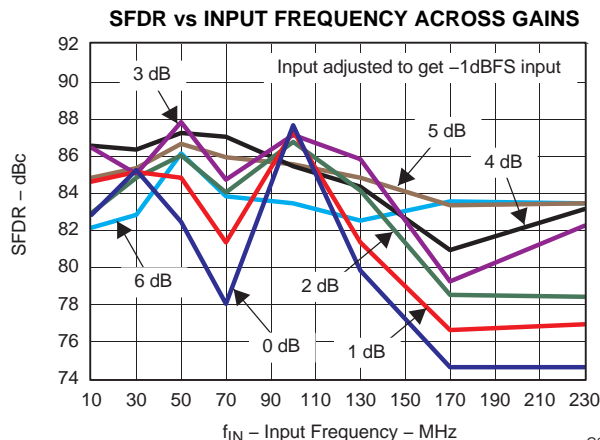


Figure 12.

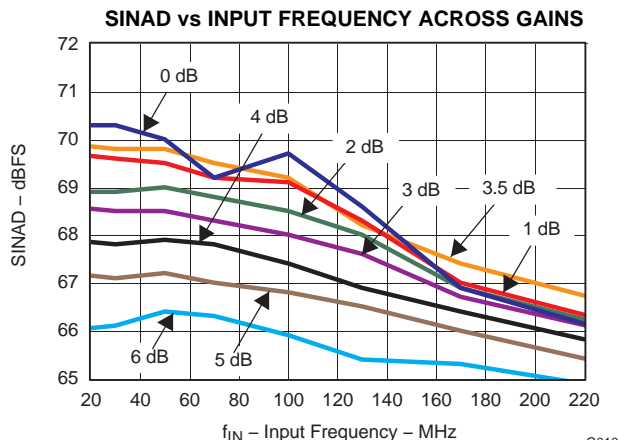


Figure 13.

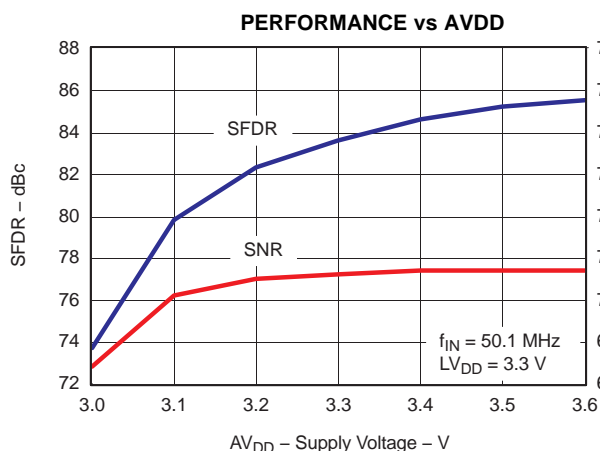


Figure 14.

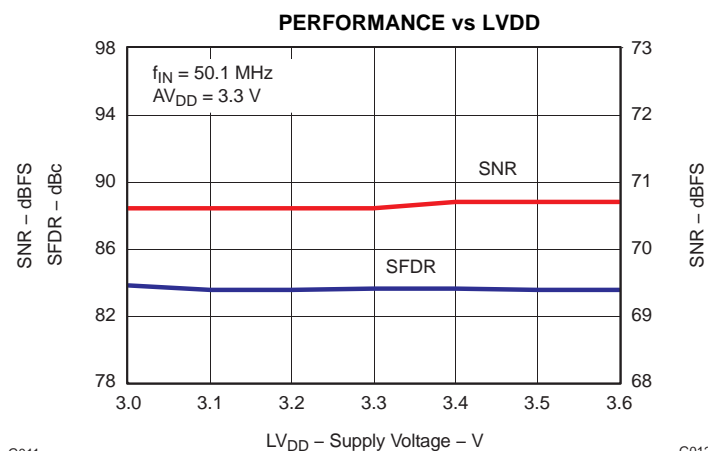


Figure 15.

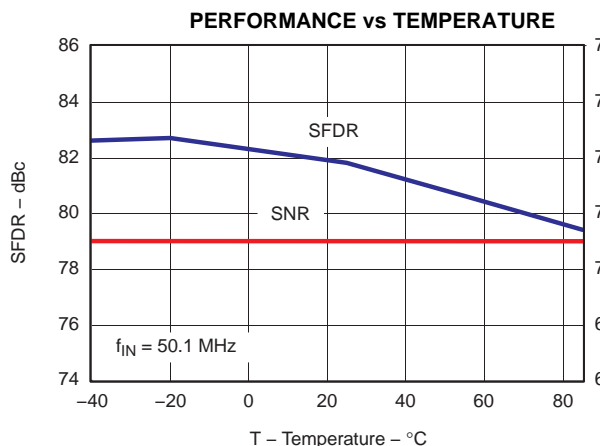


Figure 16.

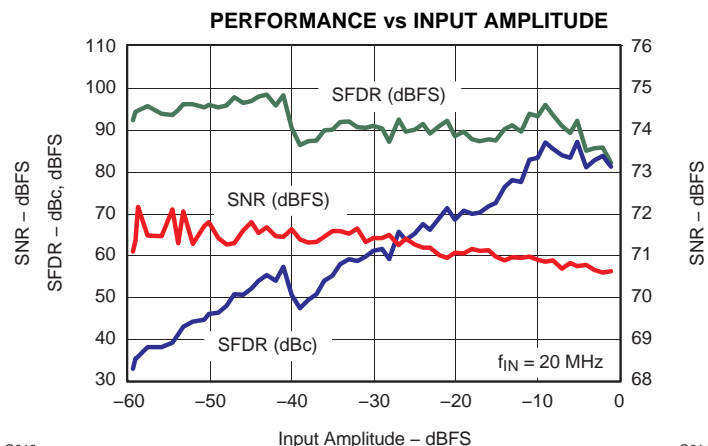


Figure 17.

## ADS6225 ( $F_s = 125$ MSPS) (continued)

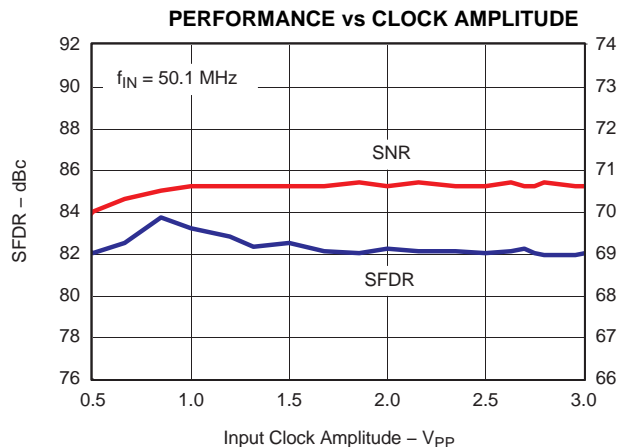


Figure 18.

G015

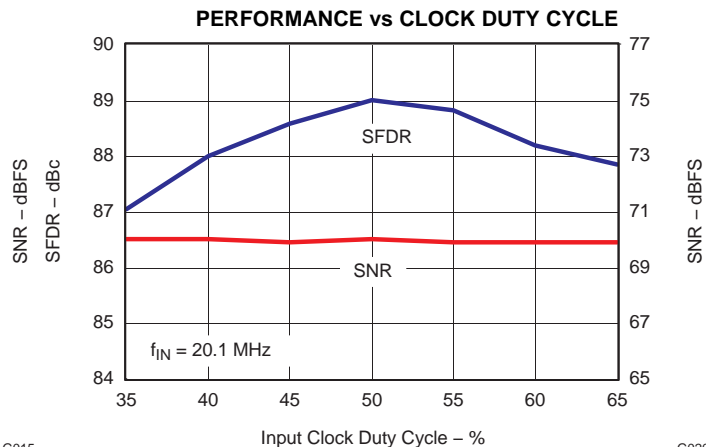


Figure 19.

G020

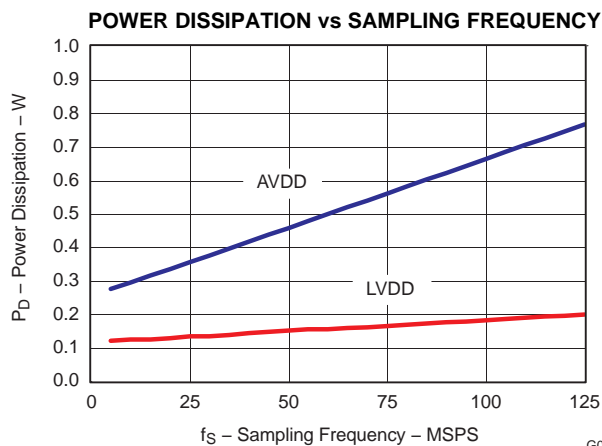


Figure 20.

G015

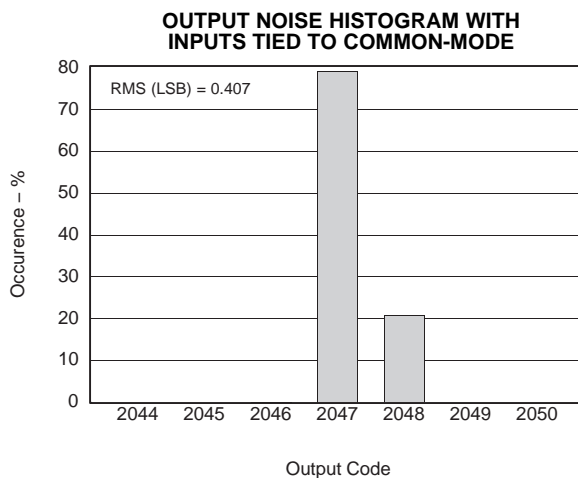


Figure 21.

G017

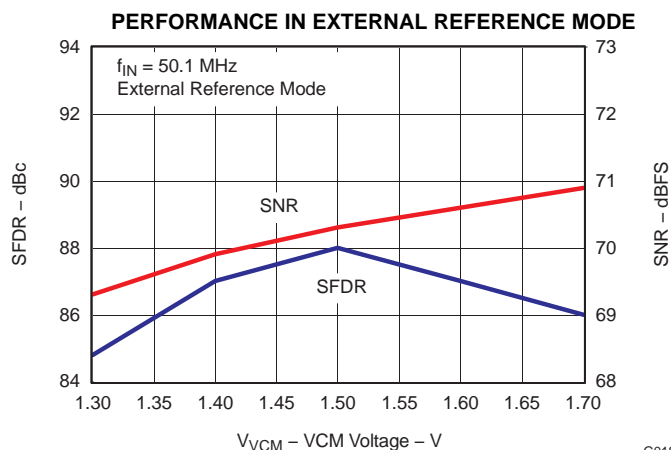


Figure 22.

G018

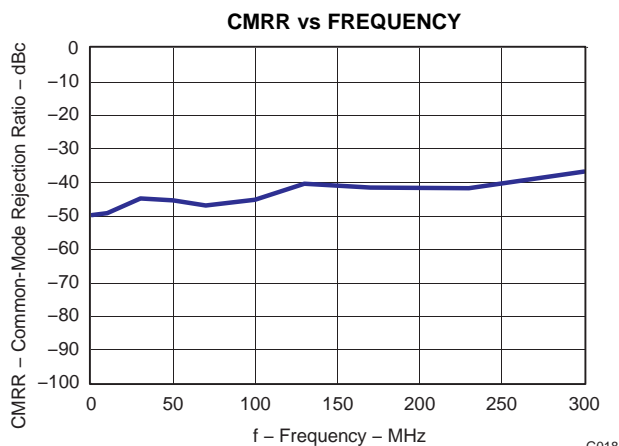


Figure 23.

G018

# ADS6224 ( $F_s = 105 \text{ MSPS}$ )

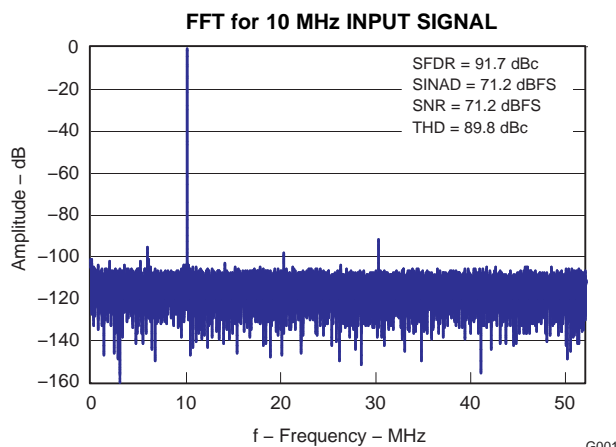


Figure 24.

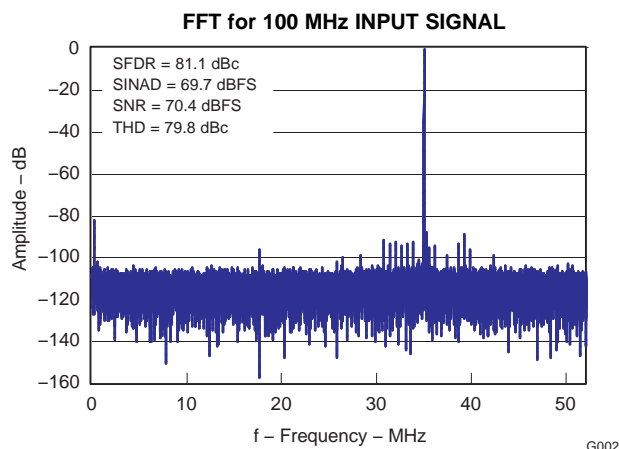


Figure 25.

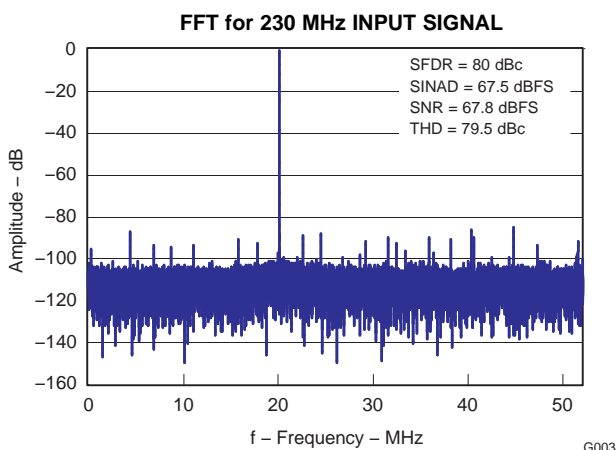


Figure 26.

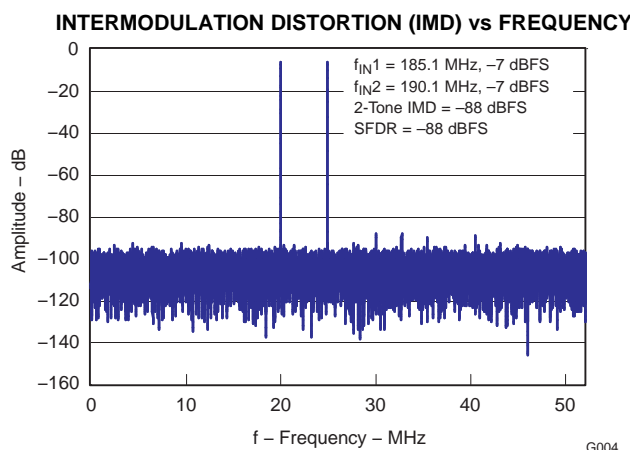


Figure 27.

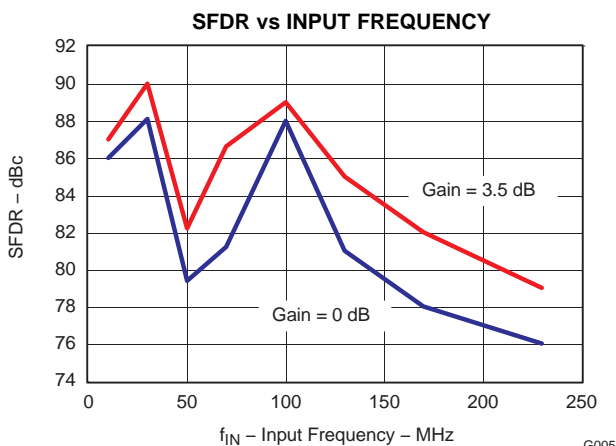


Figure 28.

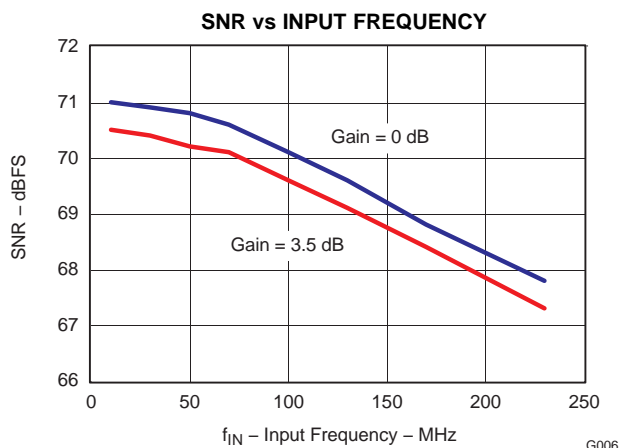


Figure 29.

## ADS6224 ( $F_s = 105$ MSPS) (continued)

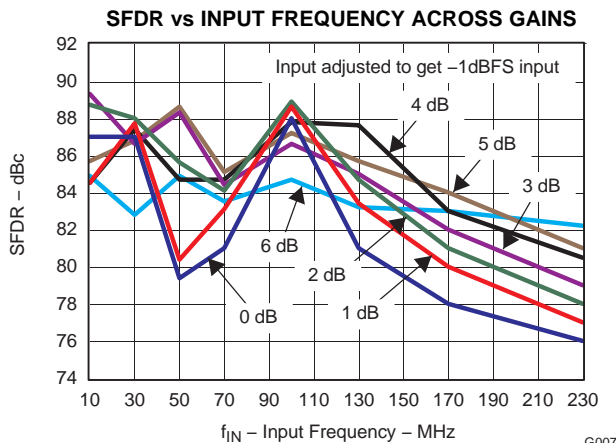


Figure 30.

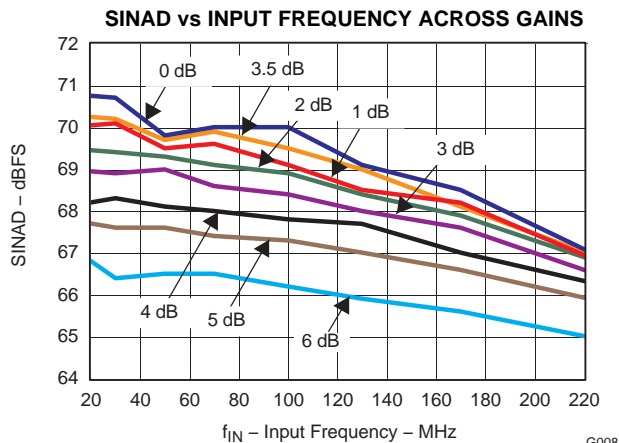


Figure 31.

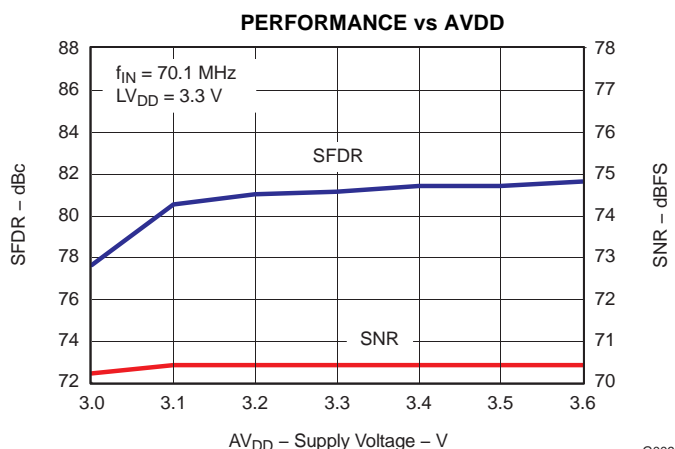


Figure 32.

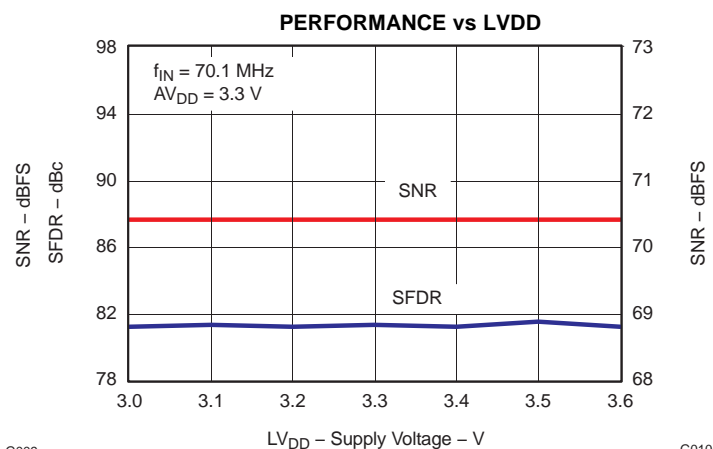


Figure 33.

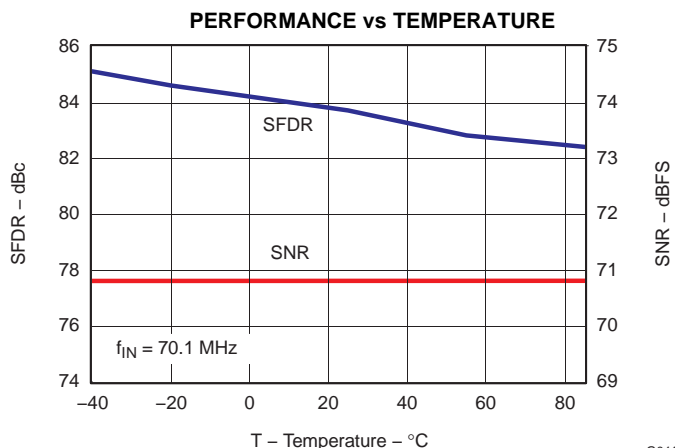


Figure 34.

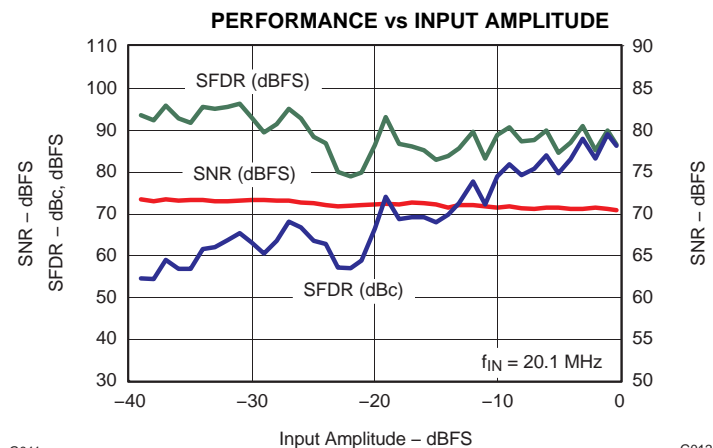


Figure 35.

## ADS6224 ( $F_s = 105$ MSPS) (continued)

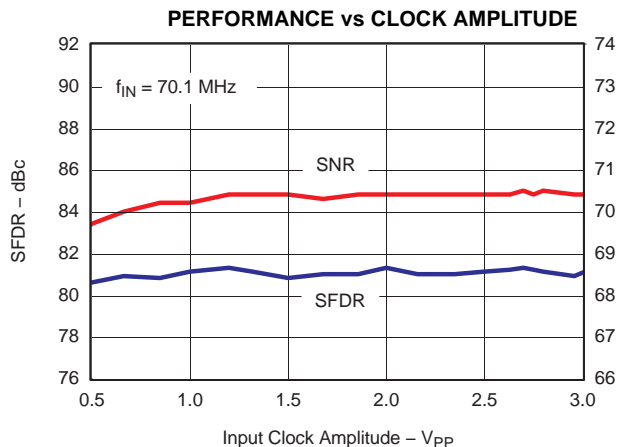


Figure 36.

G013

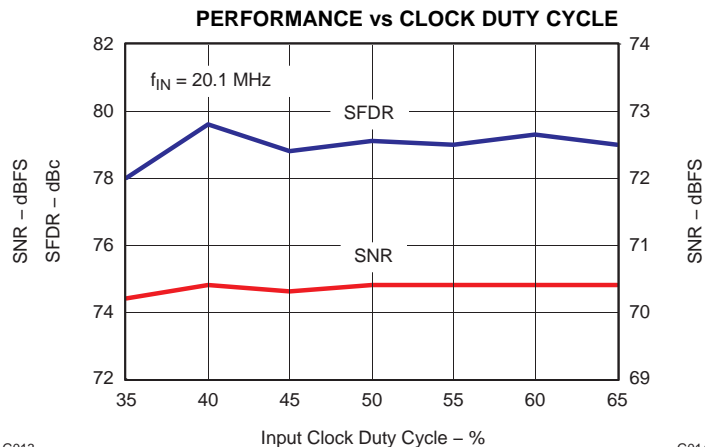


Figure 37.

G014

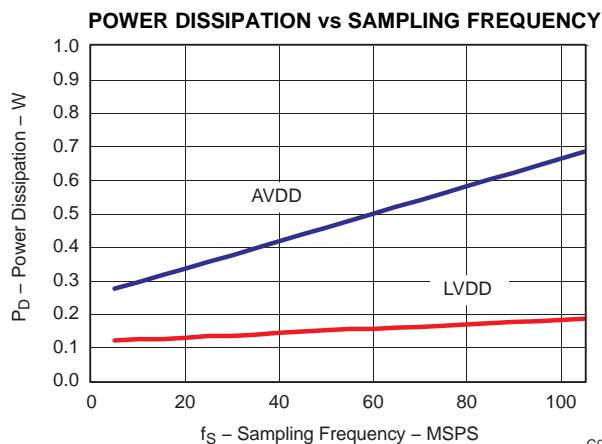


Figure 38.

G033

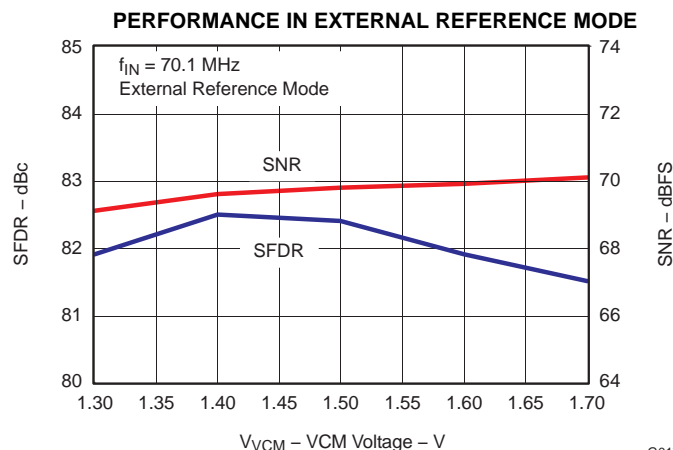


Figure 39.

G017

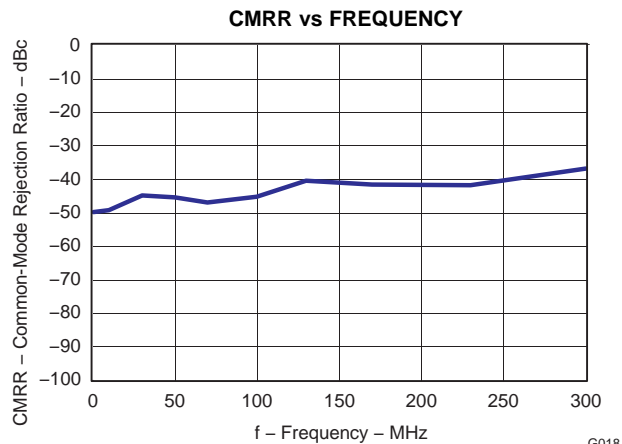


Figure 40.

G018



## ADS6223 ( $F_s = 80$ MSPS)

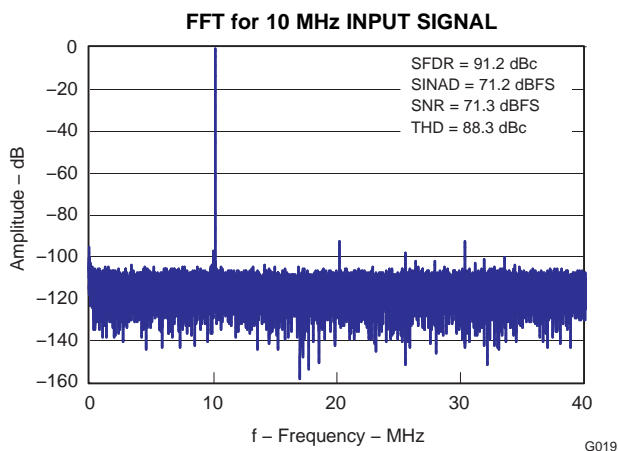


Figure 41.

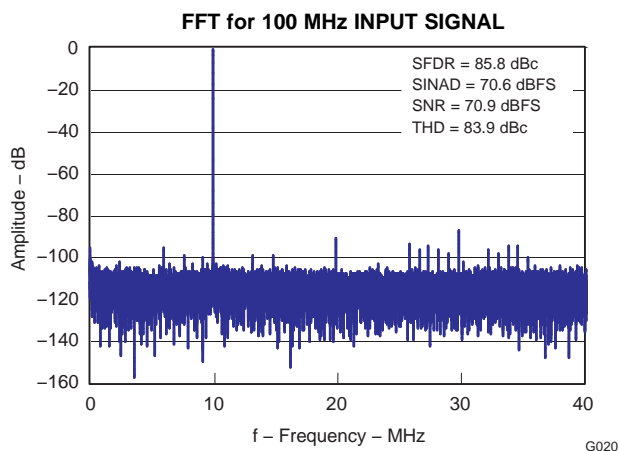


Figure 42.

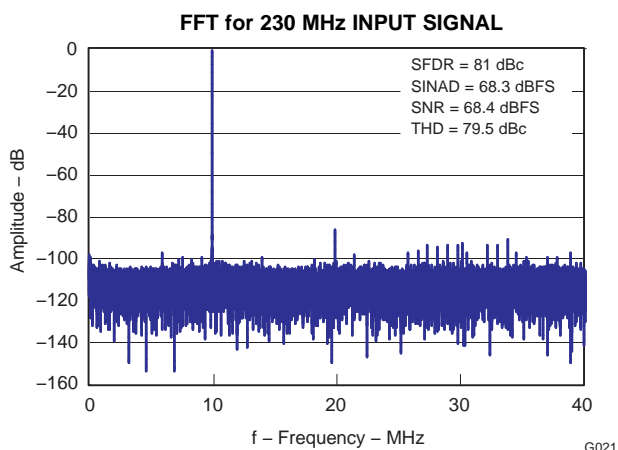


Figure 43.

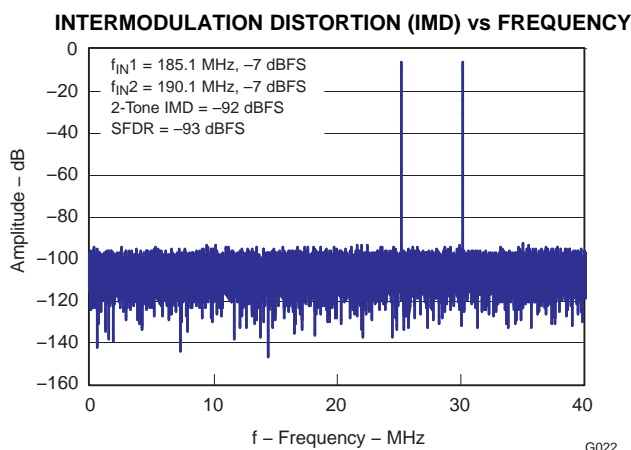


Figure 44.

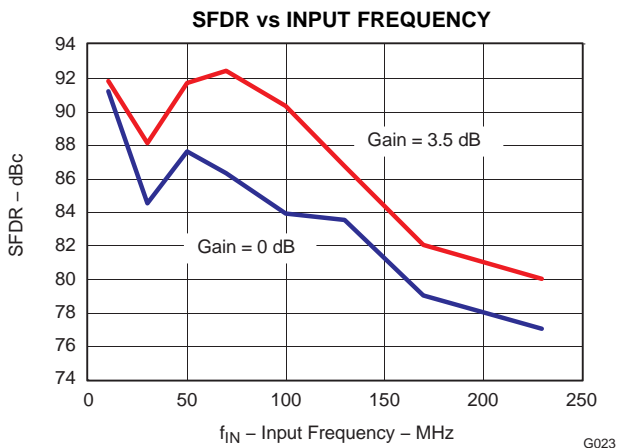


Figure 45.

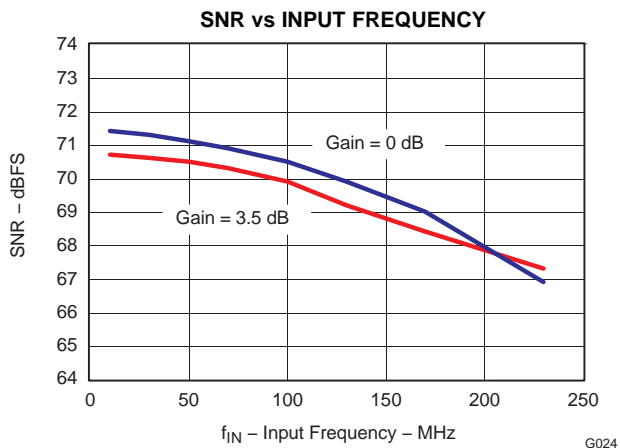


Figure 46.

ADS6223 ( $F_s = 80$  MSPS) (continued)

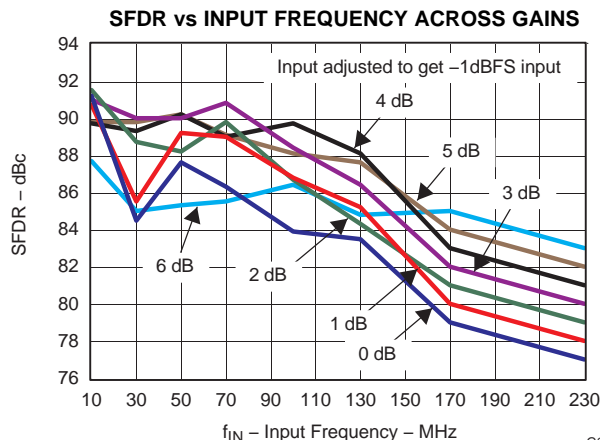


Figure 47.

G025

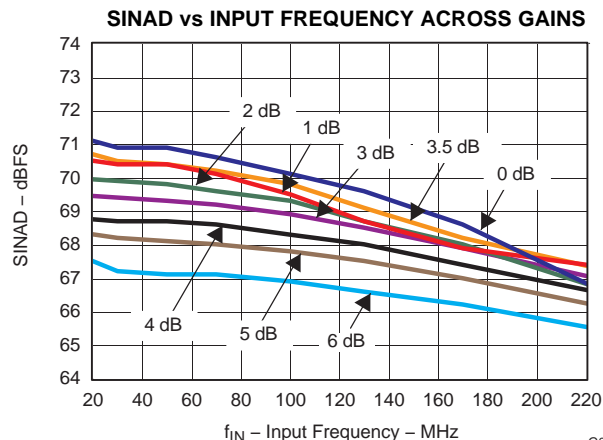


Figure 48.

G026

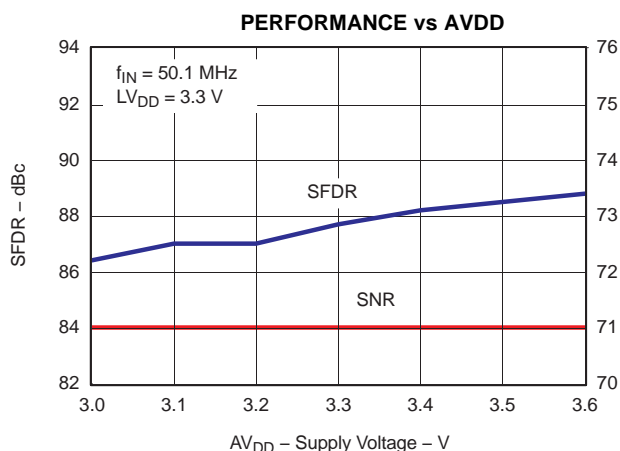


Figure 49.

G027

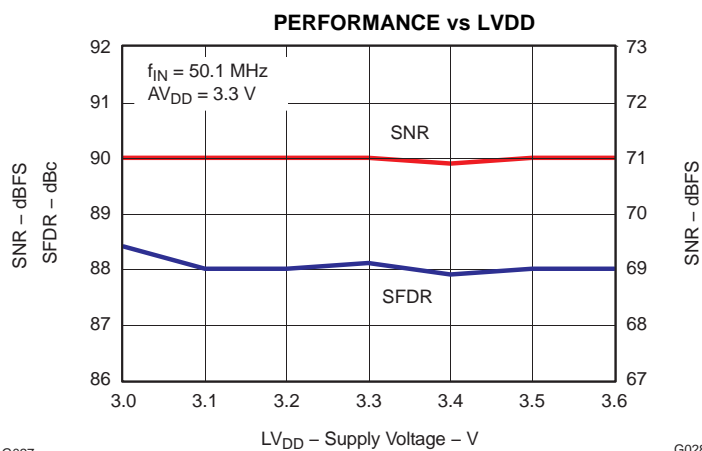


Figure 50.

G028

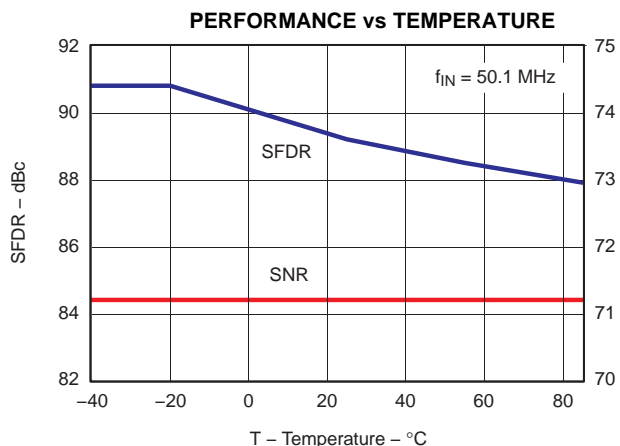


Figure 51.

G029

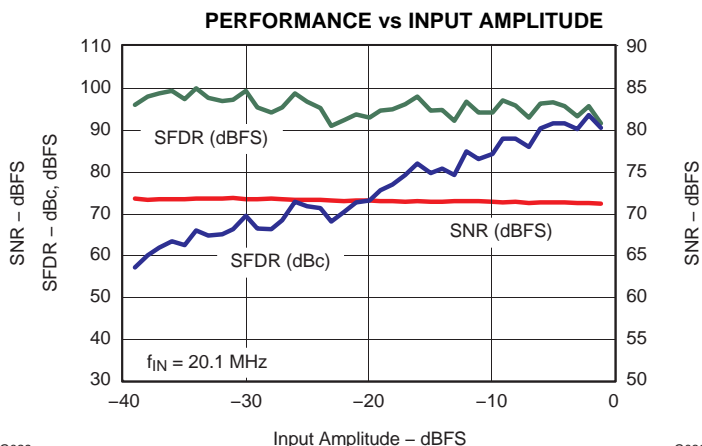


Figure 52.

G030

## ADS6223 ( $F_S = 80$ MSPS) (continued)

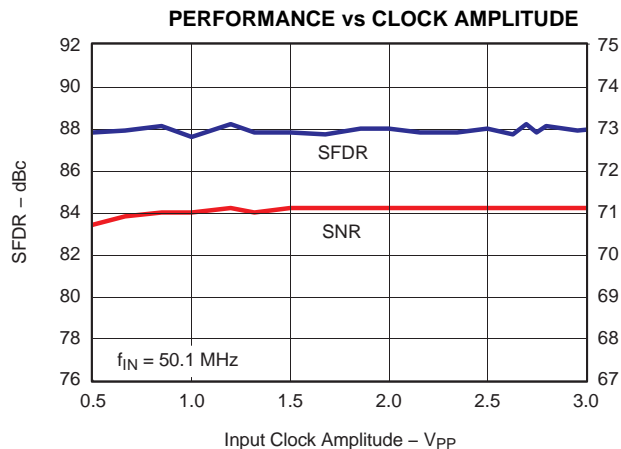


Figure 53.

G031

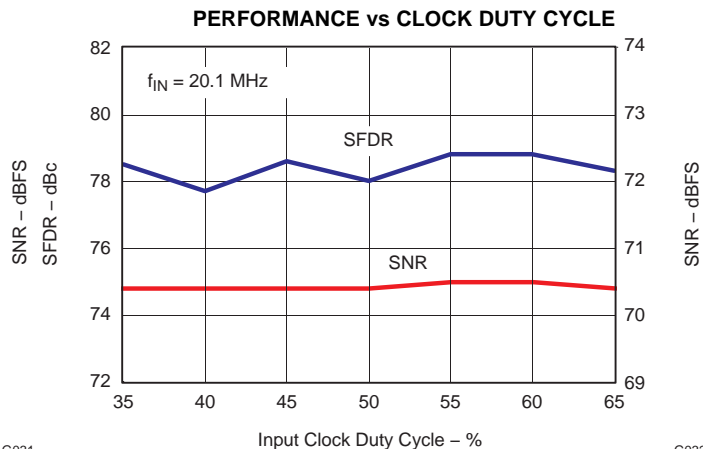


Figure 54.

G032

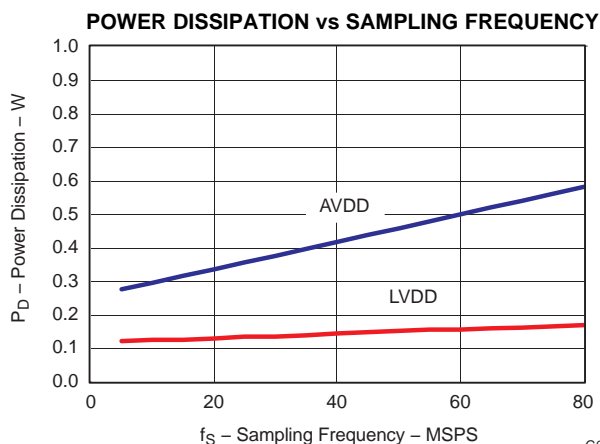


Figure 55.

G051

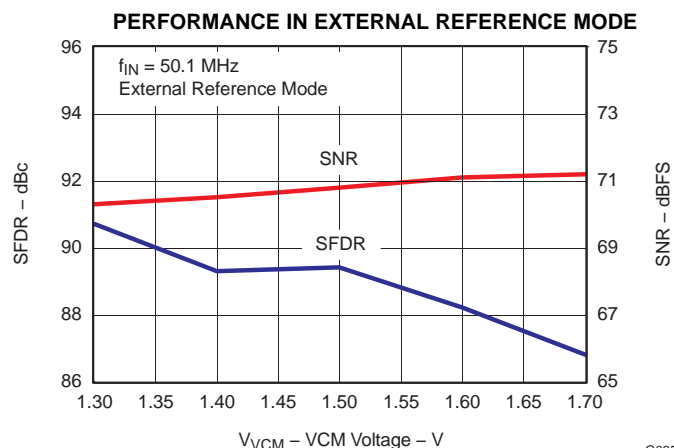


Figure 56.

G035

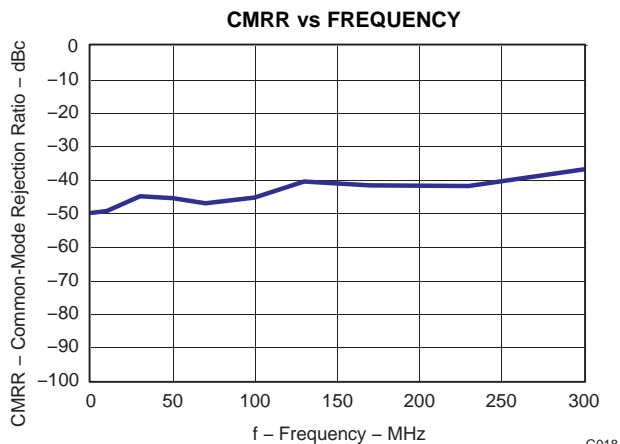


Figure 57.

G018

## ADS6222 ( $F_s = 65$ MSPS)

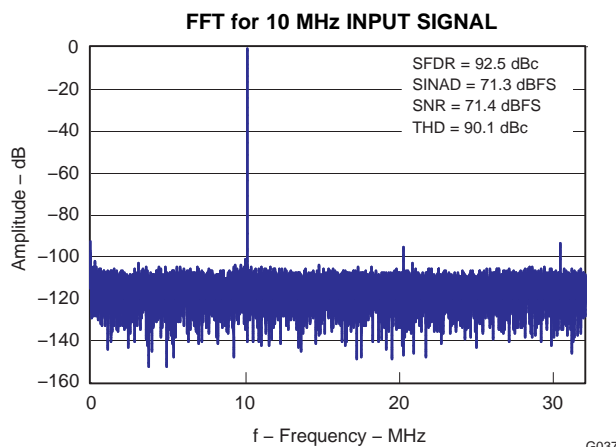


Figure 58.

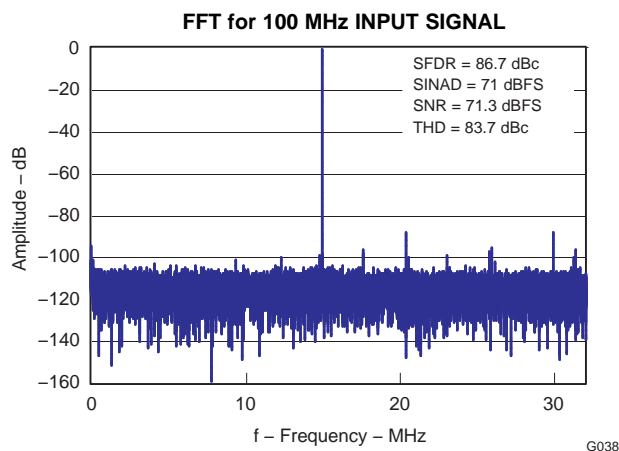


Figure 59.

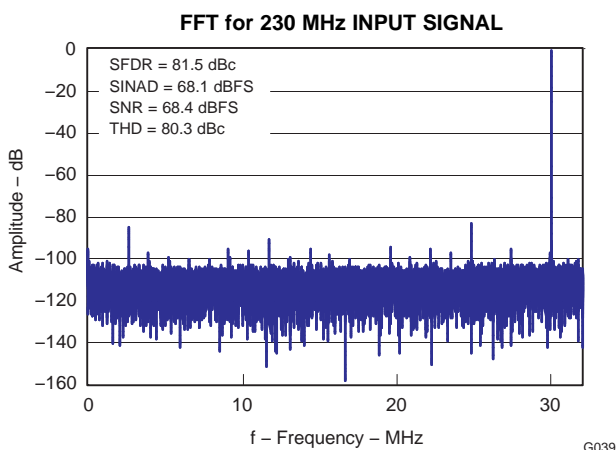


Figure 60.

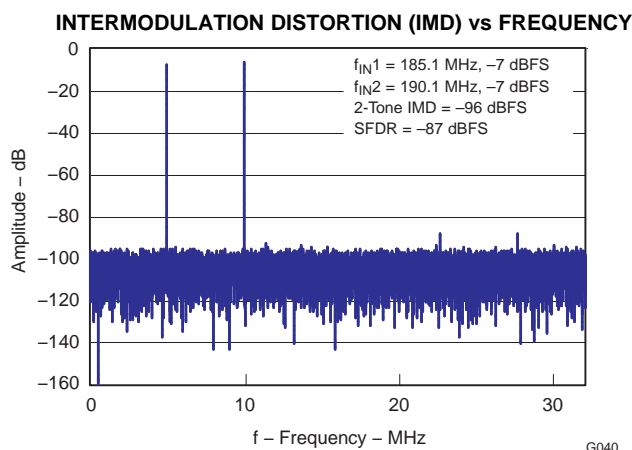


Figure 61.

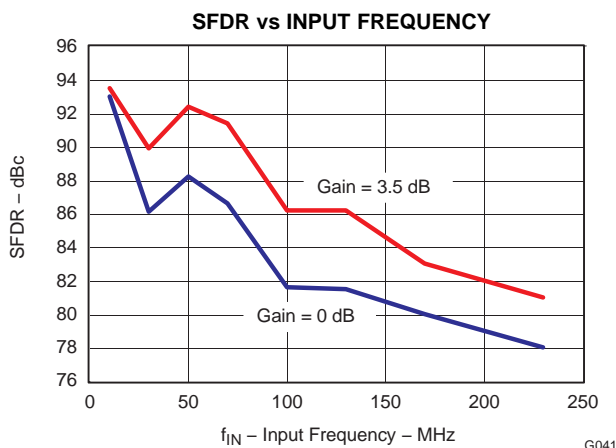


Figure 62.

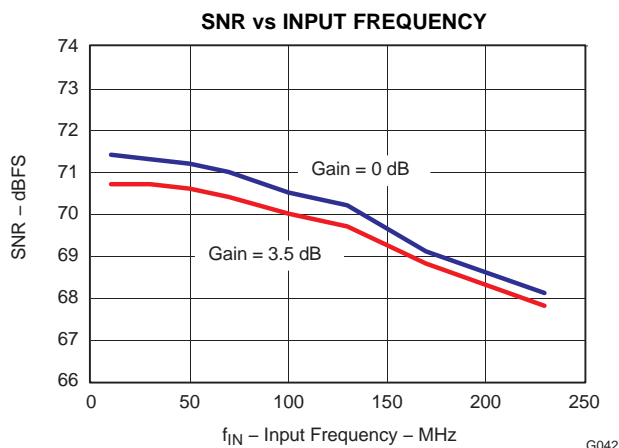


Figure 63.

## ADS6222 ( $F_s = 65$ MSPS) (continued)

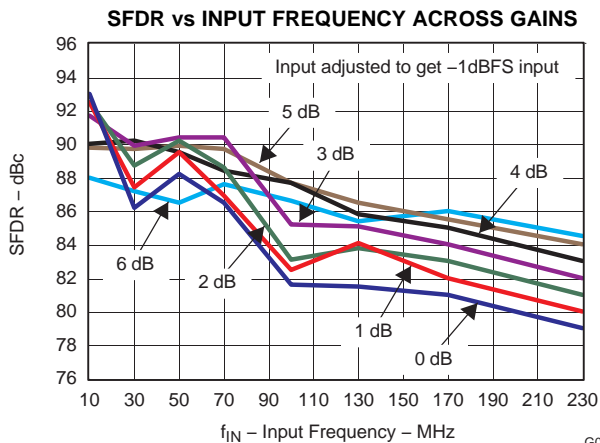


Figure 64.

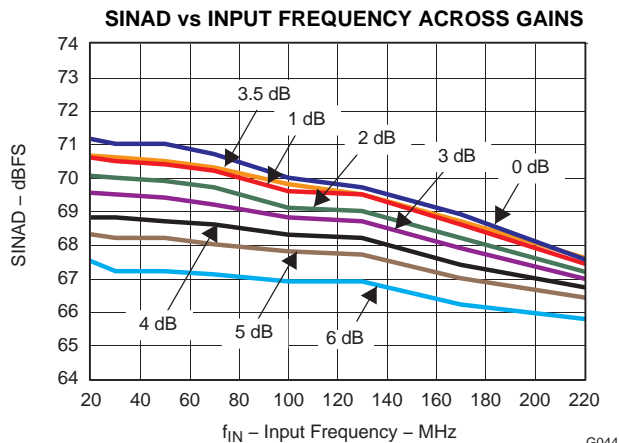


Figure 65.

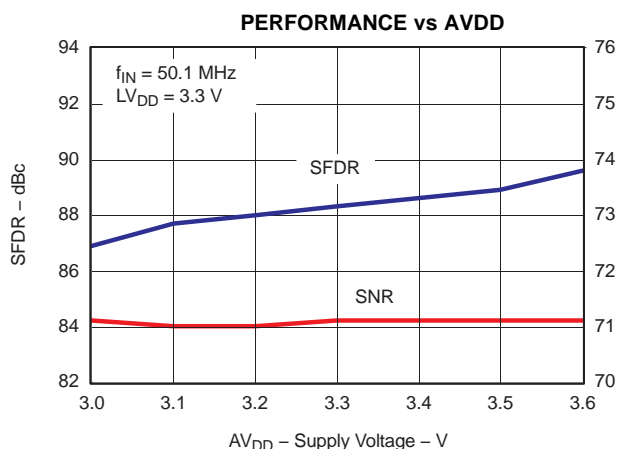


Figure 66.

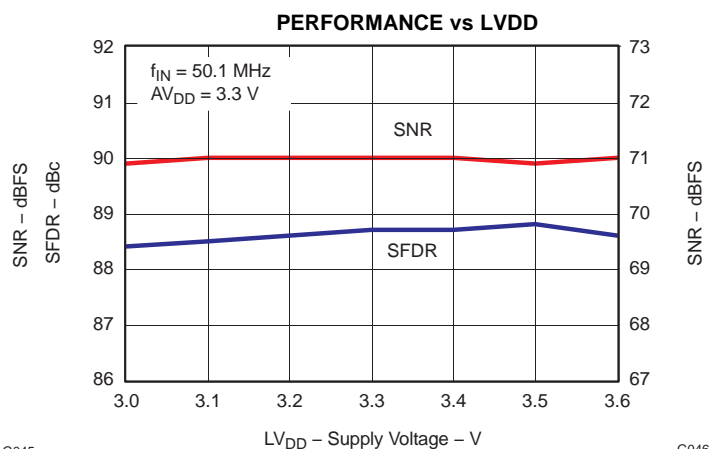


Figure 67.

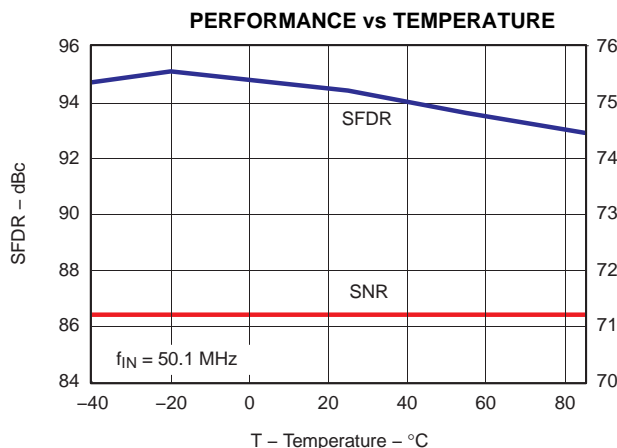


Figure 68.

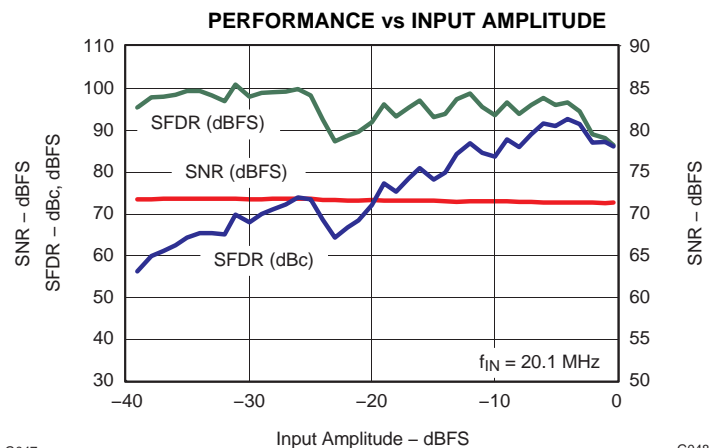


Figure 69.

# ADS6222 ( $F_S = 65$ MSPS) (continued)

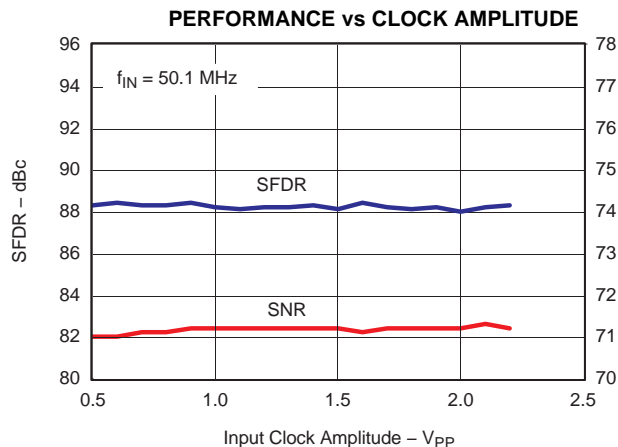


Figure 70.

G049

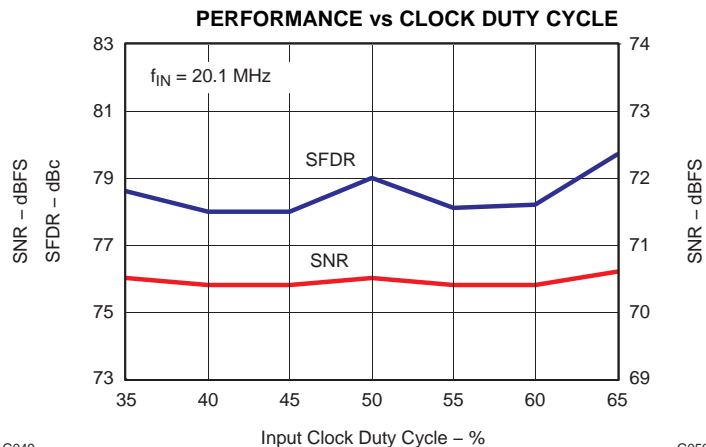


Figure 71.

G050

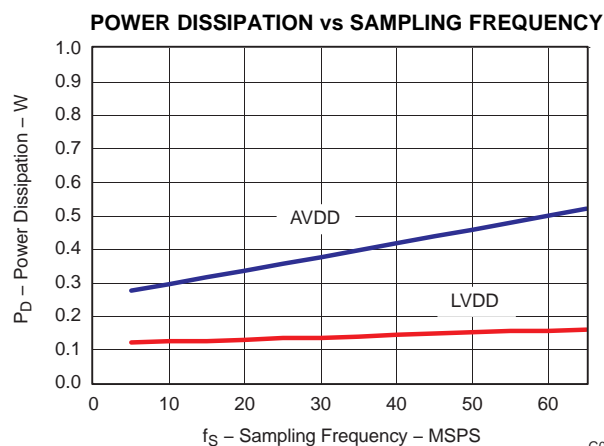


Figure 72.

G069

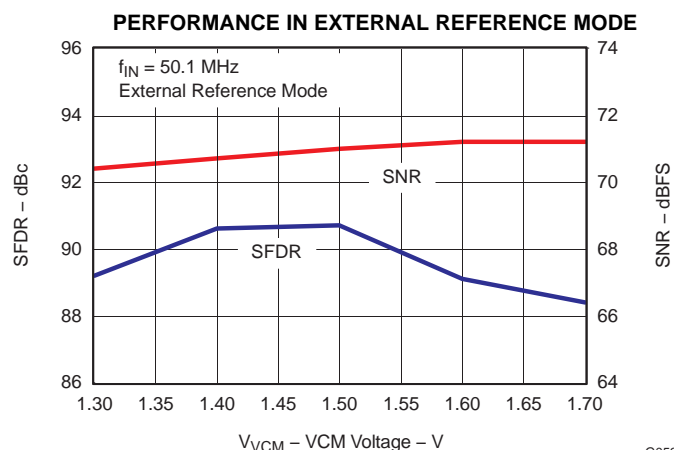


Figure 73.

G053

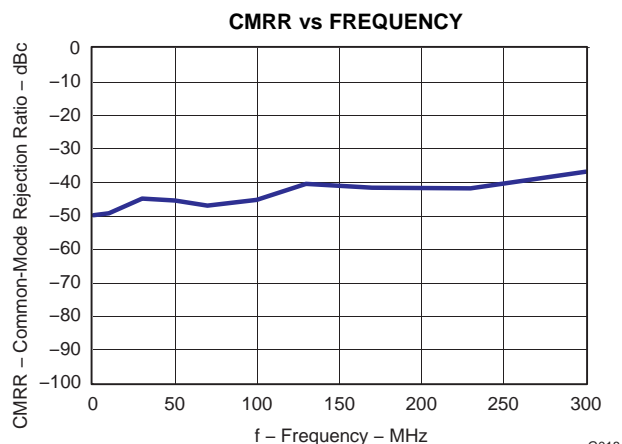
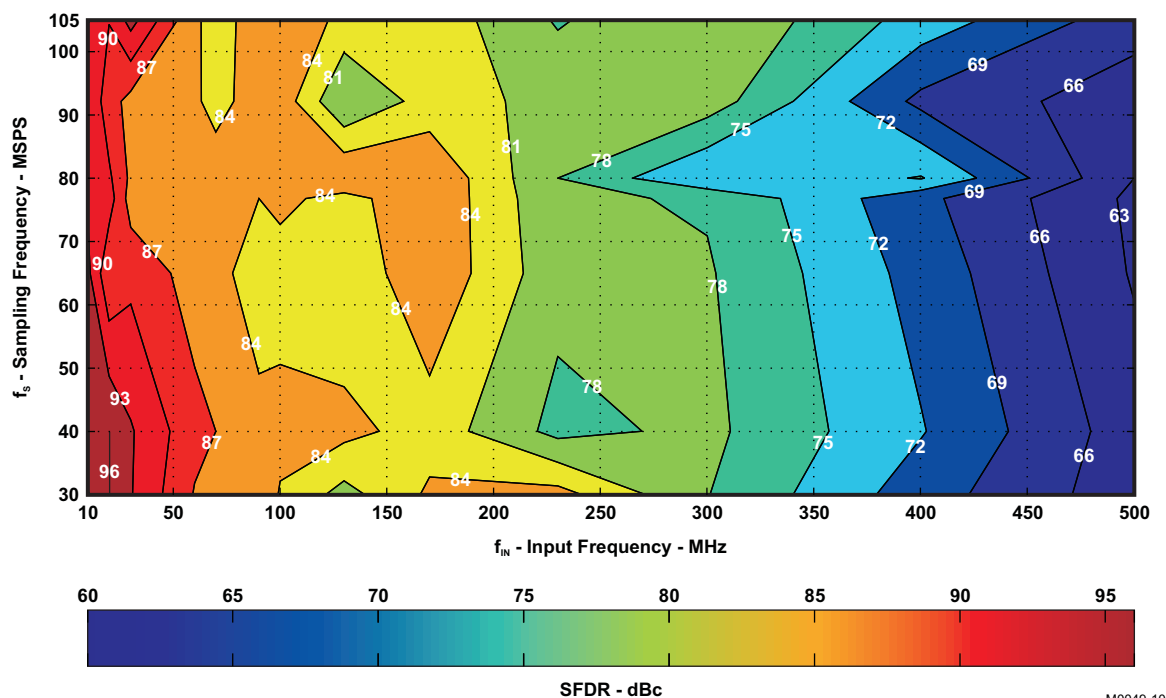


Figure 74.

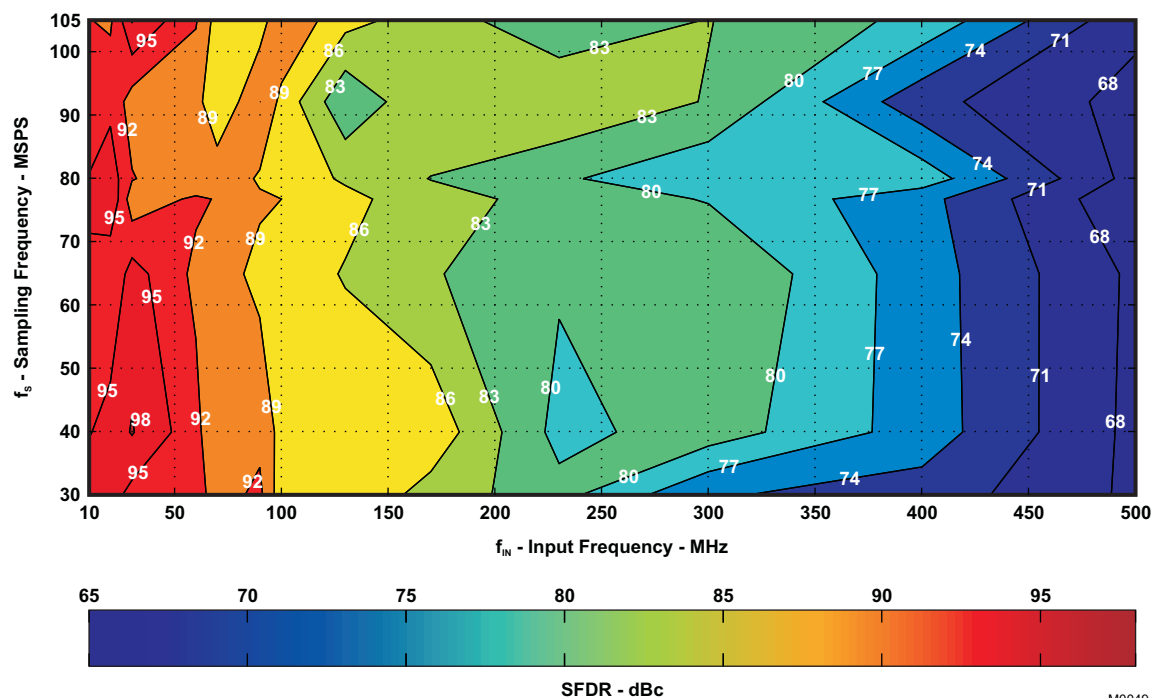
G018

## Contour Plots Across Input and Sampling Frequencies



M0049-10

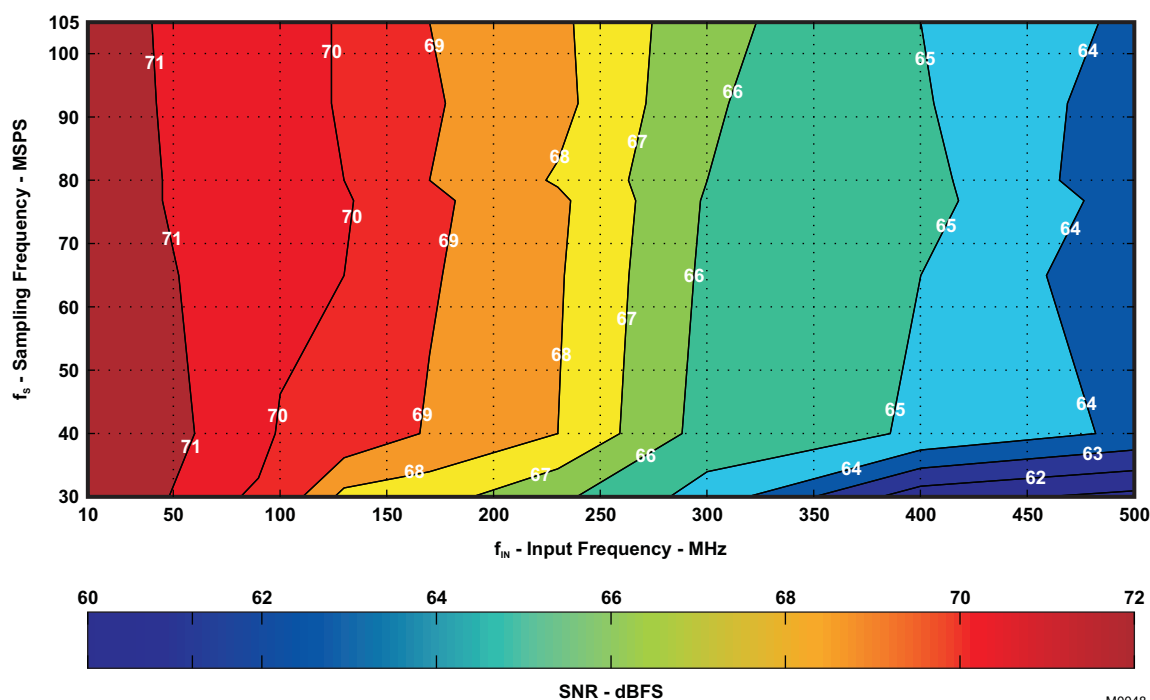
Figure 75. SFDR Contour (no gain)



M0049-11

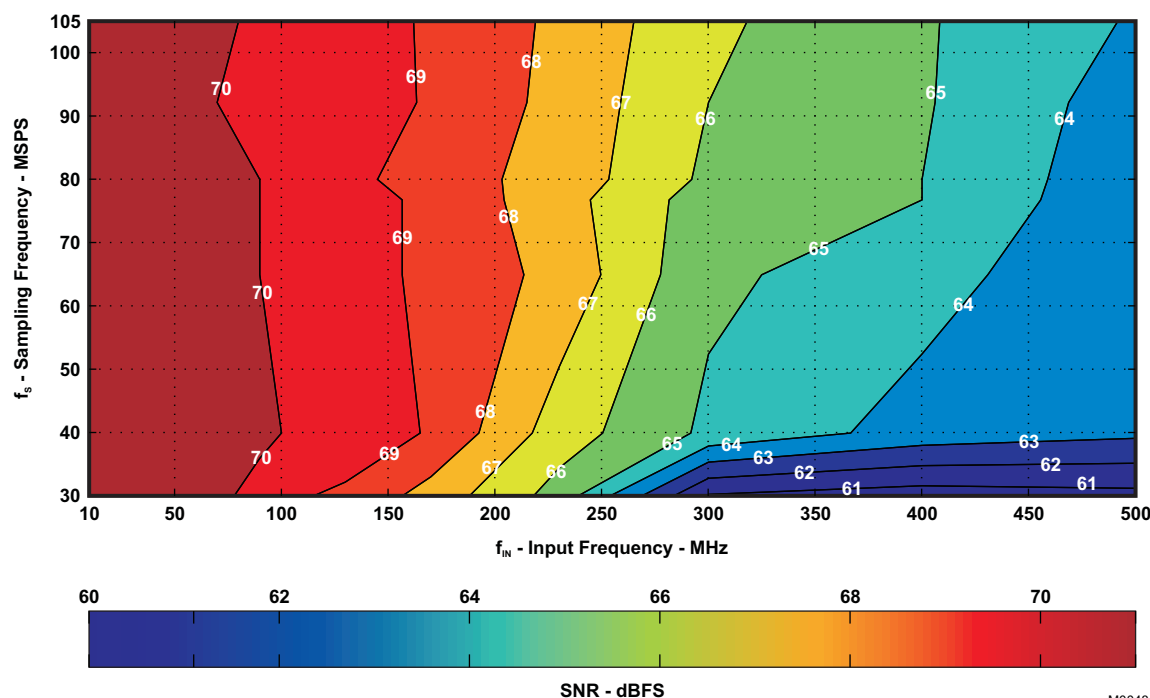
Figure 76. SFDR Contour (3.5 dB coarse gain)

### Contour Plots Across Input and Sampling Frequencies (continued)



M0048-10

Figure 77. SNR Contour (no gain)



M0048-11

Figure 78. SNR Contour (3.5 dB coarse gain)



## APPLICATION INFORMATION

### THEORY OF OPERATION

ADS6225/ADS6224/ADS6223/ADS6222 (ADS622X) is a family of dual channel, 12-bit pipeline ADCs based on switched capacitor architecture in CMOS technology.

The conversion is initiated simultaneously by all the four channels at the rising edge of the external input clock. After the input signals are captured by the sample and hold circuit of each channel, the samples are sequentially converted by a series of low resolution stages. The stage outputs are combined in a digital correction logic block to form the final 12-bit word with a latency of 12 clock cycles. The 12-bit word of each channel is serialized and output as LVDS levels. In addition to the data streams, a bit clock and frame clock are also output. The frame clock is aligned with the 12-bit word boundary.

### ANALOG INPUT

The analog input consists of a switched-capacitor based differential sample and hold architecture, shown in Figure 79. This differential topology results in very good AC performance even for high input frequencies. The INP and INM pins have to be externally biased around a common-mode voltage of 1.5 V, available on VCM pin 13. For a full-scale differential input, each input pin INP, INM has to swing symmetrically between  $V_{CM} + 0.5\text{ V}$  and  $V_{CM} - 0.5\text{ V}$ , resulting in a  $2\text{-}V_{pp}$  differential input swing. The maximum swing is determined by the internal reference voltages REFP (2.0V nominal) and REFM (1.0 V, nominal). The sampling circuit has a 3 dB bandwidth that extends up to 500 MHz (Figure 80, shown by the transfer function from the analog input pins to the voltage across the sampling capacitors).

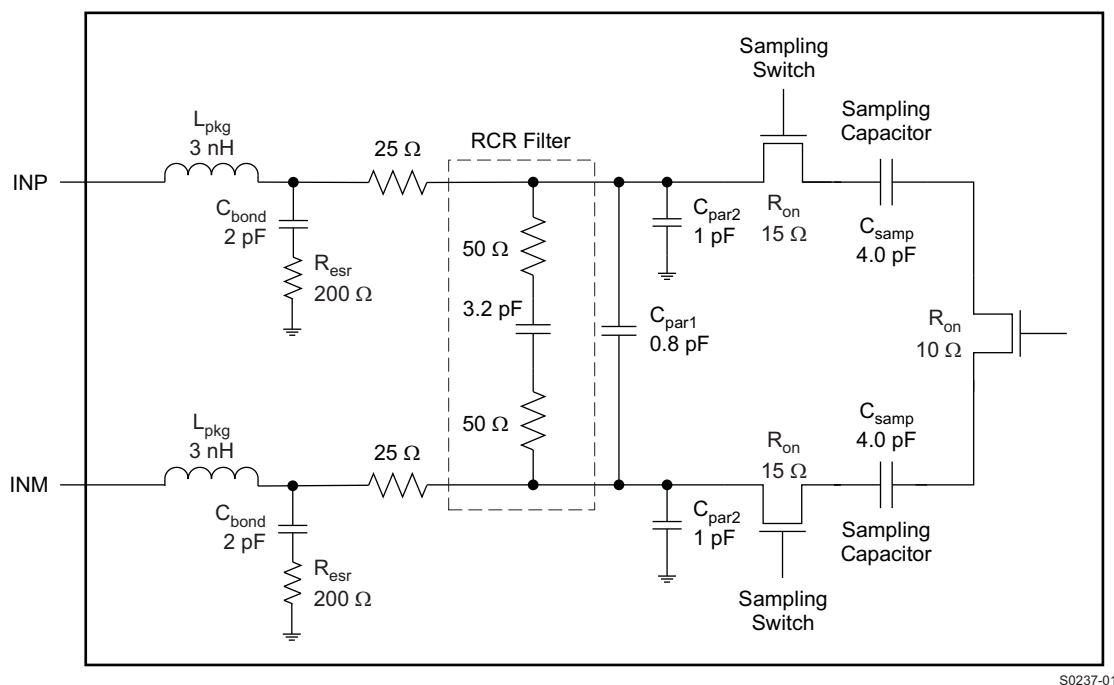
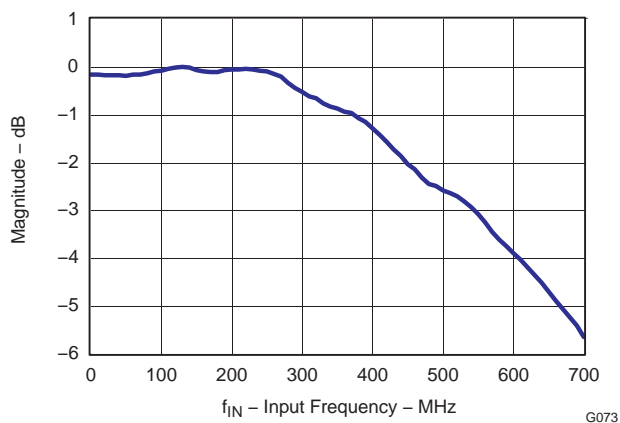


Figure 79. Input Sampling Circuit



**Figure 80. Analog Input Bandwidth**

### Drive Circuit Requirements

For optimum performance, the analog inputs must be driven differentially. This improves the common-mode noise immunity and even order harmonic rejection.

A 5- $\Omega$  resistor in series with each input pin is recommended to damp out ringing caused by the package parasitics. It is also necessary to present low impedance ( $< 50 \Omega$ ) for the common mode switching currents. For example, this is achieved by using two resistors from each input terminated to the common mode voltage (VCM).

In addition to the above, the drive circuit may have to be designed to provide a low insertion loss over the desired frequency range and matched impedance to the source. While doing this, the ADC input impedance has to be taken into account. [Figure 81](#) shows that the impedance ( $Z_{in}$ , looking into the ADC input pins) decreases at high input frequencies. The smith chart shows that the input impedance is capacitive and can be approximated by a series R-C up to 500 MHz.

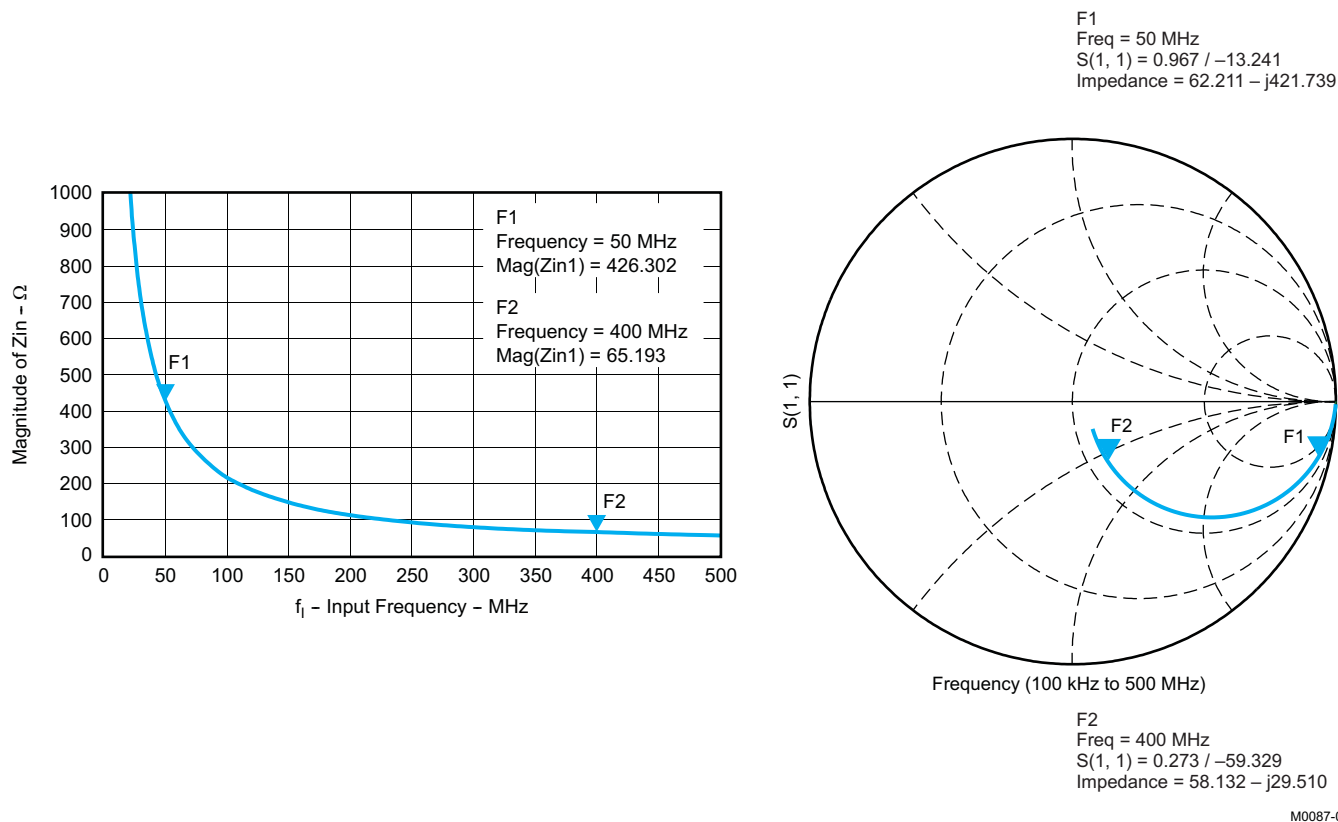


Figure 81. ADC Input Impedance, Zin

### Using RF-Transformer Based Drive Circuits

For optimum performance, the analog inputs must be driven differentially. This improves the common-mode noise immunity and even order harmonic rejection. An example of input drive using RF transformers is shown in Figure 83.

The single-ended signal is fed to the primary winding of the RF transformer. The transformer is terminated on the secondary side. Putting the termination on the secondary side helps to shield the kickbacks caused by the sampling circuit from the RF transformer's leakage inductances. The termination is accomplished by two resistors connected in series, with the center point connected to the 1.5 V common mode (VCM pin). The value of the termination resistors (connected to common mode) has to be low ( $< 100 \Omega$ ) to provide a low-impedance path for the ADC common-mode switching current.

Figure 82 shows a configuration using a single 1:1 turns ratio transformer (for example, WBC1-1) that can be used for low input frequencies up to 100 MHz.

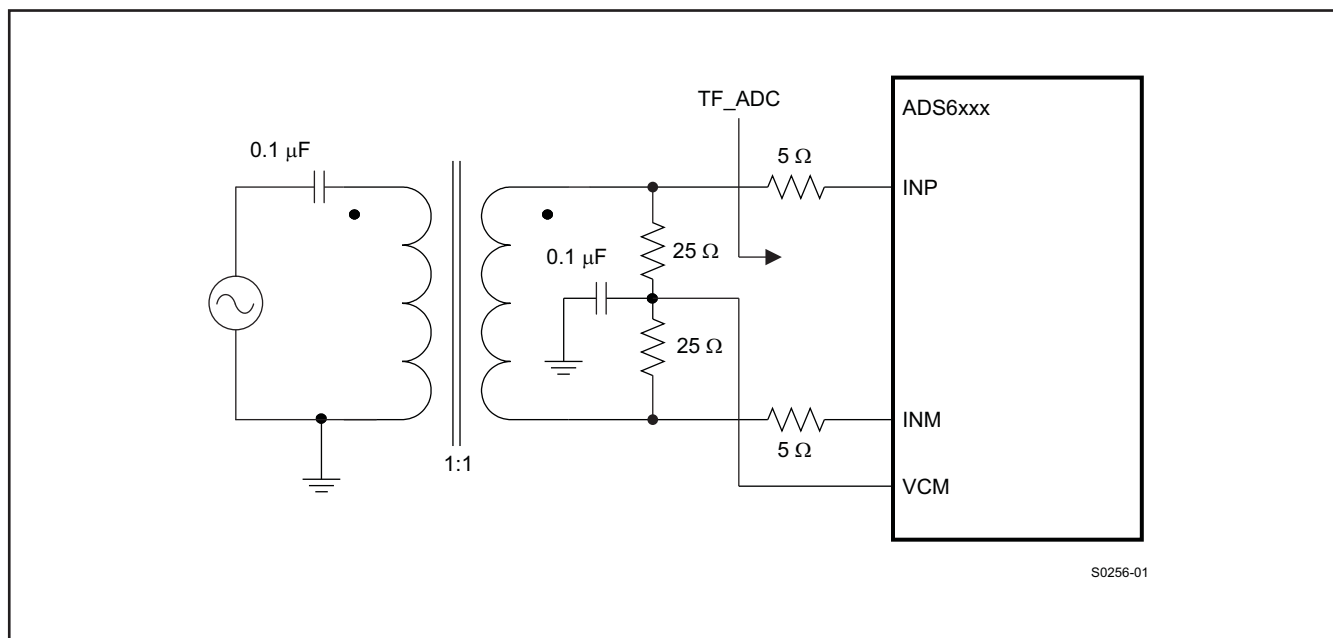


Figure 82. Single Transformer Drive Circuit

At high input frequencies, the mismatch in the transformer parasitic capacitance (between the windings) results in degraded even-order harmonic performance. Connecting two identical RF transformers back-to-back helps minimize this mismatch, and good performance is obtained for high frequency input signals. Figure 83 shows an example using two transformers (Coilcraft WBC1-1). An additional termination resistor pair (enclosed within the shaded box in Figure 83) may be required between the two transformers to improve the balance between the P and M sides. The center point of this termination must be connected to ground.

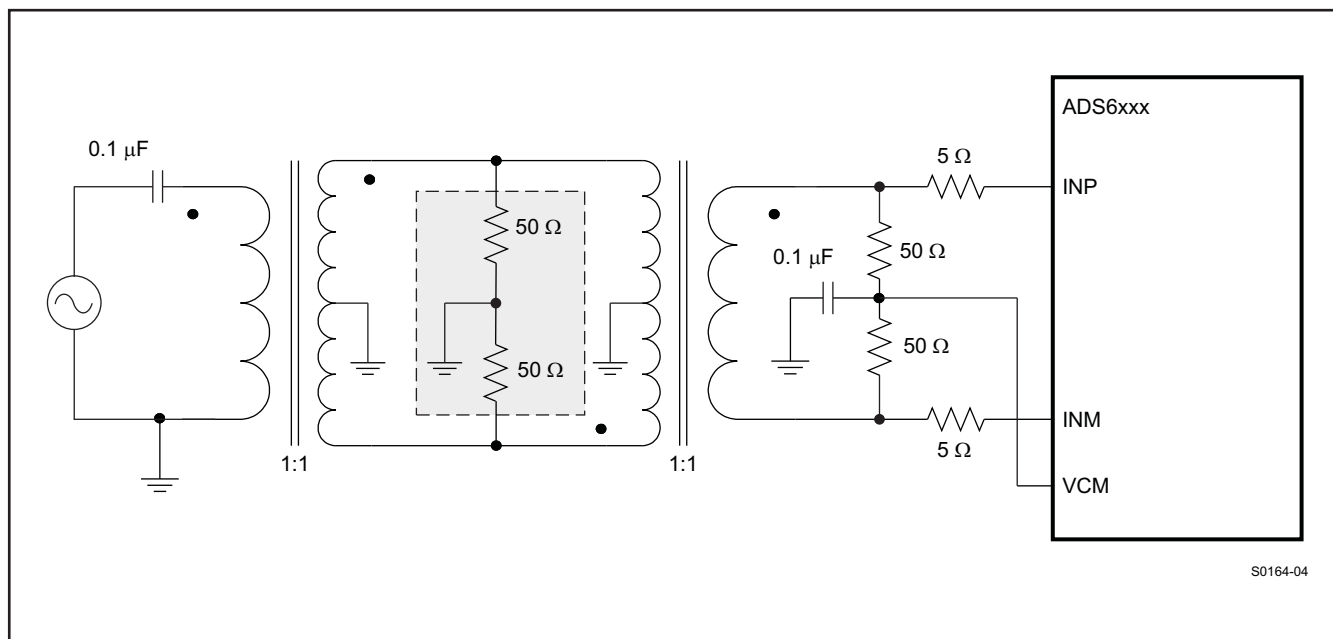


Figure 83. Two Transformer Drive Circuit

## Using Differential Amplifier Drive Circuits

Figure 84 shows a drive circuit using a differential amplifier (TI's THS4509) to convert a single-ended input to differential output that can be interfaced to the ADC input pins. In addition to the single-ended to differential conversion, the amplifier also provides gain (10 dB in Figure 84). As shown in the figure,  $R_{FIL}$  helps to isolate the amplifier output from the switching inputs of the ADC. Together with  $C_{FIL}$ , it also forms a low-pass filter that bandlimits the noise (and signal) at the ADC input. As the amplifier outputs are ac-coupled, the common-mode of the ADC input pins is set using two resistors connected to VCM. The amplifier outputs can also be dc-coupled. Using the output common-mode control of the THS4509, the ADC input pins can be biased to 1.5 V.

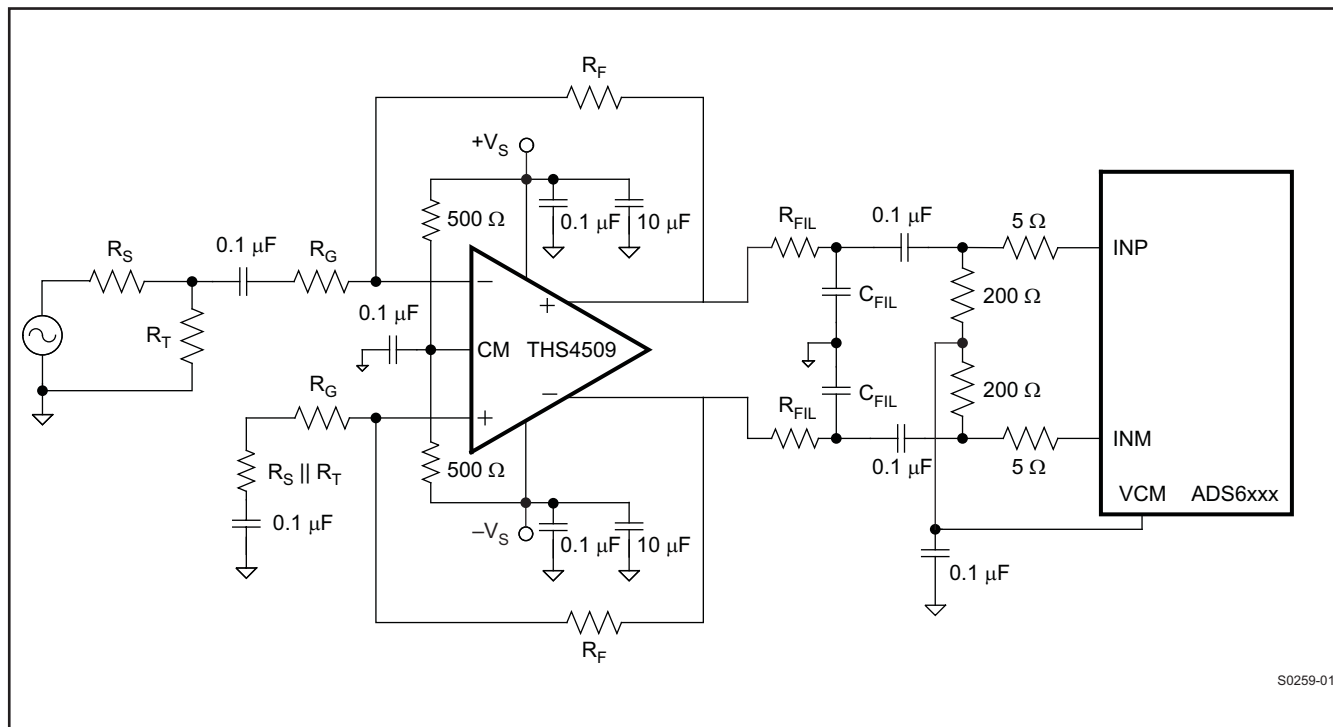


Figure 84. Drive Circuit using THS4509

Refer to the EVM User Guide (SLAU196) for more information.

## INPUT COMMON MODE

To ensure a low-noise common-mode reference, the VCM pin is filtered with a 0.1-μF low-inductance capacitor connected to ground. The VCM pin is designed to directly drive the ADC inputs. The input stage of the ADC sinks a common-mode current in the order of 155 μA at 125 MSPS (per input pin). Equation 1 describes the dependency of the common-mode current and the sampling frequency.

$$\frac{155 \mu A x F_s}{125 \text{ MSPS}} \quad (1)$$

This equation helps to design the output capability and impedance of the CM driving circuit accordingly.

## REFERENCE

The ADS622X has built-in internal references REFP and REFM, requiring no external components. Design schemes are used to linearize the converter load seen by the references; this and the on-chip integration of the requisite reference capacitors eliminates the need for external decoupling. The full-scale input range of the converter can be controlled in the external reference mode as explained below. The internal or external reference modes can be selected by programming the register bit <REF> (Table 14).

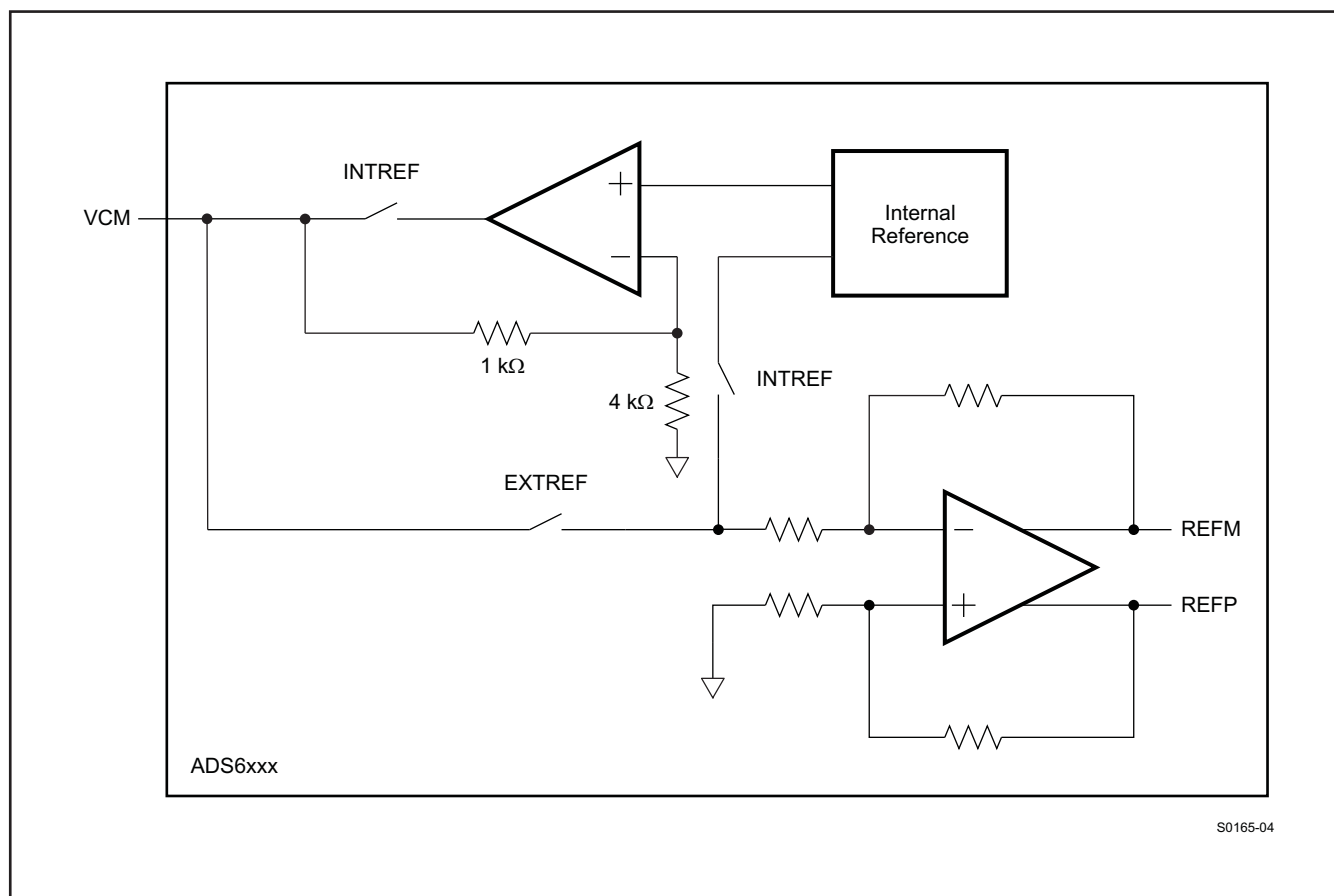


Figure 85. Reference Section

### Internal Reference

When the device is in internal reference mode, the REFP and REFM voltages are generated internally. Common-mode voltage (1.5 V nominal) is output on VCM pin, which can be used to externally bias the analog input pins.

### External Reference

When the device is in external reference mode, the VCM acts as a reference input pin. The voltage forced on the VCM pin is buffered and gained by 1.33 internally, generating the REFP and REFM voltages. The differential input voltage corresponding to full-scale is given by [Equation 2](#).

$$\text{Full-scale differential input pp} = (\text{Voltage forced on VCM}) \times 1.33 \quad (2)$$

In this mode, the range of voltage applied on VCM should be 1.45 V to 1.55 V. The 1.5-V common-mode voltage to bias the input pins has to be generated externally.

## COARSE GAIN AND PROGRAMMABLE FINE GAIN

ADS622X includes gain settings that can be used to get improved SFDR performance (compared to 0 dB gain mode). The gain settings are 3.5 dB coarse gain and programmable fine gain from 0 dB to 6 dB. For each gain setting, the analog input full-scale range scales proportionally, as shown in [Table 22](#).

The coarse gain is a fixed setting of 3.5 dB and is designed to improve SFDR with little degradation in SNR. The fine gain is programmable in 1 dB steps from 0 to 6 dB. With fine gain also, SFDR improvement is achieved, but at the expense of SNR (there is about 1 dB SNR degradation for every 1 dB of fine gain).

So, the fine gain can be used to trade-off between SFDR and SNR. The coarse gain makes it possible to get best SFDR but without losing SNR significantly. At high input frequencies, the gains are especially useful as the SFDR improvement is significant with marginal degradation in SINAD.

The gains can be programmed using the register bits **<COARSE GAIN>** (Table 19) and **<FINE GAIN>** (Table 18). Note that the default gain after reset is 0 dB.

**Table 22. Full-Scale Range Across Gains**

| GAIN, dB | TYPE                        | FULL-SCALE, $V_{pp}$ |
|----------|-----------------------------|----------------------|
| 0        | Default (after reset)       | 2                    |
| 3.5      | Coarse setting (fixed)      | 1.34                 |
| 1        | Fine setting (programmable) | 1.78                 |
| 2        |                             | 1.59                 |
| 3        |                             | 1.42                 |
| 4        |                             | 1.26                 |
| 5        |                             | 1.12                 |
| 6        |                             | 1.00                 |

## CLOCK INPUT

The ADS622X clock inputs can be driven differentially (SINE, LVPECL or LVDS) or single-ended (LVCMOS), with little or no difference in performance between them. The common-mode voltage of the clock inputs is set to VCM using internal 5-k $\Omega$  resistors as shown in Figure 86. This allows using transformer-coupled drive circuits for sine wave clock or ac-coupling for LVPECL, LVDS clock sources (see Figure 88 and Figure 90). Figure 87 shows the impedance looking into the clock input pins.

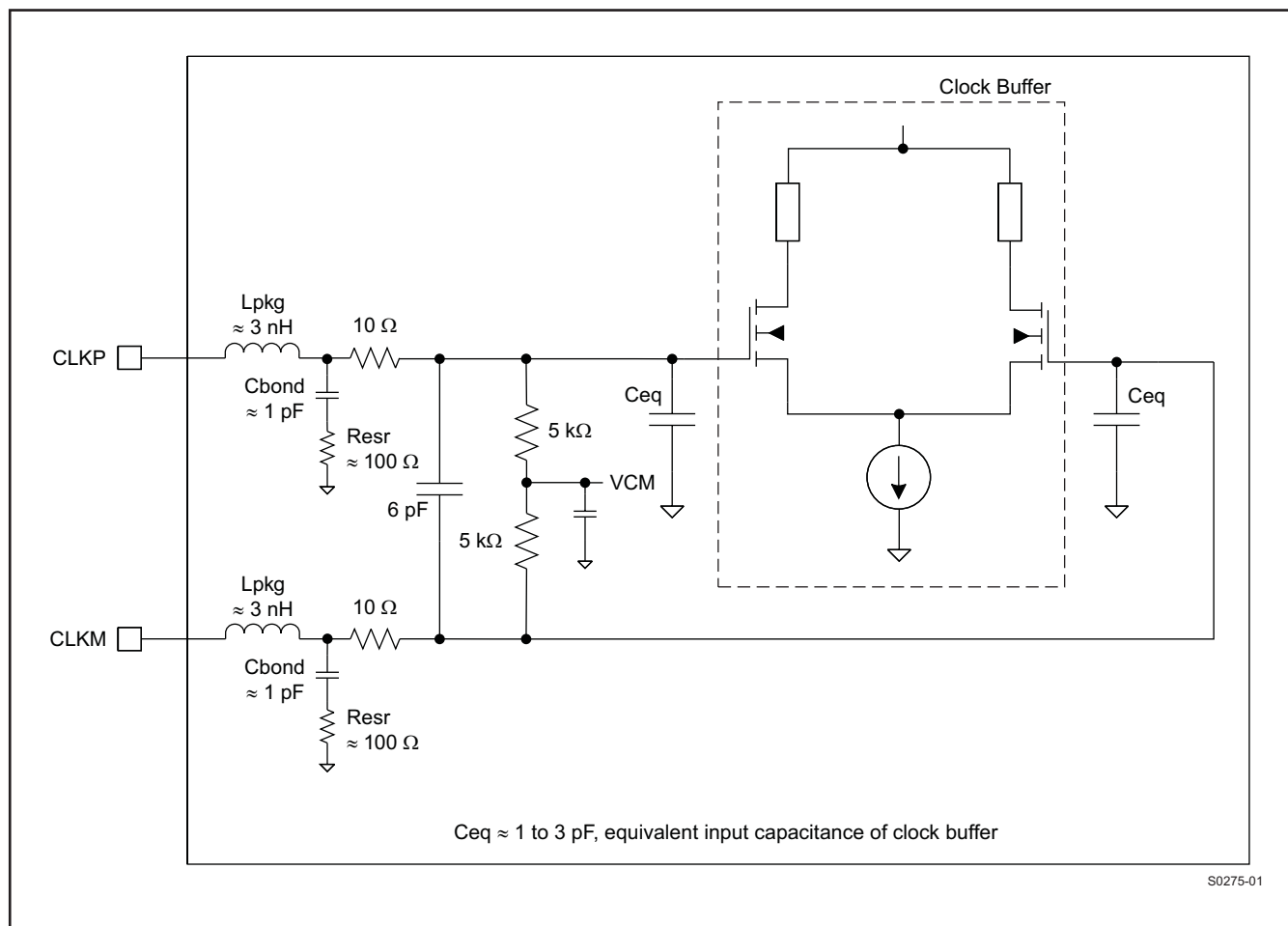


Figure 86. Internal Clock Buffer

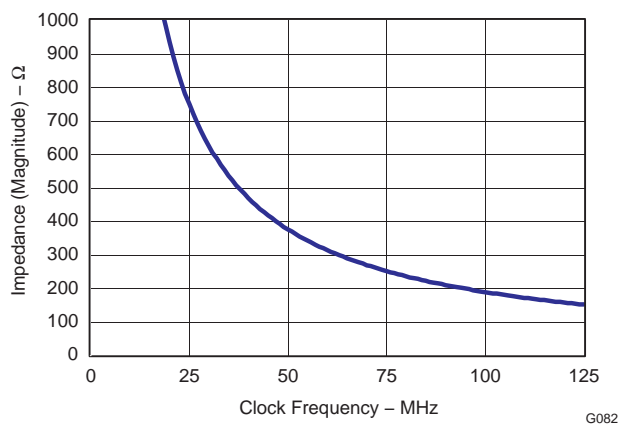
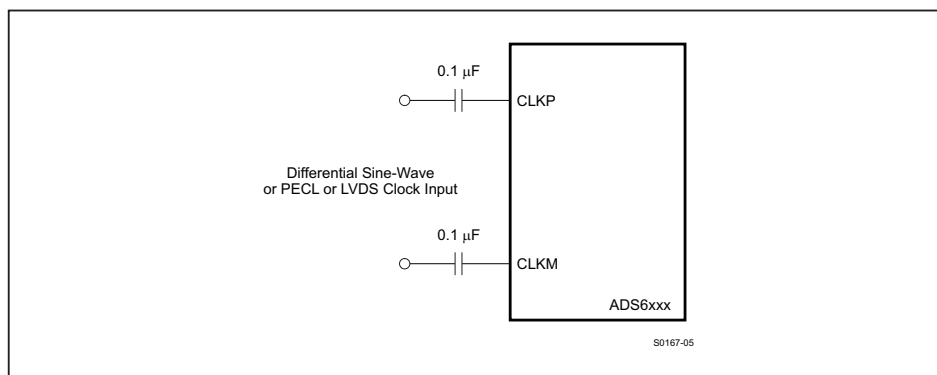


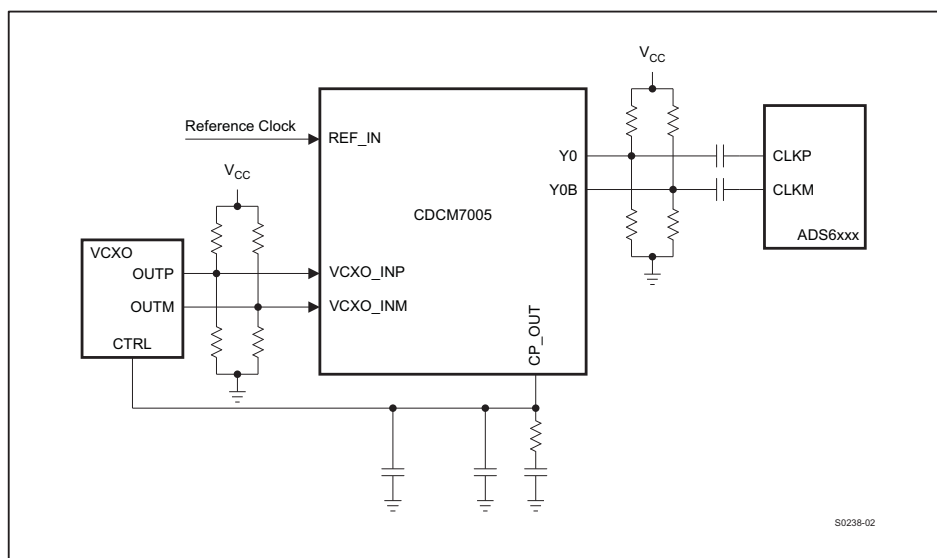
Figure 87. Clock Buffer Input Impedance





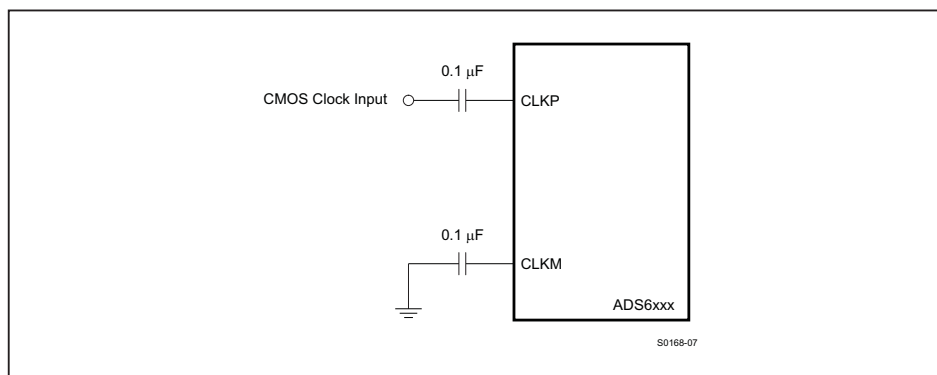
**Figure 88. Differential Clock Driving Circuit**

Figure 89 shows a typical scheme using PECL clock drive from a CDCM7005 clock driver. SNR performance with this scheme is comparable with that of a low jitter sine wave clock source.



**Figure 89. PECL Clock Drive Using CDCM7005**

Single-ended CMOS clock can be ac-coupled to the CLKP input, with CLKM (pin) connected to ground with a 0.1-µF capacitor, as shown in Figure 90.



**Figure 90. Single-Ended Clock Driving Circuit**

For best performance, the clock inputs have to be driven differentially, reducing susceptibility to common-mode noise. For high input frequency sampling, it is recommended to use a clock source with very low jitter. Bandpass filtering of the clock source can help reduce the effect of jitter. There is no change in performance with a non-50% duty cycle clock input.

## CLOCK BUFFER GAIN

When using a sinusoidal clock input, the noise contributed by clock jitter improves as the clock amplitude is increased. Hence, it is recommended to use large clock amplitude. Use clock amplitude greater than 1 V<sub>pp</sub> to avoid performance degradation.

In addition, the clock buffer has programmable gain to amplify the input clock to support very low clock amplitude. The gain can be set by programming the register bits **<CLKIN GAIN>** (Table 15) and increases monotonically from Gain 0 to Gain 4 settings. Table 23 shows the minimum clock amplitude supported for each gain setting.

**Table 23. Minimum Clock Amplitude across gains**

| CLOCK BUFFER GAIN     | MINIMUM CLOCK AMPLITUDE SUPPORTED, mV <sub>pp</sub> differential |
|-----------------------|--|
| Gain 0 (minimum gain) | 800  |
| Gain 1 (default gain) | 400  |
| Gain 2                | 300  |
| Gain 3                | 200  |
| Gain 4 (highest gain) | 150  |

## POWER DOWN MODES

The ADS622X has three power down modes – global power down, channel standby, and input clock stop.

### Global Power Down

This is a global power down mode in which almost the entire chip is powered down, including the four ADCs, internal references, PLL and LVDS buffers. As a result, the total power dissipation falls to about 77 mW typical (with input clock running). This mode can be initiated by setting the register bit **<PDN GLOBAL>** (Table 14). The output data and clock buffers are in high impedance state.

The wake-up time from this mode to data becoming valid in normal mode is 100 μs.

### Channel Standby

In this mode, only the ADC of each channel is powered down and this helps to get very fast wake-up times. Each of the four ADCs can be powered down independently using the register bits **<PDN CH>** (Table 14). The output LVDS buffers remain powered up.

The wake-up time from this mode to data becoming valid in normal mode is 200 clock cycles.

### Input Clock Stop

The converter enters this mode:

- If the input clock frequency falls below 1 MSPS or
- If the input clock amplitude is less than 400 mV (pp, differential with default clock buffer gain setting) at any sampling frequency.

All ADCs and LVDS buffers are powered down and the power dissipation is about 235 mW. The wake-up time from this mode to data becoming valid in normal mode is 100 μs.

**Table 24. Power Down Modes Summary <sup>(1)</sup>**

| POWER DOWN MODE       | AVDD POWER (mW) | LVDD POWER (mW) | WAKE UP TIME |
|-----------------------|-----------------|-----------------|--------------|
| In power-up           | 782             | 208             | –            |
| Global power down     | 65              | 12              | 100 $\mu$ s  |
| 1 Channel in standby  |                 | 208             | 200 Clocks   |
| 2 Channels in standby |                 | 208             | 200 Clocks   |
| Input clock stop      |                 |                 | 100 $\mu$ s  |

(1) Sampling frequency = 125 MSPS.

## POWER SUPPLY SEQUENCING

During power-up, the AVDD and LVDD supplies can come up in any sequence. The two supplies are separated inside the device. Externally, they can be driven from separate supplies or from a single supply.

## DIGITAL OUTPUT INTERFACE

ADS622X offers several flexible output options making it easy to interface to an ASIC or an FPGA. Each of these options can be easily programmed using either parallel pins or the serial interface.

The output interface options are:

- 1-Wire, 1× frame clock, 12× and 14× serialization with DDR bit clock
- 2-Wire, 1× frame clock, 12× serialization, with DDR and SDR bit clock, byte wise/bit wise/word wise
- 2-Wire, 1× frame clock, 14× serialization, with SDR bit clock, byte wise/bit wise/word wise
- 2-Wire, (0.5 x) frame clock, 14× serialization, with DDR bit clock, byte wise/bit wise/word wise.

The maximum sampling frequency, bit clock frequency and output data rate will vary depending on the interface options selected (refer to Table 12).

**Table 25. Maximum Recommended Sampling Frequency for Different Output Interface Options**

| INTERFACE OPTIONS |                  |                   | MAXIMUM<br>RECOMMENDED<br>SAMPLING<br>FREQUENCY,<br>MSPS | BIT CLOCK<br>FREQUENCY,<br>MHZ | FRAME CLOCK<br>FREQUENCY, MHZ | SERIAL DATA RATE,<br>Mbps |
|-------------------|------------------|-------------------|--|--------------------------------|-------------------------------|---------------------------|
| 1-Wire            | DDR Bit<br>clock | 12× Serialization | 65   | 390                            | 65                            | 780                       |
|                   |                  | 14× Serialization | 65   | 455                            | 65                            | 910                       |
| 2-Wire            | DDR Bit<br>clock | 12× Serialization | 125  | 375                            | 125                           | 750                       |
|                   |                  | 14× Serialization | 125  | 437.5                          | 62.5                          | 875                       |
| 2-Wire            | SDR Bit<br>clock | 12× Serialization | 65   | 390                            | 65                            | 390                       |
|                   |                  | 14× Serialization | 65   | 455                            | 65                            | 455                       |

Each interface option is described in detail below.

### 1-WIRE INTERFACE – 12× AND 14× SERIALIZATION WITH DDR BIT CLOCK

Here the device outputs the data of each ADC serially on a single LVDS pair (1-wire). The data is available at the rising and falling edges of the bit clock (DDR bit clock). The ADC outputs a new word at the rising edge of every frame clock, starting with the MSB. Optionally, it can also be programmed to output the LSB first. The data rate is 12 × sample frequency (12× serialization) and 14 × sample frequency (14× serialization).

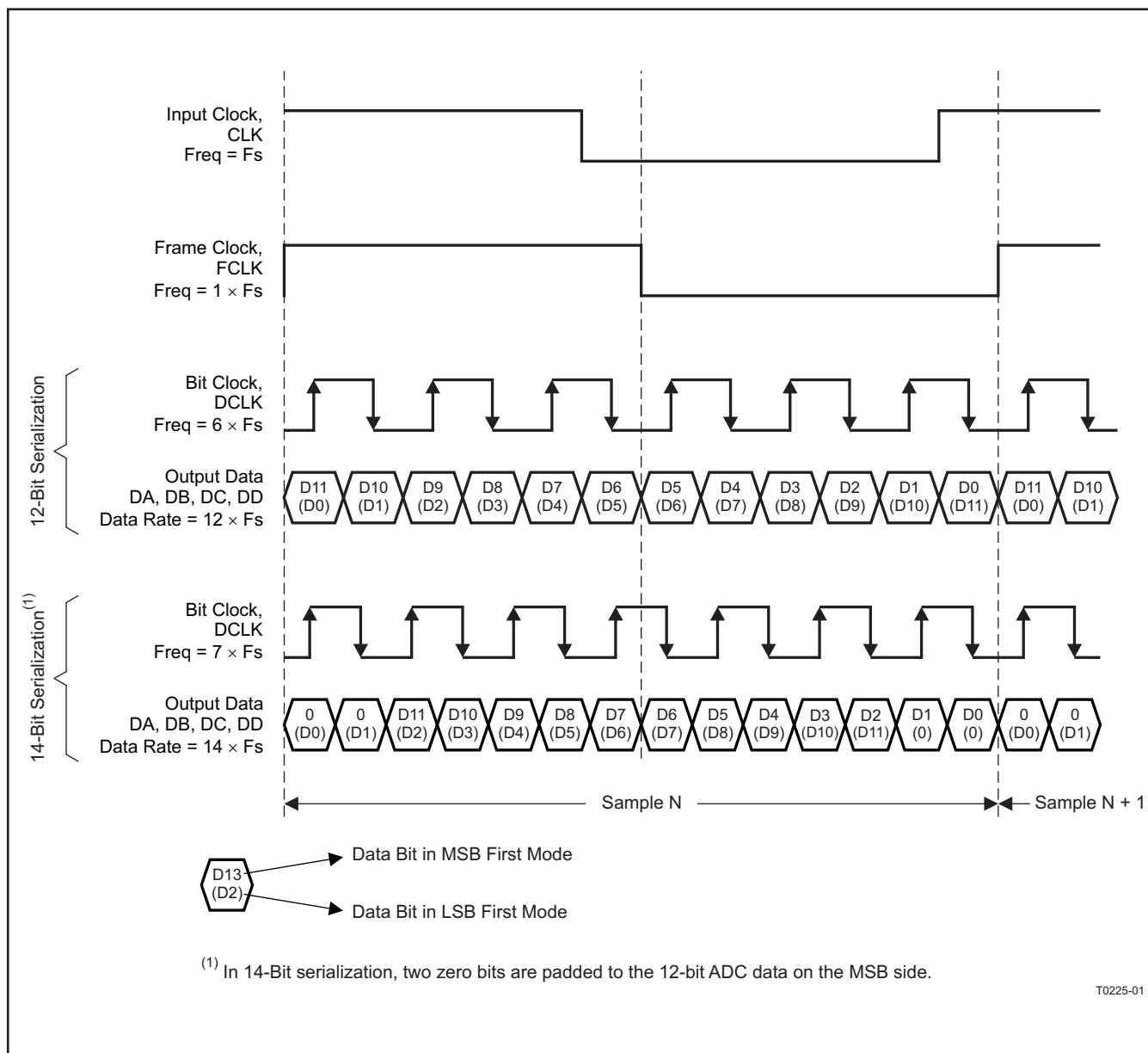


Figure 91. 1-Wire Interface

## 2-WIRE INTERFACE – 12× SERIALIZATION WITH DDR/SDR BIT CLOCK

The 2-wire interface is recommended for sampling frequencies above 65 MSPS. The device outputs the data of each ADC serially on two LVDS pairs (2-wire). The data rate is  $6 \times$  Sample frequency since 6 bits are sent on each wire every clock cycle. The data is available along with DDR bit clock or optionally with SDR bit clock. Each ADC sample is sent over the 2 wires as byte-wise or bit-wise or word-wise.

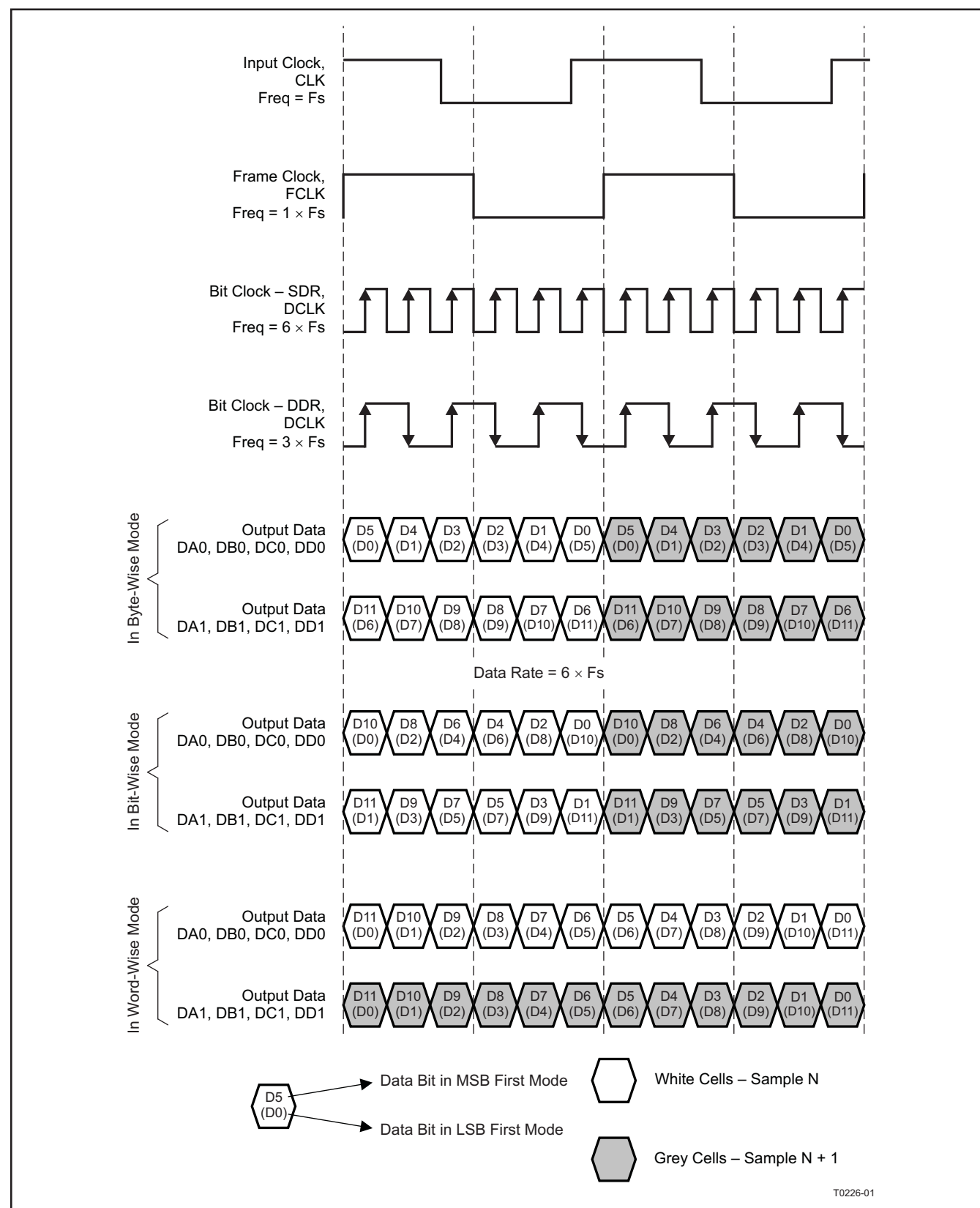


Figure 92. 2-Wire Interface 12x Serialization

## **2-WIRE INTERFACE - 14× SERIALIZATION**

In 14× serialization, two zero bits are padded to the 14-bit ADC data on the MSB side and the combined 14-bit data is serialized and output over two LVDS pairs. A frame clock at  $1 \times$  sample frequency is also available with an SDR bit clock. With DDR bit clock option, the frame clock frequency is  $0.5 \times$  sample frequency. The output data rate will be  $7 \times$  Sample frequency as 7 data bits are output every clock cycle on each wire. Each ADC sample is sent over the 2 wires as byte-wise or bit-wise or word-wise.

Using the 14× serialization makes it possible to upgrade to a 14-bit ADC in the 64xx family in the future seamlessly, without requiring any modification to the receiver capture logic design.

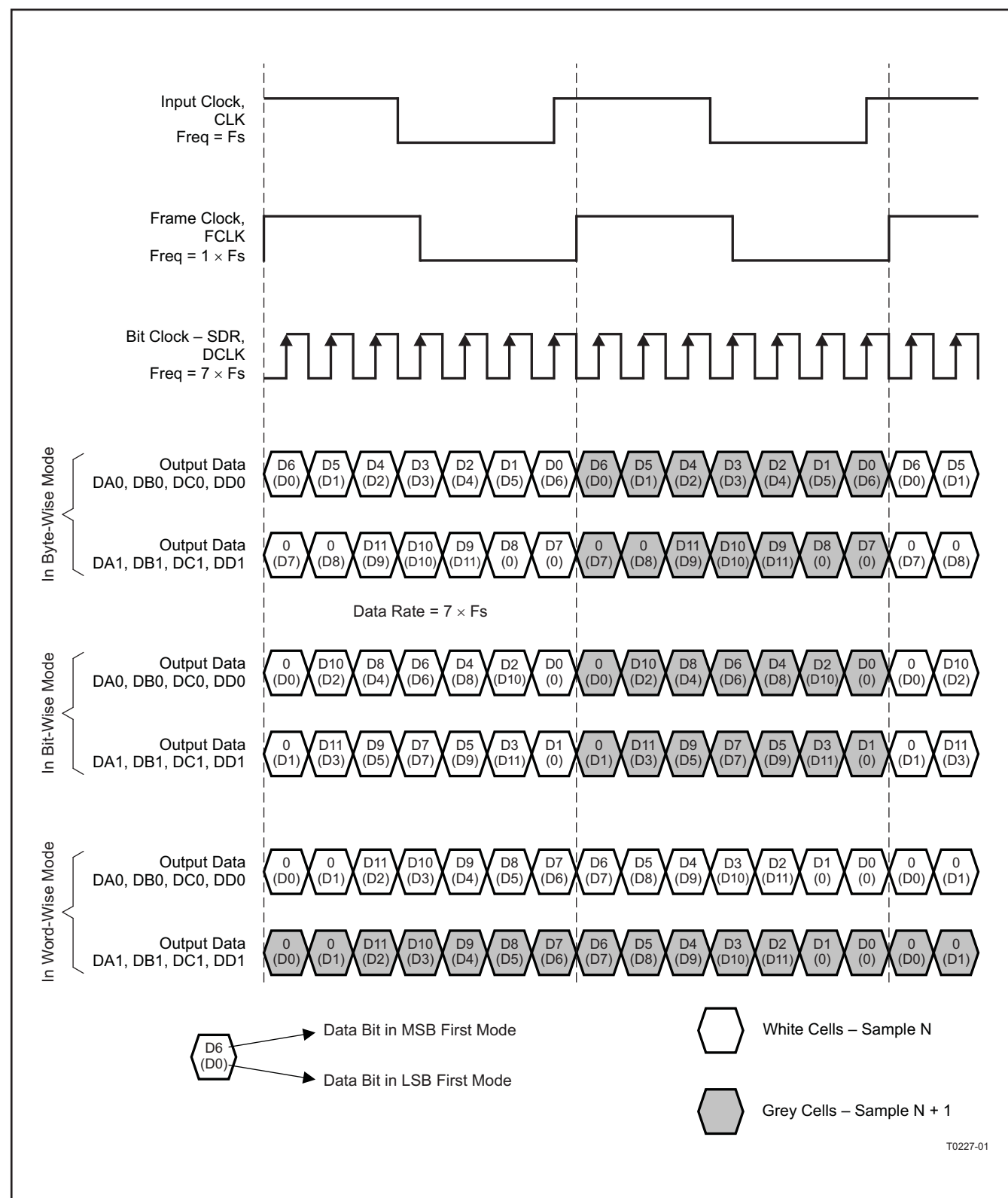


Figure 93. 2-Wire Interface 14× Serialization – SDR Bit Clock



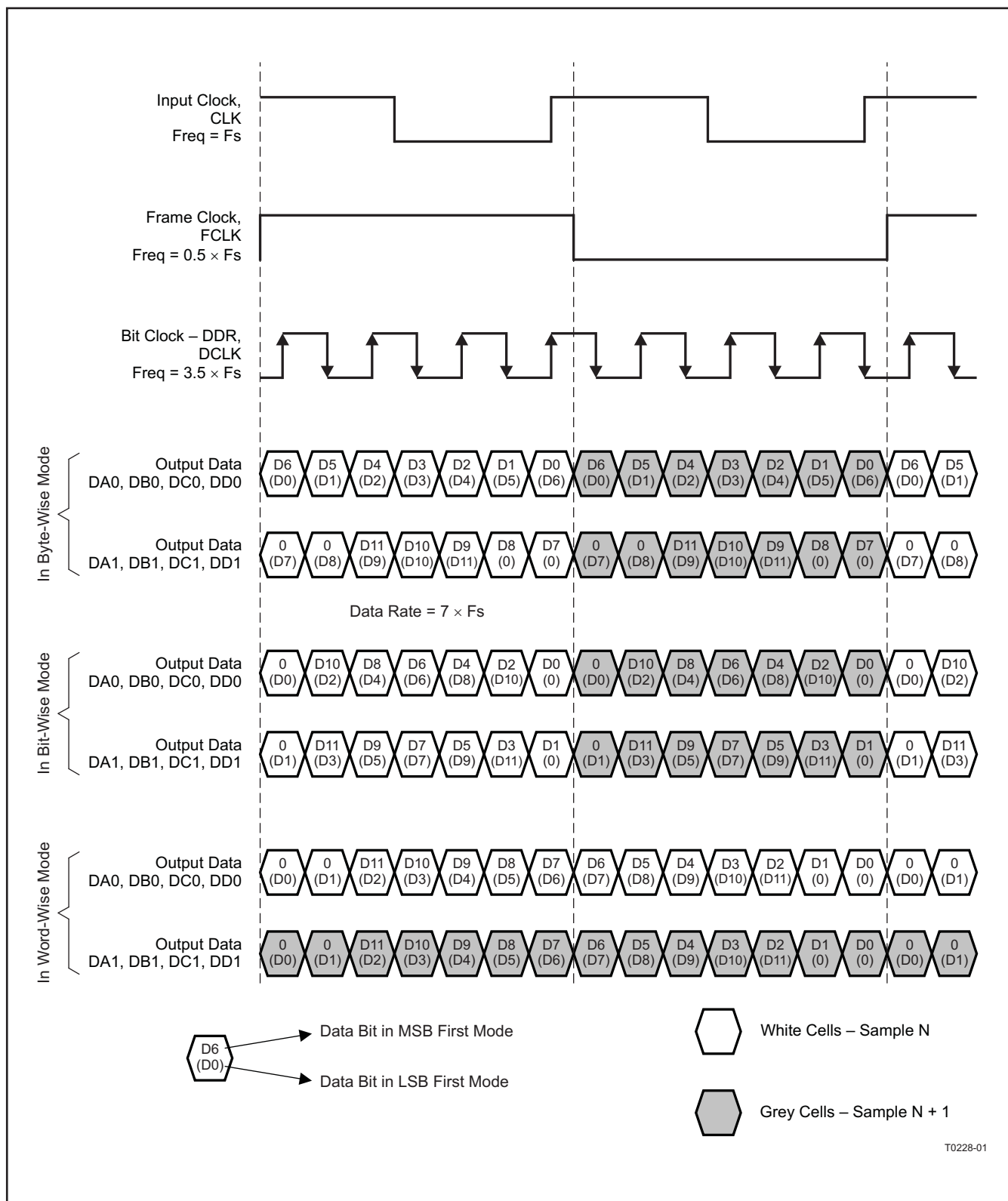


Figure 94. 2-Wire Interface 14x Serialization – DDR Bit Clock

## OUTPUT BIT ORDER

In the 2-wire interface, three types of bit order are supported - byte-wise, bit-wise and word-wise.

**Byte-wise:** Each sample is split across the 2 wires. Wires DA0 and DB0 carry the 6 LSB bits D5-D0 and wires DA1 and DB1 carry the 6 MSB bits.

**Bit-wise:** Each sample is split across the 2 wires. Wires DA0 and DB0 carry the 6 even bits (D0,D2,D4..) and wires DA1 and DB1 carry the 6 odd bits (D1,D3,D5...).

**Word-wise:** In this case, all bits of every sample are sent over a single wire. Successive samples are sent over the 2 wires. For example sample N is sent on wires DA0 and DB0, while sample N+1 is sent over wires DA1 and DB1. The frame clock frequency is 0.5x sampling frequency, with the rising edge aligned with the start of each word.

## MSB/LSB FIRST

By default after reset, the ADC data is output serially with the MSB first (D11,D10,...D1,D0). The data can be output LSB first also by programming the register bit **<MSB\_LSB\_First>**. In the 2-wire mode, the bit order in each wire is flipped in the LSB first mode.

## OUTPUT DATA FORMATS

Two output data formats are supported – 2s complement (default after reset) and offset binary. They can be selected using the serial interface register bit **<DF>**. In the event of an input voltage overdrive, the digital outputs go to the appropriate full-scale level. For a positive overdrive, the output code is 0xFFF in offset binary output format, and 0x7FF in 2s complement output format. For a negative input overdrive, the output code is 0x000 in offset binary output format and 0x800 in 2s complement output format.

## LVDS CURRENT CONTROL

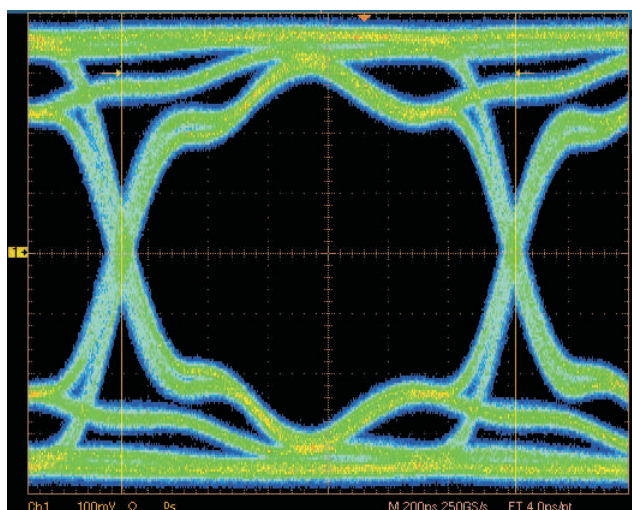
The default LVDS buffer current is 3.5 mA. With an external 100-Ω termination resistance, this develops ±350-mV logic levels at the receiver. The LVDS buffer currents can also be programmed to 2.5 mA, 3.0 mA and 4.5 mA using the register bits **<LVDS\_CURR>**. In addition, there exists a current double mode, where the LVDS nominal current is doubled (register bits **<CURR\_DOUBLE>**, [Table 20](#)).

## LVDS INTERNAL TERMINATION

An internal termination option is available (using the serial interface), by which the LVDS buffers are differentially terminated inside the device. Five termination resistances are available – 166, 200, 250, 333, and 500 Ω (nominal with ±20% variation). Any combination of these terminations can be programmed; the effective termination will be the parallel combination of the selected resistances. The terminations can be programmed separately for the clock and data buffers (bits **<TERM\_CLK>** and **<TERM\_DATA>**, [Table 21](#)).

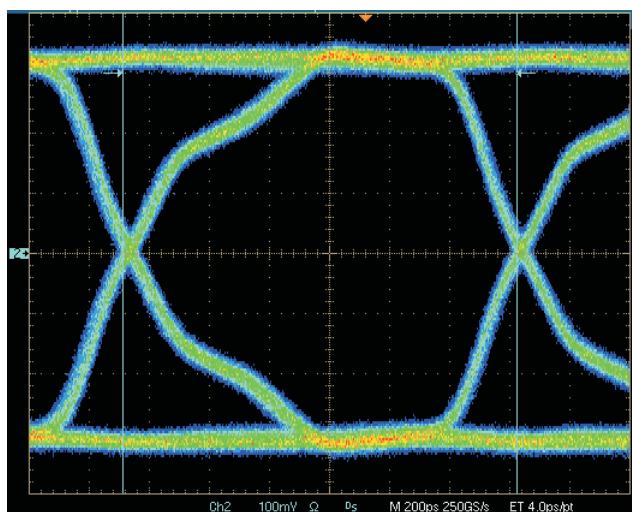
The internal termination helps to absorb any reflections from the receiver end, improving the signal integrity. This makes it possible to drive up to 10 pF of load capacitance, compared to only 5 pF without the internal termination. [Figure 95](#) and [Figure 96](#) show the eye diagram with 5 pF and 10 pF load capacitors (connected from each output pin to ground).

With 100-Ω internal and 100-Ω external termination, the voltage swing at the receiver end will be halved (compared to no internal termination). The voltage swing can be restored by using the LVDS current double mode (bits **<CURR\_DOUBLE>**, [Table 20](#)).



C001

Figure 95. LVDS Data Eye Diagram with 5-pF Load Capacitance (No Internal Termination)



C002

Figure 96. LVDS Data Eye Diagram with 10-pF Load Capacitance (100  $\Omega$  Internal Termination)

## CAPTURE TEST PATTERNS

ADS622X outputs the bit clock (DCLK), positioned nearly at the center of the data transitions. It is recommended to route the bit clock, frame clock and output data lines with minimum relative skew on the PCB. This ensures sufficient setup/hold times for a reliable capture by the receiver.

The DESKEW is a 1010... or 0101... pattern output on the serial data lines that can be used to verify if the receiver capture clock edge is positioned correctly. This may be useful in case there is some skew between DCLK and serial data inside the receiver. Once deserialized, it is required to ensure that the parallel data is aligned to the frame boundary. The SYNC test pattern can be used for this. For example, in the 1-wire interface, the SYNC pattern is 6 '1's followed by 6 '0's (from MSB to LSB). This information can be used by the receiver logic to shift the deserialized data till it matches the SYNC pattern.

In addition to DESKEW and SYNC, the ADS622X includes other test patterns to verify correctness of the capture by the receiver such as all zeros, all ones and toggle. These patterns are output on all four channel data lines simultaneously. Some patterns like custom and sync are affected by the type of interface selected, serialization and bit order.

**Table 26. Test Patterns**

| PATTERN   | DESCRIPTION  |
|-----------|--|
| All zeros | Outputs logic low.   |
| All ones  | Outputs logic high.  |
| Toggle    | Outputs toggle pattern – <D11–D0> alternates between 101010101010 and 010101010101 every clock cycle.  |
| Custom    | Outputs a 12-bit custom pattern. The 12-bit custom pattern can be specified into two serial interface registers. In the 2-wire interface, each code is sent over the 2 wires depending on the serialization and bit order. |
| Sync      | Outputs a sync pattern.  |
| Deskew    | Outputs deskew pattern. Either <D11–D0> = 101010101010 OR <D11–D0> = 010101010101 every clock cycle.   |

**Table 27. SYNC Pattern**

| INTERFACE OPTION | SERIALIZATION | SYNC PATTERN ON EACH WIRE     |
|------------------|---------------|-------------------------------|
| 1-Wire           | 12x           | <b>MSB-111111000000-LSB</b>   |
|                  | 14x           | <b>MSB-11111110000000-LSB</b> |
| 2-Wire           | 12x           | <b>MSB-111000-LSB</b>         |
|                  | 14x           | <b>MSB-1111000-LSB</b>        |

## OUTPUT TIMINGS AT LOWER SAMPLING FREQUENCIES

Setup, hold and other timing parameters are specified across sampling frequencies and for each type of output interface in the tables below.

**Table 29 to Table 32:** Typical values are at 25°C, min and max values are across the full temperature range  $T_{MIN} = -40^{\circ}\text{C}$  to  $T_{MAX} = 85^{\circ}\text{C}$ ,  $AVDD = LVDD = 3.3\text{ V}$ ,  $C_L = 5\text{ pF}$ ,  $I_O = 3.5\text{ mA}$ ,  $R_L = 100\ \Omega$ , no internal termination, unless otherwise noted.

Timing parameters are ensured by design and characterization and not tested in production.

$T_s = 1 / \text{Sampling frequency} = 1/F_s$

**Table 28. Clock Propagation Delay and Serializer Latency for Different Interface Options**

| INTERFACE                 | SERIALIZATION | CLOCK PROPAGATION DELAY, $t_{pd\_clk}$       | SERIALIZER LATENCY <sup>(1)</sup><br>clock cycles |
|---------------------------|---------------|--|---|
| 1-Wire with DDR bit clock | 12x           | $t_{pd\_clk} = 0.5 \times T_s + t_{delay}$   | 0   |
|                           | 14x           | $t_{pd\_clk} = 0.428 \times T_s + t_{delay}$ |   |
| 2-Wire with DDR bit clock | 12x           | $t_{pd\_clk} = t_{delay}$                    | 1   |
| 2-Wire with SDR bit clock |               | $t_{pd\_clk} = 0.5 \times T_s + t_{delay}$   | 0   |
| 2-Wire with DDR bit clock | 14x           | $t_{pd\_clk} = 0.857 \times T_s + t_{delay}$ | 2<br>(when $t_{pd\_clk} \geq T_s$ )               |
|                           |               |  | 1<br>(when $t_{pd\_clk} < T_s$ )                  |
| 2-Wire with SDR bit clock |               | $t_{pd\_clk} = 0.428 \times T_s + t_{delay}$ | 0   |

(1) Note that the total latency = ADC latency + serializer latency. The ADC latency is 12 clocks

**Table 29. Timings for 1-Wire Interface**

| SERIALIZATION | SAMPLING FREQUENCY<br>MSPS | DATA SETUP TIME, $t_{su}$<br>ns |      |     | DATA HOLD TIME, $t_h$<br>ns |     |     | $t_{delay}$<br>ns         |     |     |
|---------------|----------------------------|---------------------------------|------|-----|-----------------------------|-----|-----|---------------------------|-----|-----|
|               |                            | MIN                             | TYP  | MAX | MIN                         | TYP | MAX | MIN                       | TYP | MAX |
| 12x           | 65                         | 0.4                             | 0.6  |     | 0.5                         | 0.7 |     | $F_s \geq 40\text{ MSPS}$ |     |     |
|               | 40                         | 0.8                             | 1.0  |     | 0.9                         | 1.1 |     | 3                         | 4   | 5   |
|               | 20                         | 1.6                             | 2.0  |     | 1.8                         | 2.2 |     | $F_s < 40\text{ MSPS}$    |     |     |
|               | 10                         | 3.5                             | 4.0  |     | 3.5                         | 4.2 |     | 3                         | 4.5 | 6   |
| 14x           | 65                         | 0.3                             | 0.5  |     | 0.4                         | 0.6 |     | $F_s \geq 40\text{ MSPS}$ |     |     |
|               | 40                         | 0.65                            | 0.85 |     | 0.7                         | 0.9 |     | 3                         | 4   | 5   |
|               | 20                         | 1.3                             | 1.65 |     | 1.6                         | 1.9 |     | $F_s < 40\text{ MSPS}$    |     |     |
|               | 10                         | 3.2                             | 3.5  |     | 3.2                         | 3.6 |     | 3                         | 4.5 | 6   |

**Table 30. Timings for 2-Wire Interface, DDR Bit Clock**

| SERIALIZATION | SAMPLING FREQUENCY<br>MSPS | DATA SETUP TIME, $t_{su}$<br>ns |      |     | DATA HOLD TIME, $t_h$<br>ns |      |     | $t_{delay}$<br>ns  |     |     |
|---------------|----------------------------|---------------------------------|------|-----|-----------------------------|------|-----|--------------------|-----|-----|
|               |                            | MIN                             | TYP  | MAX | MIN                         | TYP  | MAX | MIN                | TYP | MAX |
| 12×           | 105                        | 0.55                            | 0.75 |     | 0.6                         | 0.8  |     | $F_s \geq 45$ MSPS |     |     |
|               | 92                         | 0.65                            | 0.85 |     | 0.7                         | 0.9  |     | 3.4                | 4.4 | 5.4 |
|               | 80                         | 0.8                             | 1.0  |     | 0.8                         | 1.05 |     |                    |     |     |
|               | 65                         | 0.9                             | 1.2  |     | 1.0                         | 1.3  |     | $F_s < 45$ MSPS    |     |     |
|               | 40                         | 1.7                             | 2.0  |     | 1.1                         | 2.1  |     | 3.7                | 5.2 | 6.7 |
| 14×           | 105                        | 0.45                            | 0.65 |     | 0.6                         | 0.7  |     | $F_s \geq 45$ MSPS |     |     |
|               | 92                         | 0.55                            | 0.75 |     | 0.7                         | 0.8  |     | 3                  | 4   | 5   |
|               | 80                         | 0.65                            | 0.85 |     | 0.8                         | 0.9  |     |                    |     |     |
|               | 65                         | 0.8                             | 1.1  |     | 1.0                         | 1.1  |     | $F_s < 45$ MSPS    |     |     |
|               | 40                         | 1.4                             | 1.7  |     | 1.1                         | 1.9  |     | 3                  | 4.5 | 6   |

**Table 31. Timings for 2-Wire Interface, SDR Bit Clock**

| SERIALIZATION | SAMPLING FREQUENCY<br>MSPS | DATA SETUP TIME, $t_{su}$<br>ns |     |     | DATA HOLD TIME, $t_h$<br>ns |     |     | $t_{delay}$<br>ns  |     |     |
|---------------|----------------------------|---------------------------------|-----|-----|-----------------------------|-----|-----|--------------------|-----|-----|
|               |                            | MIN                             | TYP | MAX | MIN                         | TYP | MAX | MIN                | TYP | MAX |
| 12×           | 65                         | 1.0                             | 1.2 |     | 1.1                         | 1.3 |     | $F_s \geq 40$ MSPS |     |     |
|               | 40                         | 1.8                             | 2.0 |     | 1.9                         | 2.1 |     | 3.4                | 4.4 | 5.4 |
|               | 20                         | 3.9                             | 4.1 |     | 3.8                         | 4.1 |     | $F_s < 40$ MSPS    |     |     |
|               | 10                         | 8.2                             | 8.4 |     | 7.8                         | 8.2 |     | 3.7                | 5.2 | 6.7 |
| 14×           | 65                         | 0.8                             | 1.0 |     | 1.0                         | 1.2 |     | $F_s \geq 40$ MSPS |     |     |
|               | 40                         | 1.5                             | 1.7 |     | 1.6                         | 1.8 |     | 3.4                | 4.4 | 5.4 |
|               | 20                         | 3.4                             | 3.6 |     | 3.3                         | 3.5 |     | $F_s < 40$ MSPS    |     |     |
|               | 10                         | 6.9                             | 7.2 |     | 6.6                         | 6.9 |     | 3.7                | 5.2 | 6.7 |

**Table 32. Output Jitter (applies to all interface options)**

| SAMPLING FREQUENCY<br>MSPS | BIT CLOCK JITTER, CYCLE-CYCLE<br>ps, peak-peak |     |     | FRAME CLOCK JITTER, CYCLE-CYCLE<br>ps, peak-peak |     |     |
|----------------------------|--|-----|-----|--|-----|-----|
|                            | MIN  | TYP | MAX | MIN  | TYP | MAX |
| $\geq 65$                  |  | 350 |     |  | 75  |     |

## BOARD DESIGN CONSIDERATIONS

### Grounding

A single ground plane is sufficient to give optimum performance, provided the analog, digital and clock sections of the board are cleanly partitioned. Refer to the EVM User Guide ([SLAU196](#)) for more layout details.

### Supply Decoupling

As the ADS622X already includes internal decoupling, minimal external decoupling can be used without loss in performance. Note that the decoupling capacitors can help to filter external power supply noise, so the optimum number of decoupling capacitors would depend on actual application.

It is recommended to use separate supplies for the analog and digital supply pins to isolate digital switching noise from sensitive analog circuitry. In case only a single 3.3 V supply is available, it should be routed first to AVDD. It can then be tapped and isolated with a ferrite bead (or inductor) with decoupling capacitor, before being routed to LVDD.

### Exposed Thermal Pad

It is necessary to solder the exposed pad at the bottom of the package to a ground plane for best thermal performance. For detailed information, see application notes **QFN Layout Guidelines** ([SLOA122A](#)) and **QFN/SON PCB Attachment** ([SLUA271A](#)).

## DEFINITION OF SPECIFICATIONS

**Analog Bandwidth** – The analog input frequency at which the power of the fundamental is reduced by 3 dB with respect to the low frequency value.

**Aperture Delay** – The delay in time between the rising edge of the input sampling clock and the actual time at which the sampling occurs.

**Aperture Uncertainty (Jitter)** – The sample-to-sample variation in aperture delay.

**Clock Pulse Width/Duty Cycle** – The duty cycle of a clock signal is the ratio of the time the clock signal remains at a logic high (clock pulse width) to the period of the clock signal. Duty cycle is typically expressed as a percentage. A perfect differential sine-wave clock results in a 50% duty cycle.

**Maximum Conversion Rate** – The maximum sampling rate at which certified operation is given. All parametric testing is performed at this sampling rate unless otherwise noted.

**Minimum Conversion Rate** – The minimum sampling rate at which the ADC functions.

**Differential Nonlinearity (DNL)** – An ideal ADC exhibits code transitions at analog input values spaced exactly 1 LSB apart. The DNL is the deviation of any single step from this ideal value, measured in units of LSBs.

**Integral Nonlinearity (INL)** – The INL is the deviation of the ADC's transfer function from a best fit line determined by a least squares curve fit of that transfer function, measured in units of LSBs.

**Gain Error** – The gain error is the deviation of the ADC's actual input full-scale range from its ideal value. The gain error is given as a percentage of the ideal input full-scale range.

**Offset Error** – The offset error is the difference, given in number of LSBs, between the ADC's actual average idle channel output code and the ideal average idle channel output code. This quantity is often mapped into mV.

**Temperature Drift** – The temperature drift coefficient (with respect to gain error and offset error) specifies the change per degree Celsius of the parameter from  $T_{MIN}$  to  $T_{MAX}$ . It is calculated by dividing the maximum deviation of the parameter across the  $T_{MIN}$  to  $T_{MAX}$  range by the difference  $T_{MAX}-T_{MIN}$ .

**Signal-to-Noise Ratio** – SNR is the ratio of the power of the fundamental ( $P_S$ ) to the noise floor power ( $P_N$ ), excluding the power at DC and the first nine harmonics.

$$SNR = 10\log_{10} \frac{P_S}{P_N} \quad (3)$$

SNR is either given in units of dBc (dB to carrier) when the absolute power of the fundamental is used as the reference, or dBFS (dB to full scale) when the power of the fundamental is extrapolated to the converter's full-scale range.

**Signal-to-Noise and Distortion (SINAD)** – SINAD is the ratio of the power of the fundamental ( $P_S$ ) to the power of all the other spectral components including noise ( $P_N$ ) and distortion ( $P_D$ ), but excluding dc.

$$SINAD = 10\log_{10} \frac{P_S}{P_N + P_D} \quad (4)$$

SINAD is either given in units of dBc (dB to carrier) when the absolute power of the fundamental is used as the reference, or dBFS (dB to full scale) when the power of the fundamental is extrapolated to the converter's full-scale range.

**Effective Number of Bits (ENOB)** – The ENOB is a measure of a converter's performance as compared to the theoretical limit based on quantization noise.

$$ENOB = \frac{SINAD - 1.76}{6.02} \quad (5)$$

**Total Harmonic Distortion (THD)** – THD is the ratio of the power of the fundamental ( $P_S$ ) to the power of the first nine harmonics ( $P_D$ ).

$$THD = 10\log_{10} \frac{P_S}{P_D} \quad (6)$$

THD is typically given in units of dBc (dB to carrier).



**Spurious-Free Dynamic Range (SFDR)** – The ratio of the power of the fundamental to the highest other spectral component (either spur or harmonic). SFDR is typically given in units of dBc (dB to carrier).

**Two-Tone Intermodulation Distortion** – IMD3 is the ratio of the power of the fundamental (at frequencies f1 and f2) to the power of the worst spectral component at either frequency 2f1–f2 or 2f2–f1. IMD3 is either given in units of dBc (dB to carrier) when the absolute power of the fundamental is used as the reference, or dBFS (dB to full scale) when the power of the fundamental is extrapolated to the converter's full-scale range.

**DC Power Supply Rejection Ratio (DC PSRR)** – The DC PSRR is the ratio of the change in offset error to a change in analog supply voltage. The DC PSRR is typically given in units of mV/V.

**AC Power Supply Rejection Ratio (AC PSRR)** – AC PSRR is the measure of rejection of variations in the supply voltage by the ADC. If  $\Delta V_{sup}$  is the change in supply voltage and  $\Delta V_{out}$  is the resultant change of the ADC output code (referred to the input), then

$$PSRR = 20\log_{10} \frac{\Delta V_{out}}{\Delta V_{sup}}, \text{ expressed in dBc} \quad (7)$$

**Voltage Overload Recovery** – The number of clock cycles taken to recover to less than 1% error after an overload on the analog inputs. This is tested by separately applying a sine wave signal with 6dB positive and negative overload. The deviation of the first few samples after the overload (from their expected values) is noted.

**Common Mode Rejection Ratio (CMRR)** – CMRR is the measure of rejection of variations in the analog input common-mode by the ADC. If  $\Delta V_{cm\_in}$  is the change in the common-mode voltage of the input pins and  $\Delta V_{out}$  is the resultant change of the ADC output code (referred to the input), then

$$CMRR = 20\log_{10} \frac{\Delta V_{out}}{\Delta V_{cm\_in}}, \text{ expressed in dBc} \quad (8)$$

**Cross-Talk (only for multi-channel ADC)**– This is a measure of the internal coupling of a signal from adjacent channel into the channel of interest. It is specified separately for coupling from the immediate neighbouring channel (near-channel) and for coupling from channel across the package (far-channel). It is usually measured by applying a full-scale signal in the adjacent channel. Cross-talk is the ratio of the power of the coupling signal (as measured at the output of the channel of interest) to the power of the signal applied at the adjacent channel input. It is typically expressed in dBc.

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| ADS6222IRGZ25    | PREVIEW               | VQFN         | RGZ             | 48   | 25          | TBD                     | Call TI          | Call TI                      |
| ADS6222IRGZR     | ACTIVE                | VQFN         | RGZ             | 48   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| ADS6222IRGZRG4   | ACTIVE                | VQFN         | RGZ             | 48   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| ADS6222IRGZT     | ACTIVE                | VQFN         | RGZ             | 48   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| ADS6222IRGZTG4   | ACTIVE                | VQFN         | RGZ             | 48   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| ADS6223IRGZ25    | PREVIEW               | VQFN         | RGZ             | 48   | 25          | TBD                     | Call TI          | Call TI                      |
| ADS6223IRGZR     | ACTIVE                | VQFN         | RGZ             | 48   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| ADS6223IRGZRG4   | ACTIVE                | VQFN         | RGZ             | 48   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| ADS6223IRGZT     | ACTIVE                | VQFN         | RGZ             | 48   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| ADS6223IRGZTG4   | ACTIVE                | VQFN         | RGZ             | 48   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| ADS6224IRGZ25    | PREVIEW               | VQFN         | RGZ             | 48   | 25          | TBD                     | Call TI          | Call TI                      |
| ADS6224IRGZR     | ACTIVE                | VQFN         | RGZ             | 48   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| ADS6224IRGZRG4   | ACTIVE                | VQFN         | RGZ             | 48   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| ADS6224IRGZT     | ACTIVE                | VQFN         | RGZ             | 48   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| ADS6224IRGZTG4   | ACTIVE                | VQFN         | RGZ             | 48   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| ADS6225IRGZ25    | PREVIEW               | VQFN         | RGZ             | 48   | 25          | TBD                     | Call TI          | Call TI                      |
| ADS6225IRGZR     | ACTIVE                | VQFN         | RGZ             | 48   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| ADS6225IRGZRG4   | ACTIVE                | VQFN         | RGZ             | 48   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| ADS6225IRGZT     | ACTIVE                | VQFN         | RGZ             | 48   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| ADS6225IRGZTG4   | ACTIVE                | VQFN         | RGZ             | 48   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

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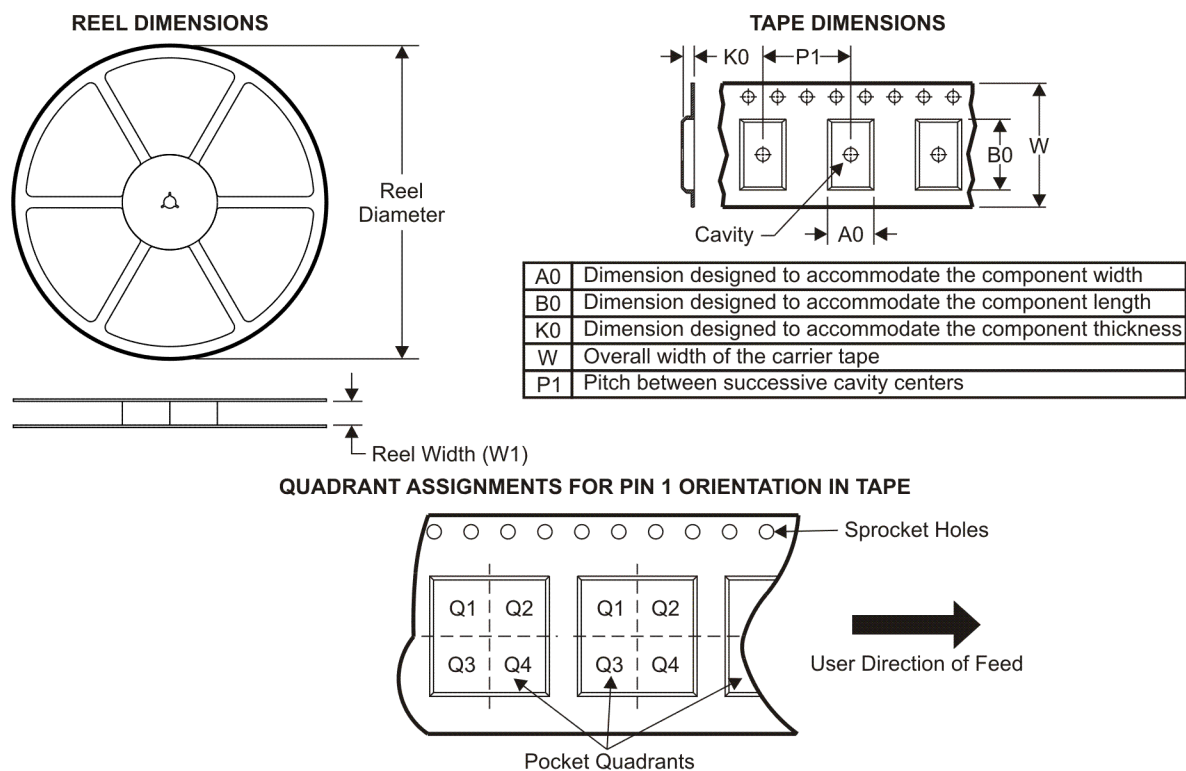
**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| ADS6222IRGZR | VQFN         | RGZ             | 48   | 2500 | 330.0              | 16.4               | 7.3     | 7.3     | 1.5     | 12.0    | 16.0   | Q2            |
| ADS6222IRGZT | VQFN         | RGZ             | 48   | 250  | 330.0              | 16.4               | 7.3     | 7.3     | 1.5     | 12.0    | 16.0   | Q2            |
| ADS6223IRGZR | VQFN         | RGZ             | 48   | 2500 | 330.0              | 16.4               | 7.3     | 7.3     | 1.5     | 12.0    | 16.0   | Q2            |
| ADS6223IRGZT | VQFN         | RGZ             | 48   | 250  | 330.0              | 16.4               | 7.3     | 7.3     | 1.5     | 12.0    | 16.0   | Q2            |
| ADS6224IRGZR | VQFN         | RGZ             | 48   | 2500 | 330.0              | 16.4               | 7.3     | 7.3     | 1.5     | 12.0    | 16.0   | Q2            |
| ADS6224IRGZT | VQFN         | RGZ             | 48   | 250  | 330.0              | 16.4               | 7.3     | 7.3     | 1.5     | 12.0    | 16.0   | Q2            |
| ADS6225IRGZR | VQFN         | RGZ             | 48   | 2500 | 330.0              | 16.4               | 7.3     | 7.3     | 1.5     | 12.0    | 16.0   | Q2            |
| ADS6225IRGZT | VQFN         | RGZ             | 48   | 250  | 330.0              | 16.4               | 7.3     | 7.3     | 1.5     | 12.0    | 16.0   | Q2            |

## TAPE AND REEL BOX DIMENSIONS

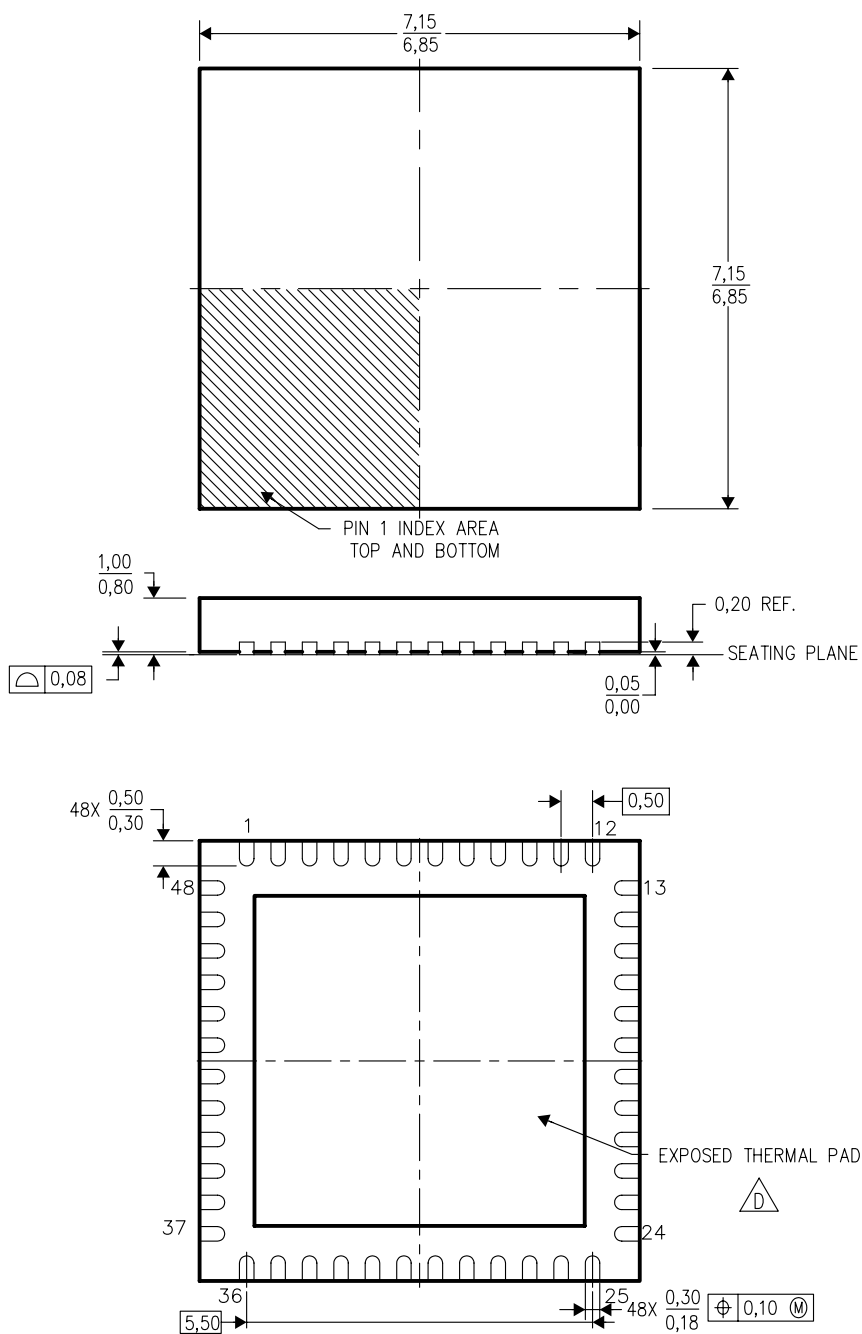


\*All dimensions are nominal


| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ADS6222IRGZR | VQFN         | RGZ             | 48   | 2500 | 333.2       | 345.9      | 28.6        |
| ADS6222IRGZT | VQFN         | RGZ             | 48   | 250  | 333.2       | 345.9      | 28.6        |
| ADS6223IRGZR | VQFN         | RGZ             | 48   | 2500 | 333.2       | 345.9      | 28.6        |
| ADS6223IRGZT | VQFN         | RGZ             | 48   | 250  | 333.2       | 345.9      | 28.6        |
| ADS6224IRGZR | VQFN         | RGZ             | 48   | 2500 | 333.2       | 345.9      | 28.6        |
| ADS6224IRGZT | VQFN         | RGZ             | 48   | 250  | 333.2       | 345.9      | 28.6        |
| ADS6225IRGZR | VQFN         | RGZ             | 48   | 2500 | 333.2       | 345.9      | 28.6        |
| ADS6225IRGZT | VQFN         | RGZ             | 48   | 250  | 333.2       | 345.9      | 28.6        |

RGZ (S-PQFP-N48)

PLASTIC QUAD FLATPACK



4204101/E 11/04

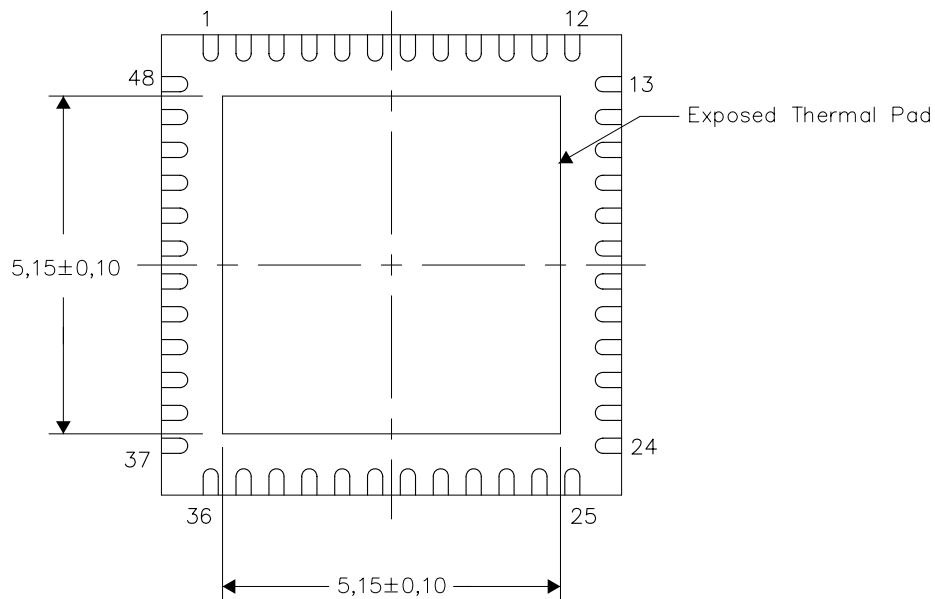
- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Quad Flatpack, No-leads (QFN) package configuration.
  -  D. The package thermal pad must be soldered to the board for thermal and mechanical performance. See the Product Data Sheet for details regarding the exposed thermal pad dimensions.
  - E. Falls within JEDEC MO-220.

## THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at [www.ti.com](http://www.ti.com).

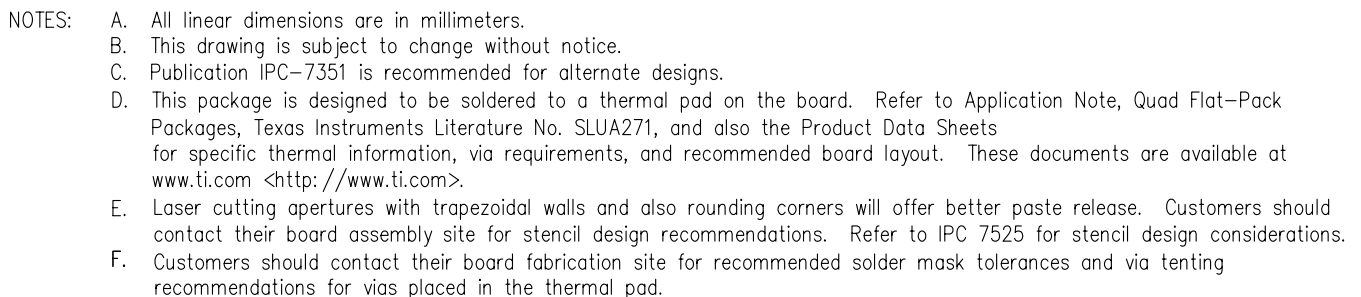
The exposed thermal pad dimensions for this package are shown in the following illustration.



Bottom View

NOTE: All linear dimensions are in millimeters

## Exposed Thermal Pad Dimensions





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| Logic                       | <a href="http://logic.ti.com">logic.ti.com</a>                     | Industrial                 | <a href="http://www.ti.com/industrial">www.ti.com/industrial</a>                         |
| Power Mgmt                  | <a href="http://power.ti.com">power.ti.com</a>                     | Medical                    | <a href="http://www.ti.com/medical">www.ti.com/medical</a>                               |
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| RFID                        | <a href="http://www.ti-rfid.com">www.ti-rfid.com</a>               | Space, Avionics & Defense  | <a href="http://www.ti.com/space-avionics-defense">www.ti.com/space-avionics-defense</a> |
| RF/IF and ZigBee® Solutions | <a href="http://www.ti.com/lprf">www.ti.com/lprf</a>               | Video and Imaging          | <a href="http://www.ti.com/video">www.ti.com/video</a>                                   |
|                             |  | Wireless                   | <a href="http://www.ti.com/wireless-apps">www.ti.com/wireless-apps</a>                   |